

# 40MX and 42MX FPGA Families

## Features

### High Capacity

- Single-Chip ASIC Alternative
- 3,000 to 54,000 System Gates
- Up to 2.5 kbits Configurable Dual-Port SRAM
- Fast Wide-Decode Circuitry
- Up to 202 User-Programmable I/O Pins

### High Performance

- 5.6 ns Clock-to-Out
- 250 MHz Performance
- 5 ns Dual-Port SRAM Access
- 100 MHz FIFOs
- 7.5 ns 35-Bit Address Decode

## HiRel Features

- Commercial, Industrial, Automotive, and Military Temperature Plastic Packages
- Commercial, Military Temperature, and MIL-STD-883 Ceramic Packages
- QML Certification
- Ceramic Devices Available to DSCC SMD

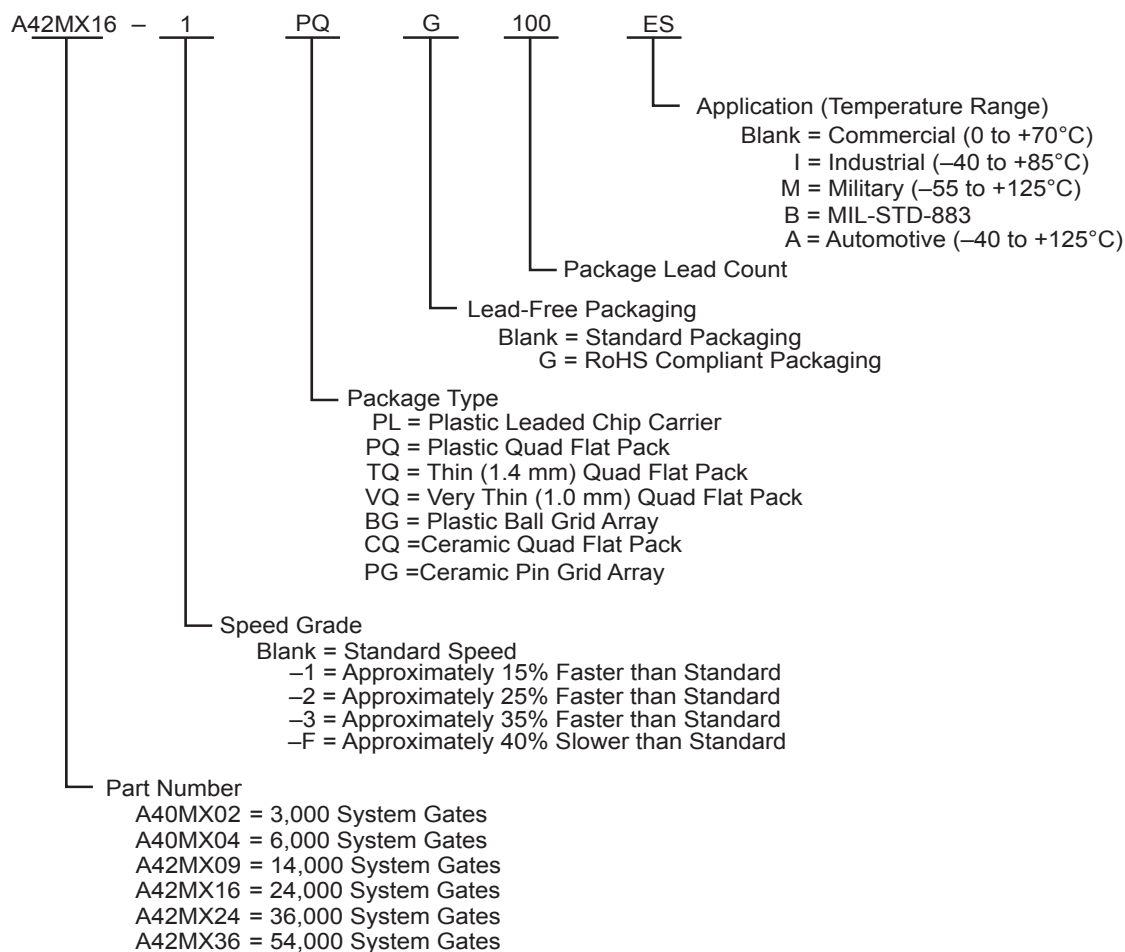
## Ease of Integration

- Mixed-Voltage Operation (5.0 V or 3.3 V for core and I/Os), with PCI-Compliant I/Os
- Up to 100% Resource Utilization and 100% Pin Locking
- Deterministic, User-Controllable Timing
- Unique In-System Diagnostic and Verification Capability with Silicon Explorer II
- Low Power Consumption
- IEEE Standard 1149.1 (JTAG) Boundary Scan Testing

## Product Profile

| Device                             | A40MX02 | A40MX04    | A42MX09       | A42MX16       | A42MX24  | A42MX36  |
|------------------------------------|---------|------------|---------------|---------------|----------|----------|
| <b>Capacity</b>                    |         |            |               |               |          |          |
| System Gates                       | 3,000   | 6,000      | 14,000        | 24,000        | 36,000   | 54,000   |
| SRAM Bits                          | —       | —          | —             | —             | —        | 2,560    |
| <b>Logic Modules</b>               |         |            |               |               |          |          |
| Sequential                         | —       | —          | 348           | 624           | 954      | 1,230    |
| Combinatorial                      | 295     | 547        | 336           | 608           | 912      | 1,184    |
| Decode                             | —       | —          | —             | —             | 24       | 24       |
| <b>Clock-to-Out</b>                | 9.5 ns  | 9.5 ns     | 5.6 ns        | 6.1 ns        | 6.1 ns   | 6.3 ns   |
| <b>SRAM Modules (64x4 or 32x8)</b> | —       | —          | —             | —             | —        | 10       |
| <b>Dedicated Flip-Flops</b>        | —       | —          | 348           | 624           | 954      | 1,230    |
| <b>Maximum Flip-Flops</b>          | 147     | 273        | 516           | 928           | 1,410    | 1,822    |
| <b>Clocks</b>                      | 1       | 1          | 2             | 2             | 2        | 6        |
| <b>User I/O (maximum)</b>          | 57      | 69         | 104           | 140           | 176      | 202      |
| <b>PCI</b>                         | —       | —          | —             | —             | Yes      | Yes      |
| <b>Boundary Scan Test (BST)</b>    | —       | —          | —             | —             | Yes      | Yes      |
| <b>Packages (by pin count)</b>     |         |            |               |               |          |          |
| PLCC                               | 44, 68  | 44, 68, 84 | 84            | 84            | 84       | —        |
| PQFP                               | 100     | 100        | 100, 144, 160 | 100, 160, 208 | 160, 208 | 208, 240 |
| VQFP                               | 80      | 80         | 100           | 100           | —        | —        |
| TQFP                               | —       | —          | 176           | 176           | 176      | —        |
| CQFP                               | —       | —          | —             | —             | —        | 208, 256 |
| PBGA                               | —       | —          | —             | —             | —        | 272      |
| CPGA                               | —       | —          | 132           | —             | —        | —        |

## Ordering Information



## Plastic Device Resources

| Device  | User I/Os      |                |                |                 |                 |                 |                 |                 |                |                 |                 |                 |
|---------|----------------|----------------|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|----------------|-----------------|-----------------|-----------------|
|         | PLCC<br>44-Pin | PLCC<br>68-Pin | PLCC<br>84-Pin | PQFP<br>100-Pin | PQFP<br>144-Pin | PQFP<br>160-Pin | PQFP<br>208-Pin | PQFP<br>240-Pin | VQFP<br>80-Pin | VQFP<br>100-Pin | TQFP<br>176-Pin | PBGA<br>272-Pin |
| A40MX02 | 34             | 57             | –              | 57              | –               | –               | –               | –               | 57             | –               | –               | –               |
| A40MX04 | 34             | 57             | 69             | 69              | –               | –               | –               | –               | 69             | –               | –               | –               |
| A42MX09 | –              | –              | 72             | 83              | 95              | 101             | –               | –               | –              | 83              | 104             | –               |
| A42MX16 | –              | –              | 72             | 83              | –               | 125             | 140             | –               | –              | 83              | 140             | –               |
| A42MX24 | –              | –              | 72             | –               | –               | 125             | 176             | –               | –              | –               | 150             | –               |
| A42MX36 | –              | –              | –              | –               | –               | –               | 176             | 202             | –              | –               | –               | 202             |

**Note: Package Definitions**

PLCC = Plastic Leaded Chip Carrier, PQFP = Plastic Quad Flat Pack, TQFP = Thin Quad Flat Pack, VQFP = Very Thin Quad Flat Pack, PBGA = Plastic Ball Grid Array

## Ceramic Device Resources

| Device  | User I/Os    |              |              |
|---------|--------------|--------------|--------------|
|         | CPGA 132-Pin | CQFP 208-Pin | CQFP 256-Pin |
| A42MX09 | 95           |              |              |
| A42MX36 |              | 176          | 202          |

**Note:** **Package Definitions** CQFP = Ceramic Quad Flat Pack

## Temperature Grade Offerings

| Package  | A40MX02    | A40MX04    | A42MX09    | A42MX16    | A42MX24    | A42MX36    |
|----------|------------|------------|------------|------------|------------|------------|
| PLCC 44  | C, I, M    | C, I, M    |            |            |            |            |
| PLCC 68  | C, I, A, M | C, I, M    |            |            |            |            |
| PLCC 84  |            | C, I, A, M | C, I, A, M | C, I, M    | C, I, M    |            |
| PQFP 100 | C, I, A, M | C, I, A, M | C, I, A, M | C, I, M    |            |            |
| PQFP 144 |            |            | C          |            |            |            |
| PQFP 160 |            |            | C, I, A, M | C, I, M    | C, I, A, M |            |
| PQFP 208 |            |            |            | C, I, A, M | C, I, A, M | C, I, A, M |
| PQFP 240 |            |            |            |            |            | C, I, A, M |
| VQFP 80  | C, I, A, M | C, I, A, M |            |            |            |            |
| VQFP 100 |            |            | C, I, A, M | C, I, A, M |            |            |
| TQFP 176 |            |            | C, I, A, M | C, I, A, M | C, I, A, M |            |
| PBGA 272 |            |            |            |            |            | C, I, M    |
| CQFP 208 |            |            |            |            |            | C, M, B    |
| CQFP 256 |            |            |            |            |            | C, M, B    |
| CPGA 132 |            |            | C          |            |            |            |

**Note:**

*C = Commercial*

*I = Industrial*

*A = Automotive*

*M = Military*

*B = MIL-STD-883 Class B*

## Speed Grade Offerings

|   | – F | Std | –1 | –2 | –3 |
|---|-----|-----|----|----|----|
| C | ✓   | ✓   | ✓  | ✓  | ✓  |
| I |     | ✓   | ✓  | ✓  | ✓  |
| A |     | ✓   |    |    |    |
| M |     | ✓   | ✓  |    |    |
| B |     | ✓   | ✓  |    |    |

*Note:* Refer to the [40MX and 42MX Automotive Family FPGAs datasheet](#) for details on automotive-grade MX offerings.

Contact your local Microsemi SoC Products Group representative for device availability.

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# 1 – 40MX and 42MX FPGA Families

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## General Description

Microsemi's 40MX and 42MX families offer a cost-effective design solution at 5V. The MX devices are single-chip solutions and provide high performance while shortening the system design and development cycle. MX devices can integrate and consolidate logic implemented in multiple PALs, CPLDs, and FPGAs. Example applications include high-speed controllers and address decoding, peripheral bus interfaces, DSP, and co-processor functions.

The MX device architecture is based on Microsemi's patented antifuse technology implemented in a 0.45µm triple-metal CMOS process. With capacities ranging from 3,000 to 54,000 system gates, the MX devices provide performance up to 250 MHz, are live on power-up and have one-fifth the standby power consumption of comparable FPGAs. MX FPGAs provide up to 202 user I/Os and are available in a wide variety of packages and speed grades.

A42MX24 and A42MX36 devices also feature MultiPlex I/Os, which support mixed-voltage systems, enable programmable PCI, deliver high-performance operation at both 5.0V and 3.3V, and provide a low-power mode. The devices are fully compliant with the PCI Local Bus Specification (version 2.1). They deliver 200 MHz on-chip operation and 6.1 ns clock-to-output performance.

The 42MX24 and 42MX36 devices include system-level features such as IEEE Standard 1149.1 (JTAG) Boundary Scan Testing and fast wide-decode modules. In addition, the A42MX36 device offers dual-port SRAM for implementing fast FIFOs, LIFOs, and temporary data storage. The storage elements can efficiently address applications requiring wide datapath manipulation and can perform transformation functions such as those required for telecommunications, networking, and DSP.

All MX devices are fully tested over automotive and military temperature ranges. In addition, the largest member of the family, the A42MX36, is available in both CQ208 and CQ256 ceramic packages screened to MIL-STD-883 levels. For easy prototyping and conversion from plastic to ceramic, the CQ208 and PQ208 devices are pin-compatible.

## MX Architectural Overview

The MX devices are composed of fine-grained building blocks that enable fast, efficient logic designs. All devices within these families are composed of logic modules, I/O modules, routing resources and clock networks, which are the building blocks for fast logic designs. In addition, the A42MX36 device contains embedded dual-port SRAM modules, which are optimized for high-speed datapath functions such as FIFOs, LIFOs and scratchpad memory. A42MX24 and A42MX36 also contain wide-decode modules.

## Logic Modules

The 40MX logic module is an eight-input, one-output logic circuit designed to implement a wide range of logic functions with efficient use of interconnect routing resources ([Figure 1-1 on page 1-2](#)).

The logic module can implement the four basic logic functions (NAND, AND, OR and NOR) in gates of two, three, or four inputs. The logic module can also implement a variety of D-latches, exclusivity functions, AND-ORs and OR-ANDs. No dedicated hard-wired latches or flip-flops are required in the array; latches and flip-flops can be constructed from logic modules whenever required in the application.

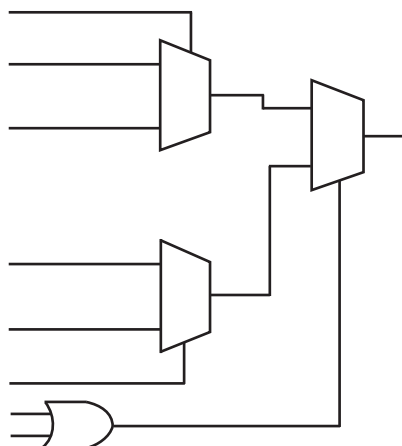


**Figure 1-1 • 42MX C-Module Implementation**

The 42MX devices contain three types of logic modules: combinational (C-modules), sequential (S-modules) and decode (D-modules). [Figure 1-2](#) illustrates the combinational logic module. The S-module, shown in [Figure 1-3](#), implements the same combinational logic function as the C-module while adding a sequential element. The sequential element can be configured as either a D-flip-flop or a transparent latch. The S-module register can be bypassed so that it implements purely combinational logic.

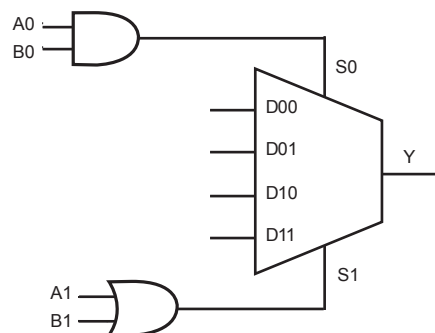


**Figure 1-2 • 42MX C-Module Implementation**

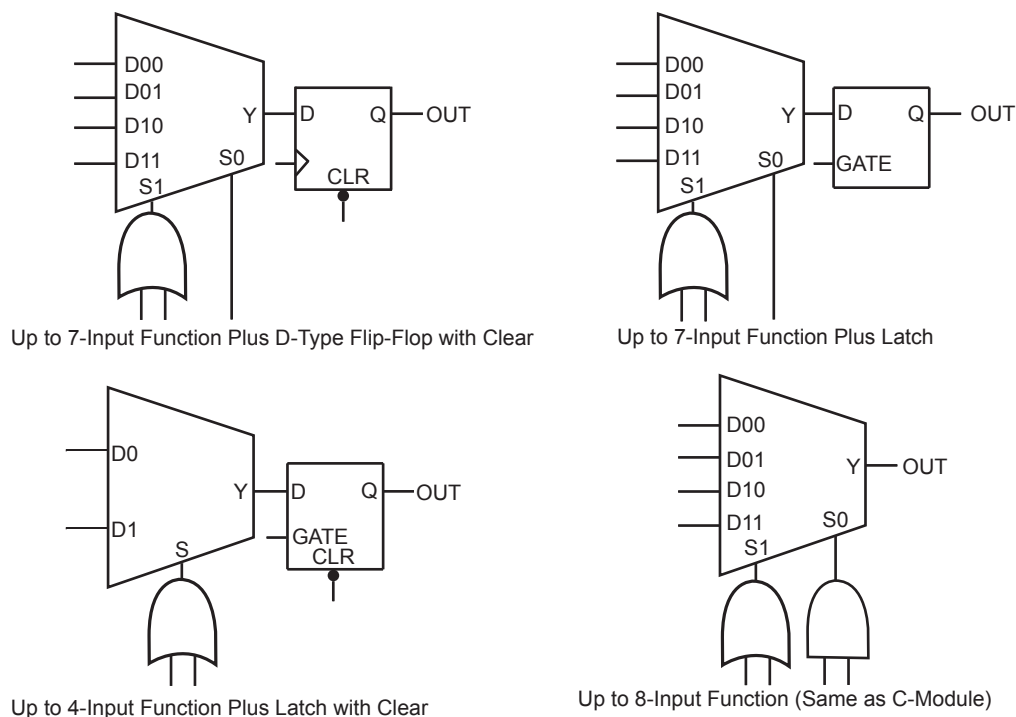


**Figure 1-3 • 42MX S-Module Implementation**

A42MX24 and A42MX36 devices contain D-modules, which are arranged around the periphery of the device. D-modules contain wide-decode circuitry, providing a fast, wide-input AND function similar to that found in CPLD architectures (Figure 1-4 on page 1-4). The D-module allows A42MX24 and A42MX36 devices to perform wide-decode functions at speeds comparable to CPLDs and PALs. The output of the D-module has a programmable inverter for active HIGH or LOW assertion. The D-module output is hardwired to an output pin, and can also be fed back into the array to be incorporated into other logic.

## Dual-Port SRAM Modules

The A42MX36 device contains dual-port SRAM modules that have been optimized for synchronous or asynchronous applications. The SRAM modules are arranged in 256-bit blocks that can be configured as 32x8 or 64x4. SRAM modules can be cascaded together to form memory spaces of user-definable width and depth. A block diagram of the A42MX36 dual-port SRAM block is shown in Figure 1-5 on page 1-4.

The A42MX36 SRAM modules are true dual-port structures containing independent read and write ports. Each SRAM module contains six bits of read and write addressing (RDAD[5:0] and WRAD[5:0], respectively) for 64x4-bit blocks. When configured in byte mode, the highest order address bits (RDAD5 and WRAD5) are not used. The read and write ports of the SRAM block contain independent clocks (RCLK and WCLK) with programmable polarities offering active HIGH or LOW implementation. The SRAM block contains eight data inputs (WD[7:0]), and eight outputs (RD[7:0]), which are connected to segmented vertical routing tracks.

The A42MX36 dual-port SRAM blocks provide an optimal solution for high-speed buffered applications requiring FIFO and LIFO queues. The ACTgen Macro Builder within Microsemi's Designer software provides capability to quickly design memory functions with the SRAM blocks. Unused SRAM blocks can be used to implement registers for other user logic within the design.

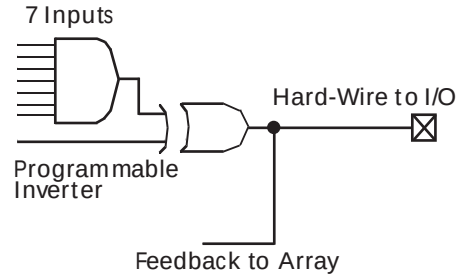


**Figure 1-4 • A42MX24 and A42MX36 D-Module Implementation**

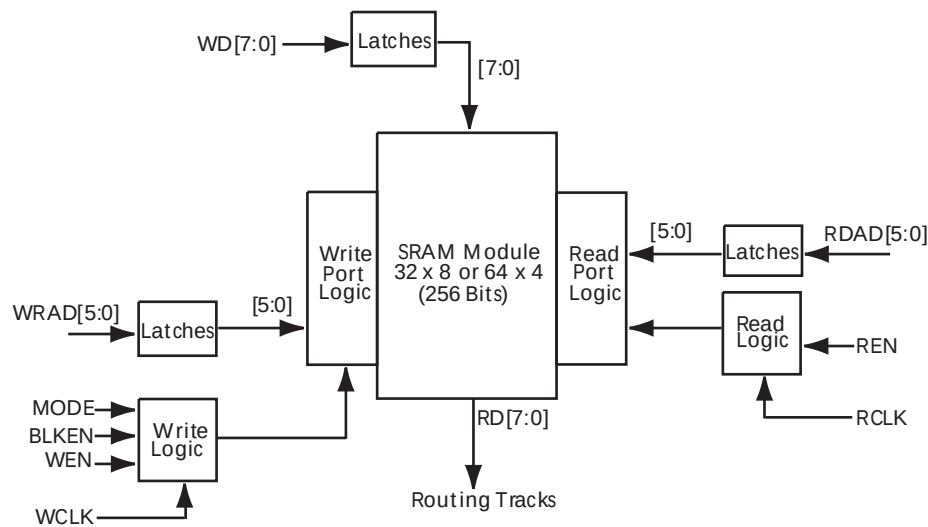


**Figure 1-5 • A42MX36 Dual-Port SRAM Block**

## Routing Structure

The MX architecture uses vertical and horizontal routing tracks to interconnect the various logic and I/O modules. These routing tracks are metal interconnects that may be continuous or split into segments. Varying segment lengths allow the interconnect of over 90% of design tracks to occur with only two antifuse connections. Segments can be joined together at the ends using antifuses to increase their lengths up to the full length of the track. All interconnects can be accomplished with a maximum of four antifuses.

### Horizontal Routing

Horizontal routing tracks span the whole row length or are divided into multiple segments and are located in between the rows of modules. Any segment that spans more than one-third of the row length is considered a long horizontal segment. A typical channel is shown in [Figure 1-6](#). Within horizontal routing, dedicated routing tracks are used for global clock networks and for power and ground tie-off tracks. Non-dedicated tracks are used for signal nets.

### Vertical Routing

Another set of routing tracks run vertically through the module. There are three types of vertical tracks: input, output, and long. Long tracks span the column length of the module, and can be divided into multiple segments. Each segment in an input track is dedicated to the input of a particular module; each segment in an output track is dedicated to the output of a particular module. Long segments are uncommitted and can be assigned during routing.

Each output segment spans four channels (two above and two below), except near the top and bottom of the array, where edge effects occur. Long vertical tracks contain either one or two segments. An example of vertical routing tracks and segments is shown in [Figure 1-6](#).

## Antifuse Structures

An antifuse is a "normally open" structure. The use of antifuses to implement a programmable logic device results in highly testable structures as well as efficient programming algorithms. There are no pre-existing connections; temporary connections can be made using pass transistors. These temporary connections can isolate individual antifuses to be programmed and individual circuit structures to be tested, which can be done before and after programming. For instance, all metal tracks can be tested for continuity and shorts between adjacent tracks, and the functionality of all logic modules can be verified.

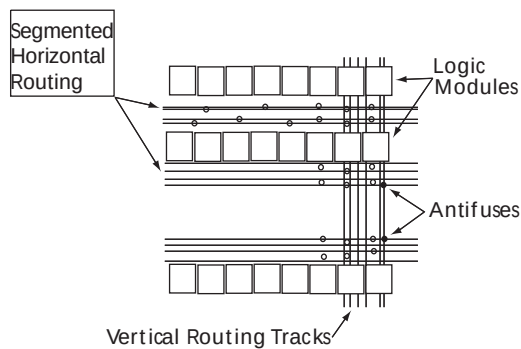


**Figure 1-6 • MX Routing Structure**

## Clock Networks

The 40MX devices have one global clock distribution network (CLK). A signal can be put on the CLK network by being routed through the CLKBUF buffer.

In 42MX devices, there are two low-skew, high-fanout clock distribution networks, referred to as CLKA and CLKB. Each network has a clock module (CLKMOD) that can select the source of the clock signal from any of the following (Figure 1-7 on page 1-6):

- Externally from the CLKA pad, using CLKBUF buffer
- Externally from the CLKB pad, using CLKBUF buffer
- Internally from the CLKINTA input, using CLKINT buffer
- Internally from the CLKINTB input, using CLKINT buffer

The clock modules are located in the top row of I/O modules. Clock drivers and a dedicated horizontal clock track are located in each horizontal routing channel.

Clock input pads in both 40MX and 42MX devices can also be used as normal I/Os, bypassing the clock networks.

The A42MX36 device has four additional register control resources, called quadrant clock networks (Figure 1-8 on page 1-6). Each quadrant clock provides a local, high-fanout resource to the contiguous logic modules within its quadrant of the device. Quadrant clock signals can originate from specific I/O pins or from the internal array and can be used as a secondary register clock, register clear, or output enable.

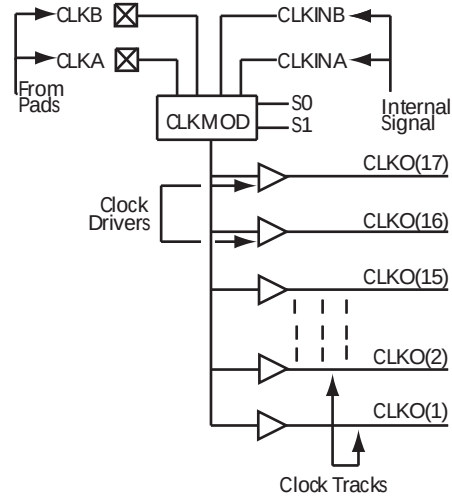
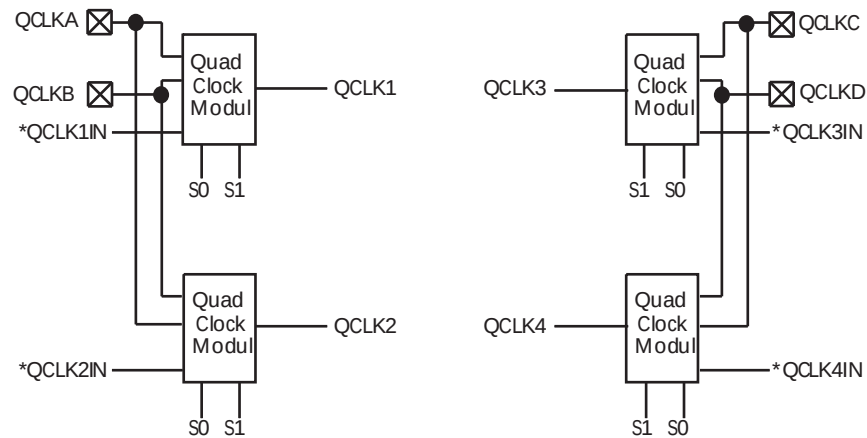


**Figure 1-7 • Clock Networks of 42MX Devices**



*Note: \*QCLK1IN, QCLK2IN, QCLK3IN, and QCLK4IN are internally-generated signals.*

**Figure 1-8 • Quadrant Clock Network of A42MX36 Devices**

## MultiPlex I/O Modules

42MX devices feature Multiplex I/Os and support 5.0 V, 3.3 V, and mixed 3.3 V/5.0 V operations.

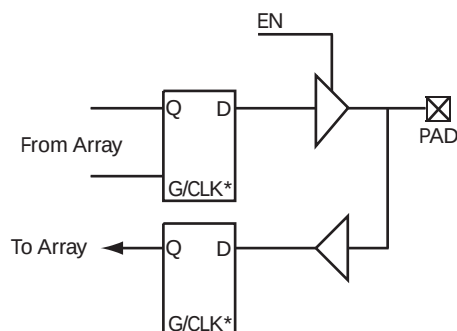
The MultiPlex I/O modules provide the interface between the device pins and the logic array. [Figure 1-9](#) is a block diagram of the 42MX I/O module. A variety of user functions, determined by a library macro selection, can be implemented in the module. (Refer to the [Antifuse Macro Library Guide](#) for more information.) All 42MX I/O modules contain tristate buffers, with input and output latches that can be configured for input, output, or bidirectional operation.

All 42MX devices contain flexible I/O structures, where each output pin has a dedicated output-enable control ([Figure 1-9](#)). The I/O module can be used to latch input or output data, or both, providing fast set-up time. In addition, the Designer software tools can build a D-type flip-flop using a C-module combined with an I/O module to register input and output signals. Refer to the [Antifuse Macro Library Guide](#) for more details.

A42MX24 and A42MX36 devices also offer selectable PCI output drives, enabling 100% compliance with version 2.1 of the PCI specification. For low-power systems, all inputs and outputs are turned off to reduce current consumption to below 500  $\mu$ A.

To achieve 5.0 V or 3.3 V PCI-compliant output drives on A42MX24 and A42MX36 devices, a chip-wide PCI fuse is programmed via the Device Selection Wizard in the Designer software ([Figure 1-10](#)). When the PCI fuse is not programmed, the output drive is standard.

Designer software development tools provide a design library of I/O macro functions that can implement all I/O configurations supported by the MX FPGAs.



*Note:* \*Can be configured as a Latch or D Flip-Flop (Using C-Module)

**Figure 1-9 • 42MX I/O Module**

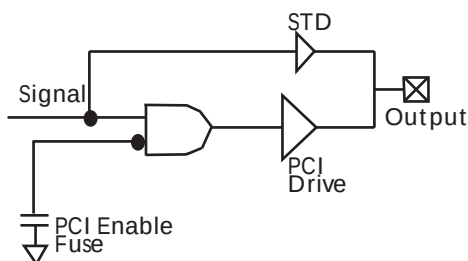


**Figure 1-10 • PCI Output Structure of A42MX24 and A42MX36 Devices**

## Other Architectural Features

### Performance

MX devices can operate with internal clock frequencies of 250 MHz, enabling fast execution of complex logic functions. MX devices are live on power-up and do not require auxiliary configuration devices and thus are an optimal platform to integrate the functionality contained in multiple programmable logic devices. In addition, designs that previously would have required a gate array to meet performance can be integrated into an MX device with improvements in cost and time-to-market. Using timing-driven place-and-route (TDPR) tools, designers can achieve highly deterministic device performance.

### User Security

Microsemi FuseLock provides robust security against design theft. Special security fuses are hidden in the fabric of the device and protect against unauthorized users attempting to access the programming and/or probe interfaces. It is virtually impossible to identify or bypass these fuses without damaging the device, making Microsemi antifuse FPGAs protected with the highest level of security available from both invasive and noninvasive attacks.

Special security fuses in 40MX devices include the Probe Fuse and Program Fuse. The former disables the probing circuitry while the latter prohibits further programming of all fuses, including the Probe Fuse. In 42MX devices, there is the Security Fuse which, when programmed, both disables the probing circuitry and prohibits further programming of the device.

### Programming

Device programming is supported through the Silicon Sculptor series of programmers. Silicon Sculptor II is a compact, robust, single-site and multi-site device programmer for the PC. With standalone software, Silicon Sculptor II is designed to allow concurrent programming of multiple units from the same PC.

Silicon Sculptor II programs devices independently to achieve the fastest programming times possible. After being programmed, each fuse is verified to insure that it has been programmed correctly. Furthermore, at the end of programming, there are integrity tests that are run to ensure no extra fuses have been programmed. Not only does it test fuses (both programmed and non-programmed), Silicon Sculptor II also allows self-test to verify its own hardware extensively.

The procedure for programming an MX device using Silicon Sculptor II is as follows:

1. Load the \*.AFM file
2. Select the device to be programmed
3. Begin programming

When the design is ready to go to production, Microsemi offers device volume-programming services either through distribution partners or via In-House Programming from the factory.

For more details on programming MX devices, please refer to the [Programming Antifuse Devices](#) and the [Silicon Sculptor II and Silicon Sculptor 3](#) user guides.

## Power Supply

MX devices are designed to operate in both 5.0V and 3.3V environments. In particular, 42MX devices can operate in mixed 5.0 V/3.3 V systems. [Table 1-1](#) describes the voltage support of MX devices.

**Table 1-1 • Voltage Support of MX Devices**

| Device | VCC   | VCCA  | VCCI  | Maximum Input Tolerance | Nominal Output Voltage |
|--------|-------|-------|-------|-------------------------|------------------------|
| 40MX   | 5.0 V | –     | –     | 5.5 V                   | 5.0 V                  |
|        | 3.3 V | –     | –     | 3.6 V                   | 3.3 V                  |
| 42MX   | –     | 5.0 V | 5.0 V | 5.5 V                   | 5.0 V                  |
|        | –     | 3.3 V | 3.3 V | 3.6 V                   | 3.3 V                  |
|        | –     | 5.0 V | 3.3 V | 5.5 V                   | 3.3 V                  |

For A42MX24 and A42MX36 devices the VCCA supply has to be monotonic during power up in order for the POR to issue reset to the JTAG state machine correctly. For more information, refer to [MX\\_PowerUp\\_AN, \(AC291\)](#).

## Power-Up/Down in Mixed-Voltage Mode

When powering up 42MX in mixed voltage mode ( $VCCA = 5.0\text{ V}$  and  $VCCI = 3.3\text{ V}$ ), VCCA must be greater than or equal to VCCI throughout the power-up sequence. If VCCI exceeds VCCA during power-up, one of two things will happen:

- The input protection diode on the I/Os will be forward biased
- The I/Os will be at logical High

In either case, ICC rises to high levels.

For power-down, any sequence with VCCA and VCCI can be implemented.

## Transient Current

Due to the simultaneous random logic switching activity during power-up, a transient current may appear on the core supply (VCC). Customers must use a regulator for the VCC supply that can source a minimum of 100 mA for transient current during power-up. Failure to provide enough power can prevent the system from powering up properly and result in functional failure. However, there are no reliability concerns, since transient current is distributed across the die instead of confined to a localized spot.

Since the transient current is not due to I/O switching, its value and duration are independent of the VCCI.

## Low Power Mode

42MX devices have been designed with a Low Power Mode. This feature, activated with setting the special LP pin to HIGH for a period longer than 800 ns, is particularly useful for battery-operated systems where battery life is a primary concern. In this mode, the core of the device is turned off and the device consumes minimal power with low standby current. In addition, all input buffers are turned off, and all outputs and bidirectional buffers are tristated. Since the core of the device is turned off, the states of the registers are lost. The device must be re-initialized when exiting Low Power Mode. I/Os can be driven during LP mode, and clock pins should be driven HIGH or LOW and should not float to avoid drawing current. To exit LP mode, the LP pin must be pulled LOW for over 200  $\mu\text{s}$  to allow for charge pumps to power up, and device initialization will begin.

## Power Dissipation

The general power consumption of MX devices is made up of static and dynamic power and can be expressed with the following equation.

### General Power Equation

$$P = [ICC_{\text{standby}} + ICC_{\text{active}}] * V_{CC1} + I_{OL} * V_{OL} * N + I_{OH} * (V_{CC1} - V_{OH}) * M$$

where:

$ICC_{\text{standby}}$  is the current flowing when no inputs or outputs are changing.

$ICC_{\text{active}}$  is the current flowing due to CMOS switching.

$I_{OL}$ ,  $I_{OH}$  are TTL sink/source currents.

$V_{OL}$ ,  $V_{OH}$  are TTL level output voltages.

$N$  equals the number of outputs driving TTL loads to  $V_{OL}$ .

$M$  equals the number of outputs driving TTL loads to  $V_{OH}$ .

Accurate values for  $N$  and  $M$  are difficult to determine because they depend on the family type, on design details, and on the system I/O. The power can be divided into two components: static and active.

### Static Power Component

The static power due to standby current is typically a small component of the overall power consumption. Standby power is calculated for commercial, worst-case conditions. The static power dissipation by TTL loads depends on the number of outputs driving, and on the DC load current. For instance, a 32-bit bus sinking 4mA at 0.33V will generate 42mW with all outputs driving LOW, and 140mW with all outputs driving HIGH. The actual dissipation will average somewhere in between, as I/Os switch states with time.

### Active Power Component

Power dissipation in CMOS devices is usually dominated by the dynamic power dissipation. Dynamic power consumption is frequency-dependent and is a function of the logic and the external I/O. Active power dissipation results from charging internal chip capacitances of the interconnect, unprogrammed antifuses, module inputs, and module outputs, plus external capacitances due to PC board traces and load device inputs. An additional component of the active power dissipation is the totem pole current in the CMOS transistor pairs. The net effect can be associated with an equivalent capacitance that can be combined with frequency and voltage to represent active power dissipation.

The power dissipated by a CMOS circuit can be expressed by the equation:

$$\text{Power } (\mu\text{W}) = C_{EQ} * V_{CCA}^2 * F(1)$$

where:

$C_{EQ}$  = Equivalent capacitance expressed in picofarads (pF)

$V_{CCA}$  = Power supply in volts (V)

$F$  = Switching frequency in megahertz (MHz)

### Equivalent Capacitance

Equivalent capacitance is calculated by measuring  $ICC_{\text{active}}$  at a specified frequency and voltage for each circuit component of interest. Measurements have been made over a range of frequencies at a fixed value of  $V_{CC}$ . Equivalent capacitance is frequency-independent, so the results can be used over a wide range of operating conditions. Equivalent capacitance values are shown below.

## C<sub>EQ</sub> Values for Microsemi MX FPGAs

Modules (C<sub>EQM</sub>)3.5

Input Buffers (C<sub>EIQ</sub>)6.9

Output Buffers (C<sub>EQO</sub>)18.2

Routed Array Clock Buffer Loads (C<sub>EQCR</sub>)1.4

To calculate the active power dissipated from the complete design, the switching frequency of each part of the logic must be known. The equation below shows a piece-wise linear summation over all components.

$$\begin{aligned} \text{Power} = & VCCA^2 * [(m * C_{EQM} * f_m)_{\text{Modules}} + \\ & (n * C_{EIQ} * f_n)_{\text{Inputs}} + (p * (C_{EQO} + C_L) * f_p)_{\text{Outputs}} + \\ & 0.5 * (q_1 * C_{EQCR} * f_{q1})_{\text{routed\_Clk1}} + (r_1 * f_{q1})_{\text{routed\_Clk1}} + \\ & 0.5 * (q_2 * C_{EQCR} * f_{q2})_{\text{routed\_Clk2}} + (r_2 * f_{q2})_{\text{routed\_Clk2}} \quad (2) \end{aligned}$$

where:

|                   |   |                                                                |
|-------------------|---|----------------------------------------------------------------|
| m                 | = | Number of logic modules switching at frequency f <sub>m</sub>  |
| n                 | = | Number of input buffers switching at frequency f <sub>n</sub>  |
| p                 | = | Number of output buffers switching at frequency f <sub>p</sub> |
| q <sub>1</sub>    | = | Number of clock loads on the first routed array clock          |
| q <sub>2</sub>    | = | Number of clock loads on the second routed array clock         |
| r <sub>1</sub>    | = | Fixed capacitance due to first routed array clock              |
| r <sub>2</sub>    | = | Fixed capacitance due to second routed array clock             |
| C <sub>EQM</sub>  | = | Equivalent capacitance of logic modules in pF                  |
| C <sub>EIQ</sub>  | = | Equivalent capacitance of input buffers in pF                  |
| C <sub>EQO</sub>  | = | Equivalent capacitance of output buffers in pF                 |
| C <sub>EQCR</sub> | = | Equivalent capacitance of routed array clock in pF             |
| C <sub>L</sub>    | = | Output load capacitance in pF                                  |
| f <sub>m</sub>    | = | Average logic module switching rate in MHz                     |
| f <sub>n</sub>    | = | Average input buffer switching rate in MHz                     |
| f <sub>p</sub>    | = | Average output buffer switching rate in MHz                    |
| f <sub>q1</sub>   | = | Average first routed array clock rate in MHz                   |
| f <sub>q2</sub>   | = | Average second routed array clock rate in MHz                  |

Fixed Capacitance Values for MX FPGAs (pF)

| Device Type | r1 routed_Clk1 | r2 routed_Clk2 |
|-------------|----------------|----------------|
| A40MX02     | 41.4           | N/A            |
| A40MX04     | 68.6           | N/A            |
| A42MX09     | 118            | 118            |
| A42MX16     | 165            | 165            |
| A42MX24     | 185            | 185            |
| A42MX36     | 220            | 220            |

## Test Circuitry and Silicon Explorer II Probe

MX devices contain probing circuitry that provides built-in access to every node in a design, via the use of Silicon Explorer II. Silicon Explorer II is an integrated hardware and software solution that, in conjunction with the Designer software, allow users to examine any of the internal nets of the device while it is operating in a prototyping or a production system. The user can probe into an MX device without changing the placement and routing of the design and without using any additional resources. Silicon Explorer II's noninvasive method does not alter timing or loading effects, thus shortening the debug cycle and providing a true representation of the device under actual functional situations.

Silicon Explorer II samples data at 100 MHz (asynchronous) or 66 MHz (synchronous). Silicon Explorer II attaches to a PC's standard COM port, turning the PC into a fully functional 18-channel logic analyzer. Silicon Explorer II allows designers to complete the design verification process at their desks and reduces verification time from several hours per cycle to a few seconds.

Silicon Explorer II is used to control the MODE, DCLK, SDI and SDO pins in MX devices to select the desired nets for debugging. The user simply assigns the selected internal nets in the Silicon Explorer II software to the PRA/PRB output pins for observation. Probing functionality is activated when the MODE pin is held HIGH.

Figure 1-11 illustrates the interconnection between Silicon Explorer II and 40MX devices, while Figure 1-12 on page 1-12 illustrates the interconnection between Silicon Explorer II and 42MX devices

To allow for probing capabilities, the security fuses must not be programmed. (Refer to "User Security" section on page 1-8 for the security fuses of 40MX and 42MX devices). Table 1-2 on page 1-13 summarizes the possible device configurations for probing.

PRA and PRB pins are dual-purpose pins. When the "Reserve Probe Pin" is checked in the Designer software, PRA and PRB pins are reserved as dedicated outputs for probing. If PRA and PRB pins are required as user I/Os to achieve successful layout and "Reserve Probe Pin" is checked, the layout tool will override the option and place user I/Os on PRA and PRB pins.

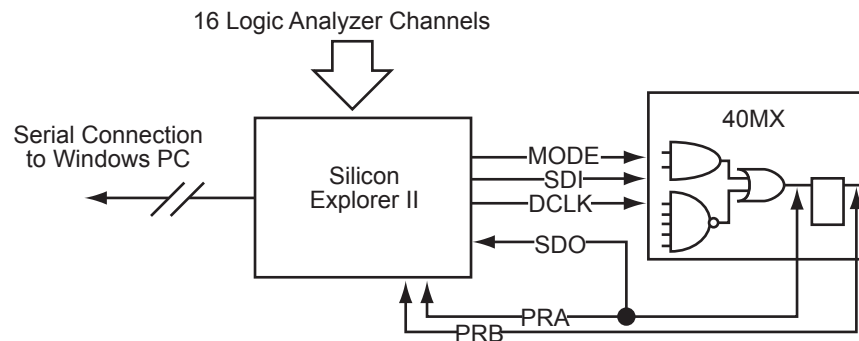


**Figure 1-11 • Silicon Explorer II Setup with 40MX**

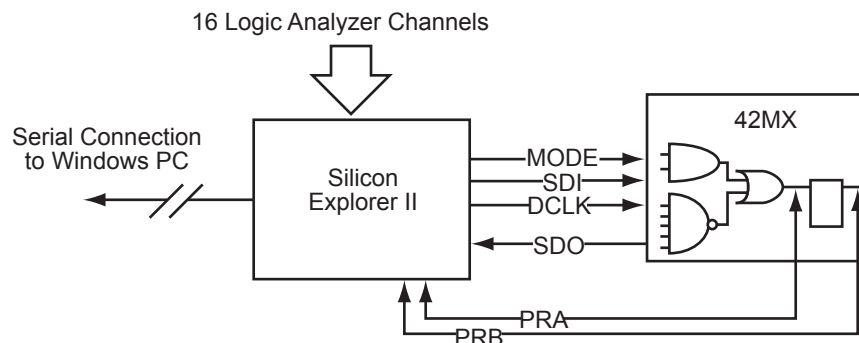


**Figure 1-12 • Silicon Explorer II Setup with 42MX**

**Table 1-2 • Device Configuration Options for Probe Capability**

| Security Fuse(s) Programmed | Mode | PRA, PRB <sup>1</sup>  | SDI, SDO, DCLK <sup>1</sup> |
|-----------------------------|------|------------------------|-----------------------------|
| No                          | LOW  | User I/Os <sup>2</sup> | User I/Os <sup>2</sup>      |
| No                          | HIGH | Probe Circuit Outputs  | Probe Circuit Inputs        |
| Yes                         | –    | Probe Circuit Secured  | Probe Circuit Secured       |

**Notes:**

1. Avoid using SDI, SDO, DCLK, PRA and PRB pins as input or bidirectional ports. Since these pins are active during probing, input signals will not pass through these pins and may cause contention.
2. If no user signal is assigned to these pins, they will behave as unused I/Os in this mode. See the "Pin Descriptions" section on page 1-83 for information on unused I/O pins.

## Design Consideration

It is recommended to use a series 70Ω termination resistor on every probe connector (SDI, SDO, MODE, DCLK, PRA and PRB). The 70Ω series termination is used to prevent data transmission corruption during probing and reading back the checksum.

## IEEE Standard 1149.1 Boundary Scan Test (BST) Circuitry

42MX24 and 42MX36 devices are compatible with IEEE Standard 1149.1 (informally known as Joint Testing Action Group Standard or JTAG), which defines a set of hardware architecture and mechanisms for cost-effective board-level testing. The basic MX boundary-scan logic circuit is composed of the TAP (test access port), TAP controller, test data registers and instruction register (Figure 1-13 on page 1-14). This circuit supports all mandatory IEEE 1149.1 instructions (EXTEST, SAMPLE/PRELOAD and BYPASS) and some optional instructions. Table 1-3 on page 1-14 describes the ports that control JTAG testing, while Table 1-4 on page 1-14 describes the test instructions supported by these MX devices.

Each test section is accessed through the TAP, which has four associated pins: TCK (test clock input), TDI and TDO (test data input and output), and TMS (test mode selector).

The TAP controller is a four-bit state machine. The '1's and '0's represent the values that must be present at TMS at a rising edge of TCK for the given state transition to occur. IR and DR indicate that the instruction register or the data register is operating in that state.

The TAP controller receives two control inputs (TMS and TCK) and generates control and clock signals for the rest of the test logic architecture. On power-up, the TAP controller enters the Test-Logic-Reset state. To guarantee a reset of the controller from any of the possible states, TMS must remain high for five TCK cycles.

42MX24 and 42MX36 devices support three types of test data registers: bypass, device identification, and boundary scan. The bypass register is selected when no other register needs to be accessed in a device. This speeds up test data transfer to other devices in a test data path. The 32-bit device identification register is a shift register with four fields (lowest significant byte (LSB), ID number, part number and version). The boundary-scan register observes and controls the state of each I/O pin.

Each I/O cell has three boundary-scan register cells, each with a serial-in, serial-out, parallel-in, and parallel-out pin. The serial pins are used to serially connect all the boundary-scan register cells in a device into a boundary-scan register chain, which starts at the TDI pin and ends at the TDO pin. The parallel ports are connected to the internal core logic tile and the input, output and control ports of an I/O buffer to capture and load data into the register to control or observe the logic state of each I/O.

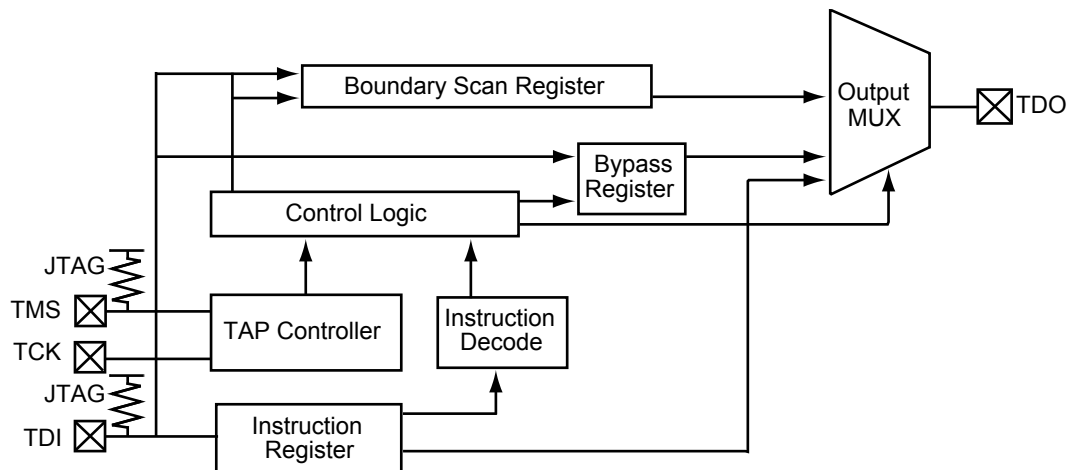


**Figure 1-13 • 42MX IEEE 1149.1 Boundary Scan Circuitry**

**Table 1-3 • Test Access Port Descriptions**

| Port                      | Description                                                                                                                                                                                                                                               |
|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TMS<br>(Test Mode Select) | Serial input for the test logic control bits. Data is captured on the rising edge of the test logic clock (TCK).                                                                                                                                          |
| TCK<br>(Test Clock Input) | Dedicated test logic clock used serially to shift test instruction, test data, and control inputs on the rising edge of the clock, and serially to shift the output data on the falling edge of the clock. The maximum clock frequency for TCK is 20 MHz. |
| TDI<br>(Test Data Input)  | Serial input for instruction and test data. Data is captured on the rising edge of the test logic clock.                                                                                                                                                  |
| TDO<br>(Test Data Output) | Serial output for test instruction and data from the test logic. TDO is set to an Inactive Drive state (high impedance) when data scanning is not in progress.                                                                                            |

**Table 1-4 • Supported BST Public Instructions**

| Instruction    | IR Code (IR2.IR0) | Instruction Type | Description                                                                                                                                                              |
|----------------|-------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EXTEST         | 000               | Mandatory        | Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.   |
| SAMPLE/PRELOAD | 001               | Mandatory        | Allows a snapshot of the signals at the device pins to be captured and examined during operation                                                                         |
| HIGH Z         | 101               | Optional         | Tristates all I/Os to allow external signals to drive pins. Please refer to the IEEE Standard 1149.1 specification.                                                      |
| CLAMP          | 110               | Optional         | Allows state of signals driven from component pins to be determined from the Boundary-Scan Register. Please refer to the IEEE Standard 1149.1 specification for details. |
| BYPASS         | 111               | Mandatory        | Enables the bypass register between the TDI and TDO pins. The test data passes through the selected device to adjacent devices in the test chain.                        |

## JTAG Mode Activation

The JTAG test logic circuit is activated in the Designer software by selecting **Tools > Device Selection**. This brings up the Device Selection dialog box as shown in [Figure 1-14](#). The JTAG test logic circuit can be enabled by clicking the "Reserve JTAG Pins" check box. [Table 1-5](#) explains the pins' behavior in either mode.



**Figure 1-14 • Device Selection Wizard**

**Table 1-5 • Boundary Scan Pin Configuration and Functionality**

| Reserve JTAG | Checked                                                                | Unchecked |
|--------------|------------------------------------------------------------------------|-----------|
| TCK          | BST input; must be terminated to logical HIGH or LOW to avoid floating | User I/O  |
| TDI, TMS     | BST input; may float or be tied to HIGH                                | User I/O  |
| TDO          | BST output; may float or be connected to TDI of another device         | User I/O  |

## TRST Pin and TAP Controller Reset

An active reset (TRST) pin is not supported; however, MX devices contain power-on circuitry that resets the boundary scan circuitry upon power-up. Also, the TMS pin is equipped with an internal pull-up resistor. This allows the TAP controller to remain in or return to the Test-Logic-Reset state when there is no input or when a logical 1 is on the TMS pin. To reset the controller, TMS must be HIGH for at least five TCK cycles.

## Boundary Scan Description Language (BSDL) File

Conforming to the IEEE Standard 1149.1 requires that the operation of the various JTAG components be documented. The BSDL file provides the standard format to describe the JTAG components that can be used by automatic test equipment software. The file includes the instructions that are supported, instruction bit pattern, and the boundary-scan chain order. For an in-depth discussion on BSDL files, please refer to the [BSDL Files Format Description](#) application note.

BSDL files are grouped into two categories - generic and device-specific. The generic files assign all user I/Os as inouts. Device-specific files assign user I/Os as inputs, outputs or inouts.

Generic files for MX devices are available on the Microsemi SoC Product Group's website:

<http://www.microsemi.com/soc/techdocs/models/bsdl.html>.

## Development Tool Support

The MX family of FPGAs is fully supported by Libero® Integrated Design Environment (IDE). Libero IDE is a design management environment, seamlessly integrating design tools while guiding the user through the design flow, managing all design and log files, and passing necessary design data among tools. Libero IDE allows users to integrate both schematic and HDL synthesis into a single flow and verify the entire design in a single environment. Libero IDE includes SynplifyPro from Synopsys, ModelSim® HDL Simulator from Mentor Graphics,® and Viewdraw.

Libero IDE includes place-and-route and provides a comprehensive suite of backend support tools for FPGA development, including timing-driven place-and-route, and a world-class integrated static timing analyzer and constraints editor.

Additionally, the back-annotation flow is compatible with all the major simulators and the simulation results can be cross-probed with Silicon Explorer II, Microsemi's integrated verification and logic analysis tool. Another tool included in the Libero software is the SmartGen macro builder, which easily creates popular and commonly used logic functions for implementation into your schematic or HDL design.

Microsemi's Libero software is compatible with the most popular FPGA design entry and verification tools from companies such as Mentor Graphics, Synopsys, and Cadence Design Systems.

Refer to the Libero IDE web content at [www.microsemi.com/soc/products/software/libero/default.aspx](http://www.microsemi.com/soc/products/software/libero/default.aspx) for further information on licensing and current operating system support.

## Related Documents

### Application Notes

*BSDL Files Format Description*

[www.microsemi.com/soc/documents/BSDLformat\\_AN.pdf](http://www.microsemi.com/soc/documents/BSDLformat_AN.pdf)

*Programming Antifuse Devices*

[http://www.microsemi.com/soc/documents/AntifuseProgram\\_AN.pdf](http://www.microsemi.com/soc/documents/AntifuseProgram_AN.pdf)

*Implementation of Security in Microsemi Antifuse FPGAs*

[www.microsemi.com/documents/Antifuse\\_Security\\_AN.pdf](http://www.microsemi.com/documents/Antifuse_Security_AN.pdf)

### User Guides and Manuals

*Antifuse Macro Library Guide*

[www.microsemi.com/soc/documents/libguide\\_UG.pdf](http://www.microsemi.com/soc/documents/libguide_UG.pdf)

*Silicon Sculptor II and Silicon Sculptor 3 User Guide*

[www.microsemi.com/soc/techdocs/manuals/default.asp#programmers](http://www.microsemi.com/soc/techdocs/manuals/default.asp#programmers)

### Miscellaneous

*Libero IDE Flow Diagram*

[www.microsemi.com/soc/products/tools/libero/flow.html](http://www.microsemi.com/soc/products/tools/libero/flow.html)

## 5.0 V Operating Conditions

**Table 1-6 • Absolute Maximum Ratings for 40MX Devices\***

| Symbol           | Parameter           | Limits          | Units |
|------------------|---------------------|-----------------|-------|
| VCC              | DC Supply Voltage   | −0.5 to +7.0    | V     |
| VI               | Input Voltage       | −0.5 to VCC+0.5 | V     |
| VO               | Output Voltage      | −0.5 to VCC+0.5 | V     |
| t <sub>STG</sub> | Storage Temperature | −65 to +150     | °C    |

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the Recommended Operating Conditions.

**Table 1-7 • Absolute Maximum Ratings for 42MX Devices\***

| Symbol           | Parameter                   | Limits           | Units |
|------------------|-----------------------------|------------------|-------|
| VCCI             | DC Supply Voltage for I/Os  | −0.5 to +7.0     | V     |
| VCCA             | DC Supply Voltage for Array | −0.5 to +7.0     | V     |
| VI               | Input Voltage               | −0.5 to VCCI+0.5 | V     |
| VO               | Output Voltage              | −0.5 to VCCI+0.5 | V     |
| t <sub>STG</sub> | Storage Temperature         | −65 to +150      | °C    |

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the Recommended Operating Conditions.

**Table 1-8 • Recommended Operating Conditions**

| Parameter          | Commercial   | Industrial | Military    | Units |
|--------------------|--------------|------------|-------------|-------|
| Temperature Range* | 0 to +70     | −40 to +85 | −55 to +125 | °C    |
| VCC (40MX)         | 4.75 to 5.25 | 4.5 to 5.5 | 4.5 to 5.5  | V     |
| VCCA (42MX)        | 4.75 to 5.25 | 4.5 to 5.5 | 4.5 to 5.5  | V     |
| VCCI (42MX)        | 4.75 to 5.25 | 4.5 to 5.5 | 4.5 to 5.5  | V     |

**Note:** \*Ambient temperature ( $T_A$ ) is used for commercial and industrial grades; case temperature ( $T_C$ ) is used for military grades.

## 5 V TTL Electrical Specifications

Table 1-9 • 5V TTL Electrical Specifications

| Symbol                                                   | Parameter                                                                                                                                                                 | Commercial |            | Commercial -F |            | Industrial |            | Military |            | Units |
|----------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|---------------|------------|------------|------------|----------|------------|-------|
|                                                          |                                                                                                                                                                           | Min.       | Max.       | Min.          | Max.       | Min.       | Max.       | Min.     | Max.       |       |
| VOH <sup>1</sup>                                         | I <sub>OH</sub> = –10 mA                                                                                                                                                  | 2.4        |            | 2.4           |            |            |            |          |            | V     |
|                                                          | I <sub>OH</sub> = –4 mA                                                                                                                                                   |            |            |               |            | 3.7        |            | 3.7      |            | V     |
| VOL <sup>1</sup>                                         | I <sub>OL</sub> = 10 mA                                                                                                                                                   |            | 0.5        |               | 0.5        |            |            |          |            | V     |
|                                                          | I <sub>OL</sub> = 6 mA                                                                                                                                                    |            |            |               |            |            | 0.4        |          | 0.4        | V     |
| VIL                                                      |                                                                                                                                                                           | –0.3       | 0.8        | –0.3          | 0.8        | –0.3       | 0.8        | –0.3     | 0.8        | V     |
| VIH (40MX)                                               |                                                                                                                                                                           | 2.0        | VCC + 0.3  | 2.0           | VCC + 0.3  | 2.0        | VCC + 0.3  | 2.0      | VCC + 0.3  | V     |
| VIH (42MX)                                               |                                                                                                                                                                           | 2.0        | VCCI + 0.3 | 2.0           | VCCI + 0.3 | 2.0        | VCCI + 0.3 | 2.0      | VCCI + 0.3 | V     |
| IIL                                                      | V <sub>IN</sub> = 0.5 V                                                                                                                                                   |            | –10        |               | –10        |            | –10        |          | –10        | μA    |
| I <sub>IH</sub>                                          | V <sub>IN</sub> = 2.7 V                                                                                                                                                   |            | –10        |               | –10        |            | –10        |          | –10        | μA    |
| Input Transition Time, T <sub>R</sub> and T <sub>F</sub> |                                                                                                                                                                           |            | 500        |               | 500        |            | 500        |          | 500        | ns    |
| C <sub>IO</sub> I/O Capacitance                          |                                                                                                                                                                           |            | 10         |               | 10         |            | 10         |          | 10         | pF    |
| Standby Current, I <sub>CC</sub> <sup>2</sup>            | A40MX02, A40MX04                                                                                                                                                          |            | 3          |               | 25         |            | 10         |          | 25         | mA    |
|                                                          | A42MX09                                                                                                                                                                   |            | 5          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX16                                                                                                                                                                   |            | 6          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX24, A42MX36                                                                                                                                                          |            | 20         |               | 25         |            | 25         |          | 25         | mA    |
| Low power mode Standby Current                           | 42MX devices only                                                                                                                                                         |            | 0.5        |               | ICC – 5.0  |            | ICC – 5.0  |          | ICC – 5.0  | mA    |
| I <sub>IO</sub> , I/O source sink current                | Can be derived from the <i>IBIS model</i> ( <a href="http://www.microsemi.com/soc/techdocs/models/ibis.html">http://www.microsemi.com/soc/techdocs/models/ibis.html</a> ) |            |            |               |            |            |            |          |            |       |

**Notes:**

1. Only one output tested at a time. VCC/VCCI = min.
2. All outputs unloaded. All inputs = VCC/VCCI or GND.

## 3.3 V Operating Conditions

**Table 1-10 • Absolute Maximum Ratings for 40MX Devices\***

| Symbol           | Parameter           | Limits            | Units |
|------------------|---------------------|-------------------|-------|
| VCC              | DC Supply Voltage   | –0.5 to +7.0      | V     |
| VI               | Input Voltage       | –0.5 to VCC + 0.5 | V     |
| VO               | Output Voltage      | –0.5 to VCC + 0.5 | V     |
| t <sub>STG</sub> | Storage Temperature | –65 to + 150      | °C    |

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the Recommended Operating Conditions.

**Table 1-11 • Absolute Maximum Ratings for 42MX Devices\***

| Symbol           | Parameter                   | Limits           | Units |
|------------------|-----------------------------|------------------|-------|
| VCCI             | DC Supply Voltage for I/Os  | –0.5 to +7.0     | V     |
| VCCA             | DC Supply Voltage for Array | –0.5 to +7.0     | V     |
| VI               | Input Voltage               | –0.5 to VCCI+0.5 | V     |
| VO               | Output Voltage              | –0.5 to VCCI+0.5 | V     |
| t <sub>STG</sub> | Storage Temperature         | –65 to +150      | °C    |

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the Recommended Operating Conditions.

**Table 1-12 • Recommended Operating Conditions**

| Parameter          | Commercial | Industrial | Military    | Units |
|--------------------|------------|------------|-------------|-------|
| Temperature Range* | 0 to +70   | –40 to +85 | –55 to +125 | °C    |
| VCC (40MX)         | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |
| VCCA (42MX)        | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |
| VCCI (42MX)        | 3.0 to 3.6 | 3.0 to 3.6 | 3.0 to 3.6  | V     |

**Note:** \*Ambient temperature ( $T_A$ ) is used for commercial and industrial grades; case temperature ( $T_C$ ) is used for military grades.

### 3.3 V LVTTL Electrical Specifications

**Table 1-13 • 3.3V LVTTL Electrical Specifications**

| Symbol                                                   | Parameter                                                                                                                                                                 | Commercial |            | Commercial -F |            | Industrial |            | Military |            | Units |
|----------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|---------------|------------|------------|------------|----------|------------|-------|
|                                                          |                                                                                                                                                                           | Min.       | Max.       | Min.          | Max.       | Min.       | Max.       | Min.     | Max.       |       |
| VOH <sup>1</sup>                                         | IOH = -4 mA                                                                                                                                                               | 2.15       |            | 2.15          |            | 2.4        |            | 2.4      |            | V     |
| VOL <sup>1</sup>                                         | IOL = 6 mA                                                                                                                                                                |            | 0.4        |               | 0.4        |            | 0.48       |          | 0.48       | V     |
| VIL                                                      |                                                                                                                                                                           | -0.3       | 0.8        | -0.3          | 0.8        | -0.3       | 0.8        | -0.3     | 0.8        | V     |
| VIH (40MX)                                               |                                                                                                                                                                           | 2.0        | VCC + 0.3  | 2.0           | VCC + 0.3  | 2.0        | VCC + 0.3  | 2.0      | VCC + 0.3  | V     |
| VIH (42MX)                                               |                                                                                                                                                                           | 2.0        | VCCI + 0.3 | 2.0           | VCCI + 0.3 | 2.0        | VCCI + 0.3 | 2.0      | VCCI + 0.3 | V     |
| IIL                                                      |                                                                                                                                                                           |            | -10        |               | -10        |            | -10        |          | -10        | μA    |
| IIH                                                      |                                                                                                                                                                           |            | -10        |               | -10        |            | -10        |          | -10        | μA    |
| Input Transition Time, T <sub>R</sub> and T <sub>F</sub> |                                                                                                                                                                           |            | 500        |               | 500        |            | 500        |          | 500        | ns    |
| C <sub>IO</sub> I/O Capacitance                          |                                                                                                                                                                           |            | 10         |               | 10         |            | 10         |          | 10         | pF    |
| Standby Current, ICC <sup>2</sup>                        | A40MX02, A40MX04                                                                                                                                                          |            | 3          |               | 25         |            | 10         |          | 25         | mA    |
|                                                          | A42MX09                                                                                                                                                                   |            | 5          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX16                                                                                                                                                                   |            | 6          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX24, A42MX36                                                                                                                                                          |            | 15         |               | 25         |            | 25         |          | 25         | mA    |
| Low-Power Mode Standby Current                           | 42MX devices only                                                                                                                                                         |            | 0.5        |               | ICC - 5.0  |            | ICC - 5.0  |          | ICC - 5.0  | mA    |
| IIO, I/O source sink current                             | Can be derived from the <i>IBIS model</i> ( <a href="http://www.microsemi.com/soc/techdocs/models/ibis.html">http://www.microsemi.com/soc/techdocs/models/ibis.html</a> ) |            |            |               |            |            |            |          |            |       |

**Notes:**

1. Only one output tested at a time. VCC/VCCI = min.
2. All outputs unloaded. All inputs = VCC/VCCI or GND.

## Mixed 5.0 V / 3.3 V Operating Conditions (for 42MX Devices Only)

**Table 1-14 • Absolute Maximum Ratings\***

| Symbol           | Parameter                   | Limits             | Units |
|------------------|-----------------------------|--------------------|-------|
| VCCI             | DC Supply Voltage for I/Os  | −0.5 to +7.0       | V     |
| VCCA             | DC Supply Voltage for Array | −0.5 to +7.0       | V     |
| VI               | Input Voltage               | −0.5 to VCCA + 0.5 | V     |
| VO               | Output Voltage              | −0.5 to VCCI + 0.5 | V     |
| t <sub>STG</sub> | Storage Temperature         | −65 to +150        | °C    |

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the Recommended Operating Conditions.

**Table 1-15 • Recommended Operating Conditions**

| Parameter          | Commercial   | Industrial | Military    | Units |
|--------------------|--------------|------------|-------------|-------|
| Temperature Range* | 0 to +70     | −40 to +85 | −55 to +125 | °C    |
| VCCA               | 4.75 to 5.25 | 4.5 to 5.5 | 4.5 to 5.5  | V     |
| VCCI               | 3.14 to 3.47 | 3.0 to 3.6 | 3.0 to 3.6  | V     |

**Note:** \*Ambient temperature ( $T_A$ ) is used for commercial and industrial grades; case temperature ( $T_C$ ) is used for military grades.

## Mixed 5.0V/3.3V Electrical Specifications

**Table 1-16 • Mixed 5.0V/3.3V Electrical Specifications**

| Symbol                                                   | Parameter                                                                                                                                                                 | Commercial |            | Commercial –F |            | Industrial |            | Military |            | Units |
|----------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|---------------|------------|------------|------------|----------|------------|-------|
|                                                          |                                                                                                                                                                           | Min.       | Max.       | Min.          | Max.       | Min.       | Max.       | Min.     | Max.       |       |
| VOH <sup>1</sup>                                         | IOH = –10 mA                                                                                                                                                              | 2.4        |            | 2.4           |            |            |            |          |            | V     |
|                                                          | IOH = –4 mA                                                                                                                                                               |            |            |               |            | 2.4        |            | 2.4      |            | V     |
| VOL <sup>1</sup>                                         | IOL = 10 mA                                                                                                                                                               |            | 0.5        |               | 0.5        |            |            |          |            | V     |
|                                                          | IOL = 6 mA                                                                                                                                                                |            |            |               |            |            | 0.4        |          | 0.4        | V     |
| VIL                                                      |                                                                                                                                                                           | –0.3       | 0.8        | –0.3          | 0.8        | –0.3       | 0.8        | –0.3     | 0.8        | V     |
| VIH                                                      |                                                                                                                                                                           | 2.0        | VCCA + 0.3 | 2.0           | VCCA + 0.3 | 2.0        | VCCA + 0.3 | 2.0      | VCCA + 0.3 | V     |
| IL                                                       | VIN = 0.5 V                                                                                                                                                               |            | –10        |               | –10        |            | –10        |          | –10        | μA    |
| IH                                                       | VIN = 2.7 V                                                                                                                                                               |            | –10        |               | –10        |            | –10        |          | –10        | μA    |
| Input Transition Time, T <sub>R</sub> and T <sub>F</sub> |                                                                                                                                                                           |            | 500        |               | 500        |            | 500        |          | 500        | ns    |
| C <sub>IO</sub> I/O Capacitance                          |                                                                                                                                                                           |            | 10         |               | 10         |            | 10         |          | 10         | pF    |
| Standby Current, ICC <sup>2</sup>                        | A42MX09                                                                                                                                                                   |            | 5          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX16                                                                                                                                                                   |            | 6          |               | 25         |            | 25         |          | 25         | mA    |
|                                                          | A42MX24, A42MX36                                                                                                                                                          |            | 20         |               | 25         |            | 25         |          | 25         | mA    |
| Low Power Mode Standby Current                           |                                                                                                                                                                           |            | 0.5        |               | ICC – 5.0  |            | ICC – 5.0  |          | ICC – 5.0  | mA    |
| I/O I/O source sink current                              | Can be derived from the <i>IBIS model</i> ( <a href="http://www.microsemi.com/soc/techdocs/models/ibis.html">http://www.microsemi.com/soc/techdocs/models/ibis.html</a> ) |            |            |               |            |            |            |          |            |       |

**Notes:**

1. Only one output tested at a time. VCCI = min.
2. All outputs unloaded. All inputs = VCCI or GND.

## Output Drive Characteristics for 5.0 V PCI Signaling

MX PCI device I/O drivers were designed specifically for high-performance PCI systems. Figure 1-15 on page 1-25 shows the typical output drive characteristics of the MX devices. MX output drivers are compliant with the PCI Local Bus Specification.

**Table 1-17 • DC Specification (5.0 V PCI Signaling)<sup>1</sup>**

| Symbol           | Parameter                  | Condition                                            | PCI  |                       | MX   |                        | Units |
|------------------|----------------------------|------------------------------------------------------|------|-----------------------|------|------------------------|-------|
|                  |                            |                                                      | Min. | Max.                  | Min. | Max.                   |       |
| V <sub>CC1</sub> | Supply Voltage for I/Os    |                                                      | 4.75 | 5.25                  | 4.75 | 5.25 <sup>2</sup>      | V     |
| V <sub>IH</sub>  | Input High Voltage         |                                                      | 2.0  | V <sub>CC</sub> + 0.5 | 2.0  | V <sub>CC1</sub> + 0.3 | V     |
| V <sub>IL</sub>  | Input Low Voltage          |                                                      | −0.5 | 0.8                   | −0.3 | 0.8                    | V     |
| I <sub>IH</sub>  | Input High Leakage Current | V <sub>IN</sub> = 2.7 V                              |      | 70                    | —    | 10                     | μA    |
| I <sub>IL</sub>  | Input Low Leakage Current  | V <sub>IN</sub> = 0.5 V                              |      | −70                   | —    | −10                    | μA    |
| V <sub>OH</sub>  | Output High Voltage        | I <sub>OUT</sub> = −2 mA<br>I <sub>OUT</sub> = −6 mA | 2.4  |                       | 3.84 |                        | V     |
| V <sub>OL</sub>  | Output Low Voltage         | I <sub>OUT</sub> = 3 mA, 6 mA                        |      | 0.55                  | —    | 0.33                   | V     |
| C <sub>IN</sub>  | Input Pin Capacitance      |                                                      |      | 10                    | —    | 10                     | pF    |
| C <sub>CLK</sub> | CLK Pin Capacitance        |                                                      | 5    | 12                    | —    | 10                     | pF    |
| L <sub>PIN</sub> | Pin Inductance             |                                                      |      | 20                    | —    | < 8 nH <sup>3</sup>    | nH    |

**Notes:**

1. PCI Local Bus Specification, Version 2.1, Section 4.2.1.1.
2. Maximum rating for V<sub>CC1</sub> −0.5 V to 7.0 V.
3. Dependent upon the chosen package. PCI recommends QFP and BGA packaging to reduce pin inductance and capacitance.

**Table 1-18 • AC Specifications (5.0V PCI Signaling)\***

| Symbol          | Parameter             | Condition                 | PCI                                 |      | MX   |      | Units |
|-----------------|-----------------------|---------------------------|-------------------------------------|------|------|------|-------|
|                 |                       |                           | Min.                                | Max. | Min. | Max. |       |
| I <sub>CL</sub> | Low Clamp Current     | −5 < V <sub>IN</sub> ≤ −1 | −25 + (V <sub>IN</sub> + 1) / 0.015 |      | −60  | −10  | mA    |
| Slew (r)        | Output Rise Slew Rate | 0.4 V to 2.4 V load       | 1                                   | 5    | 1.8  | 2.8  | V/ns  |
| Slew (f)        | Output Fall Slew Rate | 2.4 V to 0.4 V load       | 1                                   | 5    | 2.8  | 4.3  | V/ns  |

**Note:** \*PCI Local Bus Specification, Version 2.1, Section 4.2.1.2.

## Output Drive Characteristics for 3.3 V PCI Signaling

**Table 1-19 • DC Specification (3.3 V PCI Signaling)<sup>1</sup>**

| Symbol           | Parameter                  | Condition         | PCI  |           | MX   |                     | Units |
|------------------|----------------------------|-------------------|------|-----------|------|---------------------|-------|
|                  |                            |                   | Min. | Max.      | Min. | Max.                |       |
| VCCI             | Supply Voltage for I/Os    |                   | 3.0  | 3.6       | 3.0  | 3.6                 | V     |
| VIH              | Input High Voltage         |                   | 0.5  | VCC + 0.5 | 0.5  | VCCI + 0.3          | V     |
| VIL              | Input Low Voltage          |                   | −0.5 | 0.8       | −0.3 | 0.8                 | V     |
| IIH              | Input High Leakage Current | VIN = 2.7 V       |      | 70        |      | 10                  | μA    |
| IIL              | Input Leakage Current      |                   |      | −70       |      | −10                 | μA    |
| VOH              | Output High Voltage        | IOUT = −2 mA      | 0.9  |           | 3.3  |                     | V     |
| VOL              | Output Low Voltage         | IOUT = 3 mA, 6 mA |      | 0.1       |      | 0.1 VCCI            | V     |
| CIN              | Input Pin Capacitance      |                   |      | 10        |      | 10                  | pF    |
| CLK              | CLK Pin Capacitance        |                   | 5    | 12        |      | 10                  | pF    |
| L <sub>PIN</sub> | Pin Inductance             |                   |      | 20        |      | < 8 nH <sup>3</sup> | nH    |

**Notes:**

1. PCI Local Bus Specification, Version 2.1, Section 4.2.2.1.
2. Maximum rating for VCCI −0.5 V to 7.0V.
3. Dependent upon the chosen package. PCI recommends QFP and BGA packaging to reduce pin inductance and capacitance.

**Table 1-20 • AC Specifications for (3.3 V PCI Signaling)\***

| Symbol   | Parameter             | Condition           | PCI                     |      | MX   |      | Units |
|----------|-----------------------|---------------------|-------------------------|------|------|------|-------|
|          |                       |                     | Min.                    | Max. | Min. | Max. |       |
| ICL      | Low Clamp Current     | −5 < VIN ≤ −1       | −25 + (VIN + 1) / 0.015 |      | −60  | −10  | mA    |
| Slew (r) | Output Rise Slew Rate | 0.2 V to 0.6 V load | 1                       | 4    | 1.8  | 2.8  | V/ns  |
| Slew (f) | Output Fall Slew Rate | 0.6 V to 0.2 V load | 1                       | 4    | 2.8  | 4.0  | V/ns  |

**Note:** \*PCI Local Bus Specification, Version 2.1, Section 4.2.2.2.

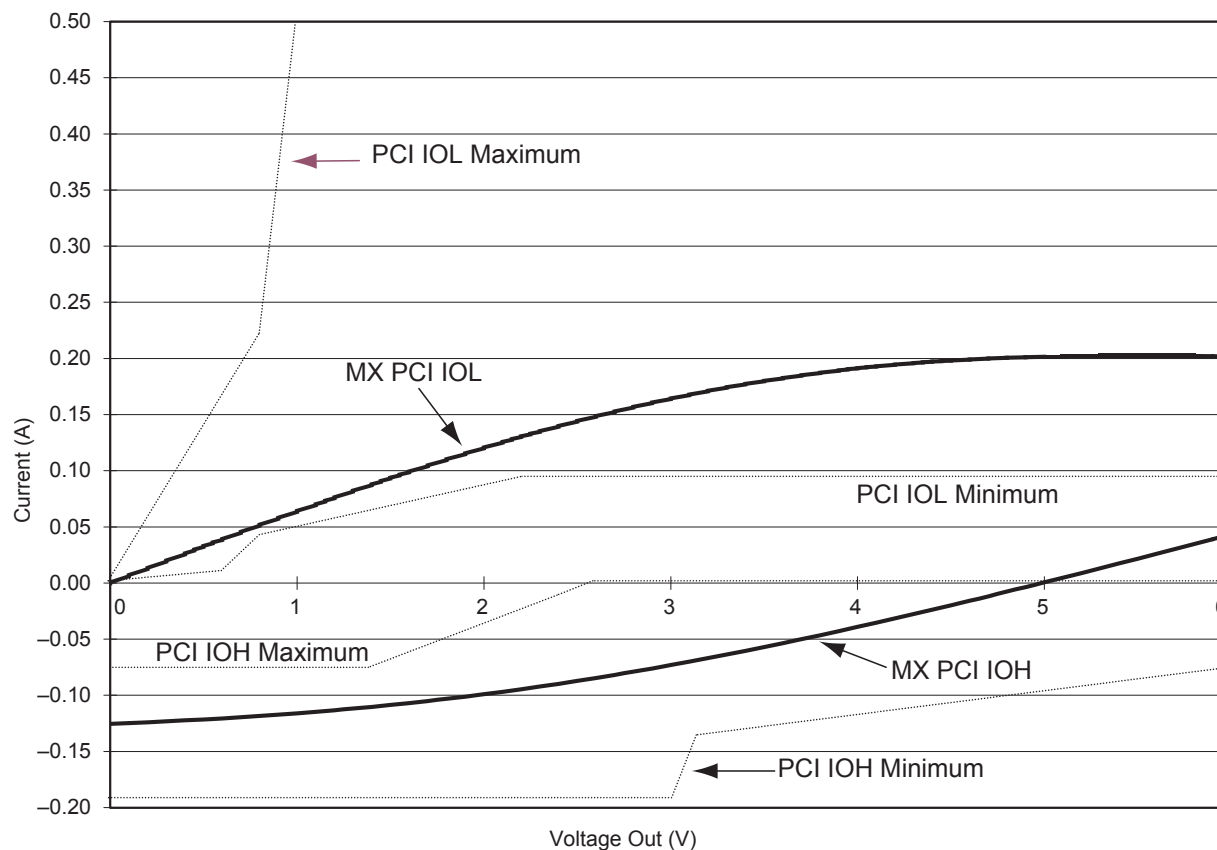


**Figure 1-15 • Typical Output Drive Characteristics (Based Upon Measured Data)**

## Junction Temperature ( $T_J$ )

The temperature variable in the Designer software refers to the junction temperature, not the ambient temperature. This is an important distinction because the heat generated from dynamic power consumption is usually hotter than the ambient temperature. [EQ 1](#), shown below, can be used to calculate junction temperature.

$$\text{Junction Temperature} = \Delta T + T_a \quad (1)$$

*EQ 1*

Where:

$T_a$  = Ambient Temperature

$\Delta T$  = Temperature gradient between junction (silicon) and ambient

$$\Delta T = \theta_{ja} * P \quad (2)$$

P = Power

$\theta_{ja}$  = Junction to ambient of package.  $\theta_{ja}$  numbers are located in [Table 1-21 on page 1-26](#).

## Package Thermal Characteristics

The device junction-to-case thermal characteristic is  $\theta_{jc}$ , and the junction-to-ambient air characteristic is  $\theta_{ja}$ . The thermal characteristics for  $\theta_{ja}$  are shown with two different air flow rates.

The maximum junction temperature is 150°C.

Maximum power dissipation for commercial- and industrial-grade devices is a function of  $\theta_{ja}$ .

A sample calculation of the absolute maximum power dissipation allowed for a TQ176 package at commercial temperature and still air is given in [EQ 2](#).

$$\text{Maximum Power Allowed} = \frac{\text{Max. junction temp. (}^{\circ}\text{C)} - \text{Max. ambient temp. (}^{\circ}\text{C)}}{\theta_{ja} (^{\circ}\text{C/W)}} = \frac{150^{\circ}\text{C} - 70^{\circ}\text{C}}{28^{\circ}\text{C/W}} = 2.86 \text{ W}$$

EQ 2

The maximum power dissipation for military-grade devices is a function of  $\theta_{jc}$ . A sample calculation of the absolute maximum power dissipation allowed for CQFP 208-pin package at military temperature and still air is given in [EQ 3](#).

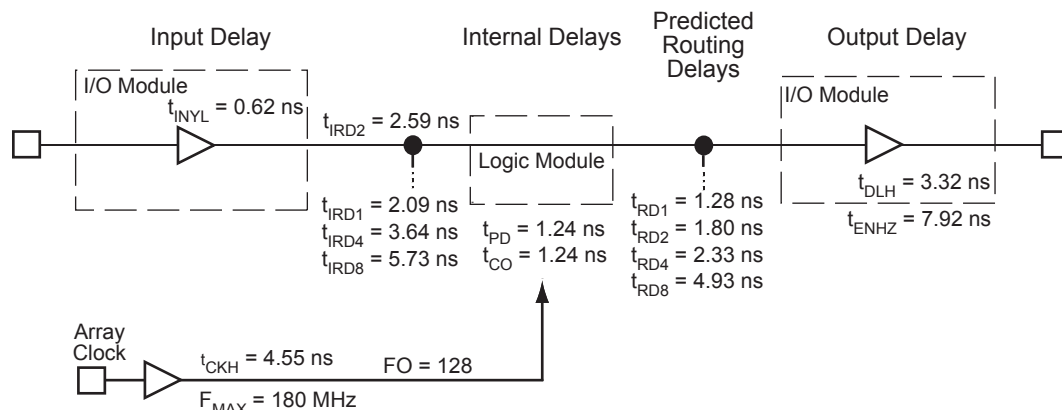
$$\text{Maximum Power Allowed} = \frac{\text{Max. junction temp. (}^{\circ}\text{C)} - \text{Max. ambient temp. (}^{\circ}\text{C)}}{\theta_{jc} (^{\circ}\text{C/W)}} = \frac{150^{\circ}\text{C} - 125^{\circ}\text{C}}{6.3^{\circ}\text{C/W}} = 3.97 \text{ W}$$

EQ 3

**Table 1-21 • Package Thermal Characteristics**

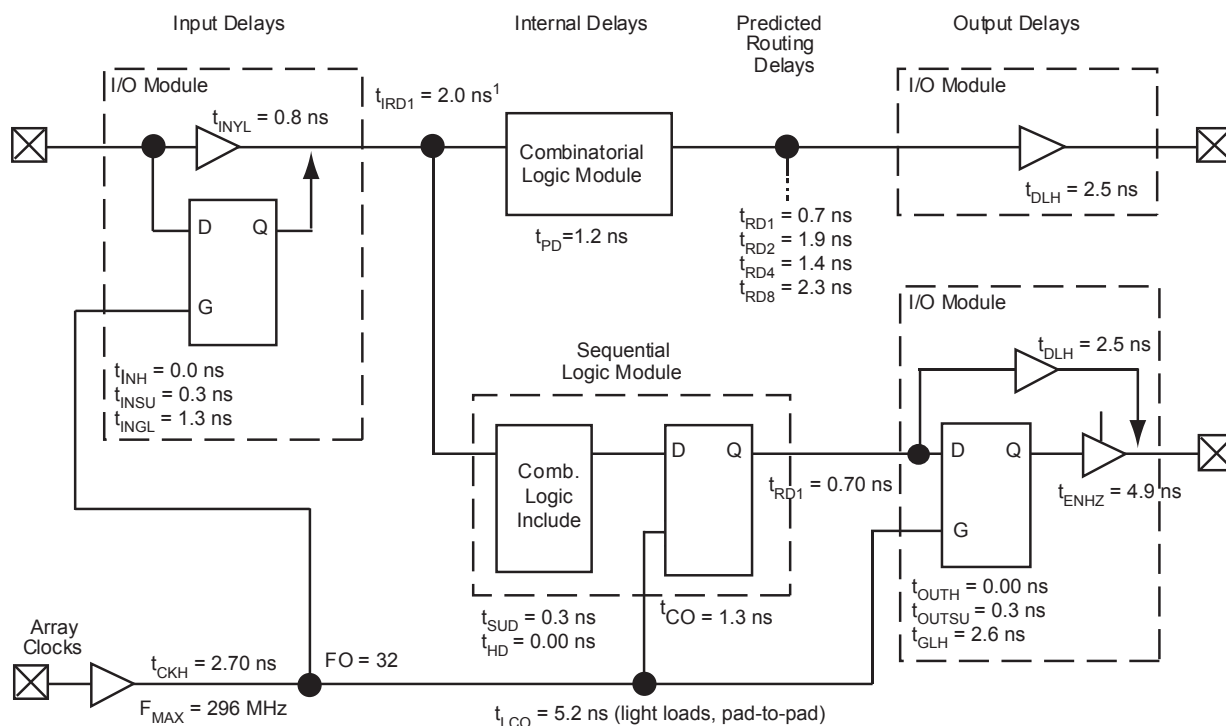
| Plastic Packages                 | Pin Count | $\theta_{jc}$ | $\theta_{ja}$ |                        |                        | Units                |
|----------------------------------|-----------|---------------|---------------|------------------------|------------------------|----------------------|
|                                  |           |               | Still Air     | 1.0 m/s<br>200 ft/min. | 2.5 m/s<br>500 ft/min. |                      |
| Plastic Quad Flat Pack           | 100       | 12.0          | 27.8          | 23.4                   | 21.2                   | $^{\circ}\text{C/W}$ |
| Plastic Quad Flat Pack           | 144       | 10.0          | 26.2          | 22.8                   | 21.1                   | $^{\circ}\text{C/W}$ |
| Plastic Quad Flat Pack           | 160       | 10.0          | 26.2          | 22.8                   | 21.1                   | $^{\circ}\text{C/W}$ |
| Plastic Quad Flat Pack           | 208       | 8.0           | 26.1          | 22.5                   | 20.8                   | $^{\circ}\text{C/W}$ |
| Plastic Quad Flat Pack           | 240       | 8.5           | 25.6          | 22.3                   | 20.8                   | $^{\circ}\text{C/W}$ |
| Plastic Leaded Chip Carrier      | 44        | 16.0          | 20.0          | 24.5                   | 22.0                   | $^{\circ}\text{C/W}$ |
| Plastic Leaded Chip Carrier      | 68        | 13.0          | 25.0          | 21.0                   | 19.4                   | $^{\circ}\text{C/W}$ |
| Plastic Leaded Chip Carrier      | 84        | 12.0          | 22.5          | 18.9                   | 17.6                   | $^{\circ}\text{C/W}$ |
| Thin Plastic Quad Flat Pack      | 176       | 11.0          | 24.7          | 19.9                   | 18.0                   | $^{\circ}\text{C/W}$ |
| Very Thin Plastic Quad Flat Pack | 80        | 12.0          | 38.2          | 31.9                   | 29.4                   | $^{\circ}\text{C/W}$ |
| Very Thin Plastic Quad Flat Pack | 100       | 10.0          | 35.3          | 29.4                   | 27.1                   | $^{\circ}\text{C/W}$ |
| Plastic Ball Grid Array          | 272       | 3.0           | 18.3          | 14.9                   | 13.9                   | $^{\circ}\text{C/W}$ |
| <b>Ceramic Packages</b>          |           |               |               |                        |                        |                      |
| Ceramic Pin Grid Array           | 132       | 4.8           | 25.0          | 20.6                   | 18.7                   | $^{\circ}\text{C/W}$ |
| Ceramic Quad Flat Pack           | 208       | 2.0           | 22.0          | 19.8                   | 18.0                   | $^{\circ}\text{C/W}$ |
| Ceramic Quad Flat Pack           | 256       | 2.0           | 20.0          | 16.5                   | 15.0                   | $^{\circ}\text{C/W}$ |

## Timing Models



*Note:* Values are shown for 40MX –3 speed devices at 5.0 V worst-case commercial conditions.

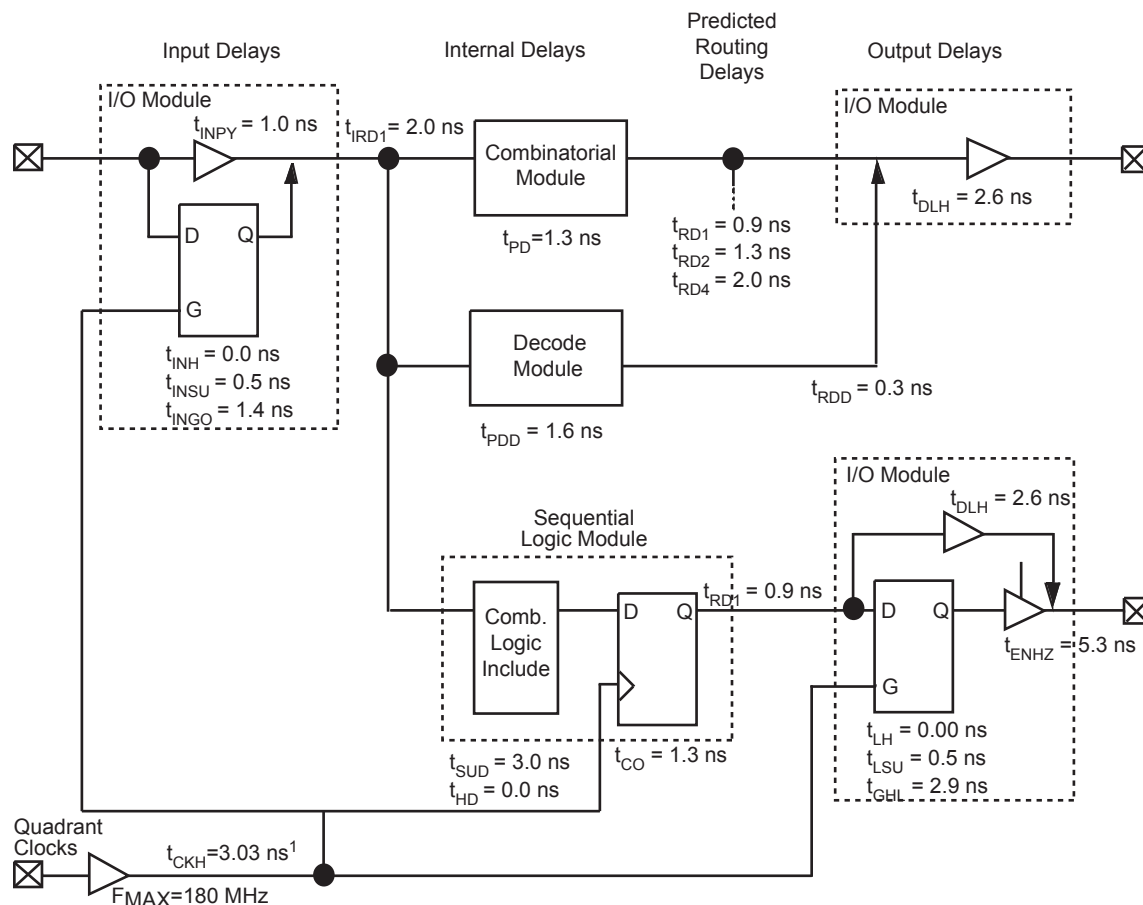
**Figure 1-16 • 40MX Timing Model\***



*Notes:*

1. Input module predicted routing delay
2. Values are shown for A42MX09 –3 at 5.0 V worst-case commercial conditions.

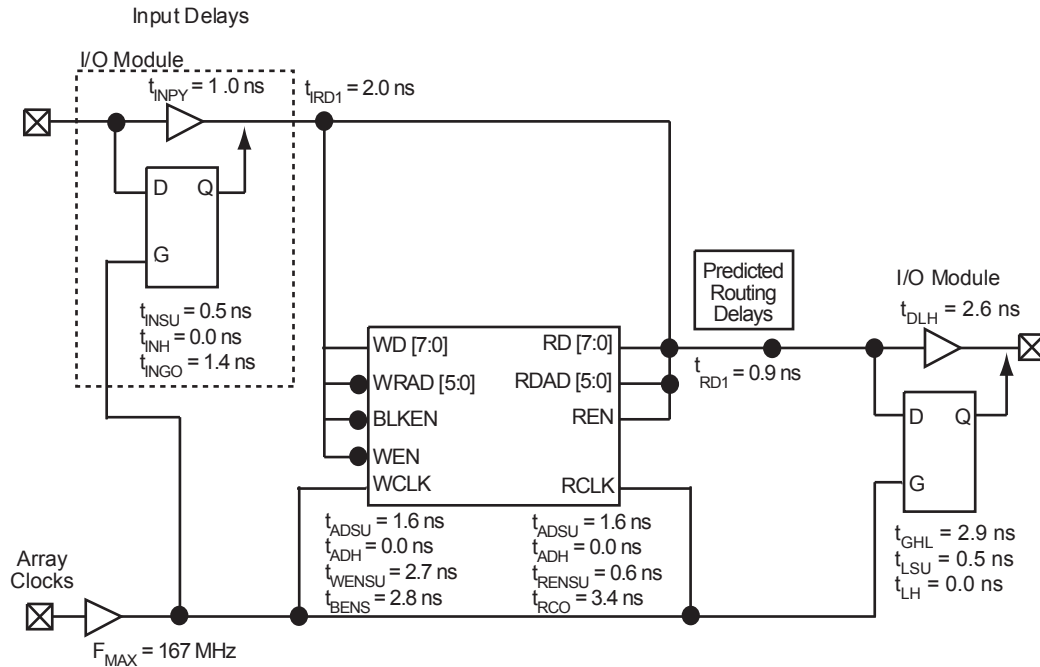
**Figure 1-17 • 42MX Timing Model**



**Notes:**

1. Load-dependent
2. Values are shown for A42MX36-3 at 5.0 V worst-case commercial conditions.

**Figure 1-18 • 42MX Timing Model (Logic Functions Using Quadrant Clocks)**



*Note:* Values are shown for A42MX36–3 at 5.0 V worst-case commercial conditions.

**Figure 1-19 • 42MX Timing Model (SRAM Functions)**

## Parameter Measurement

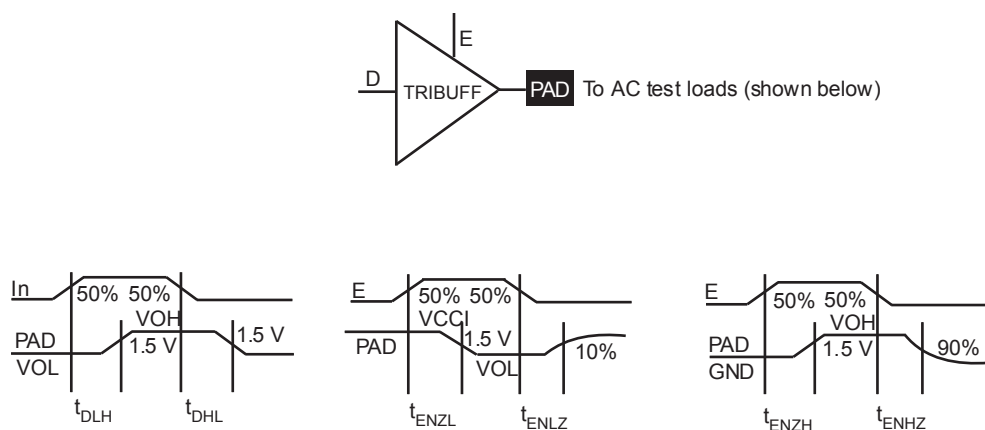


**Figure 1-20 • Output Buffer Delays**

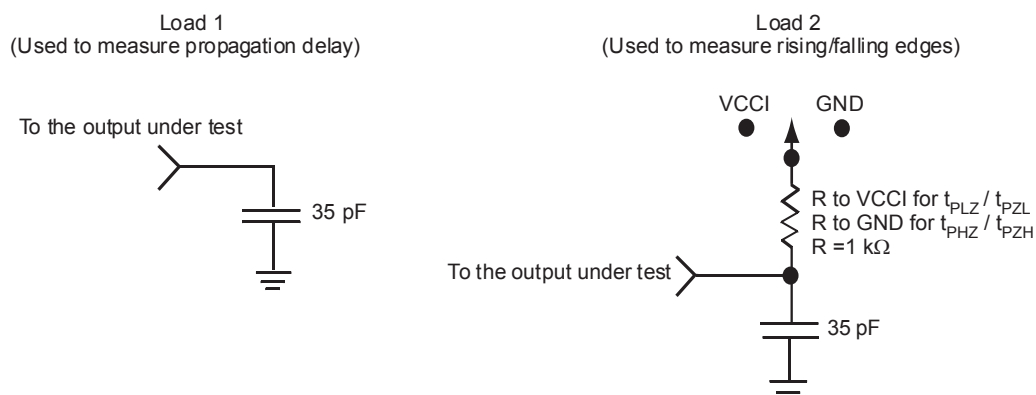


**Figure 1-21 • AC Test Loads**

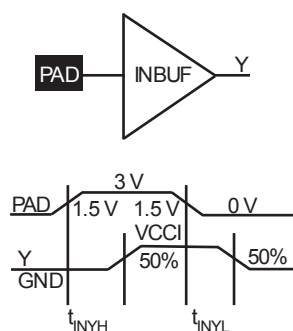


**Figure 1-22 • Input Buffer Delays**

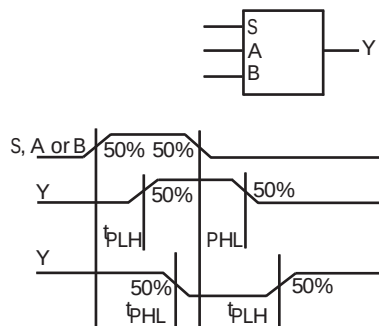
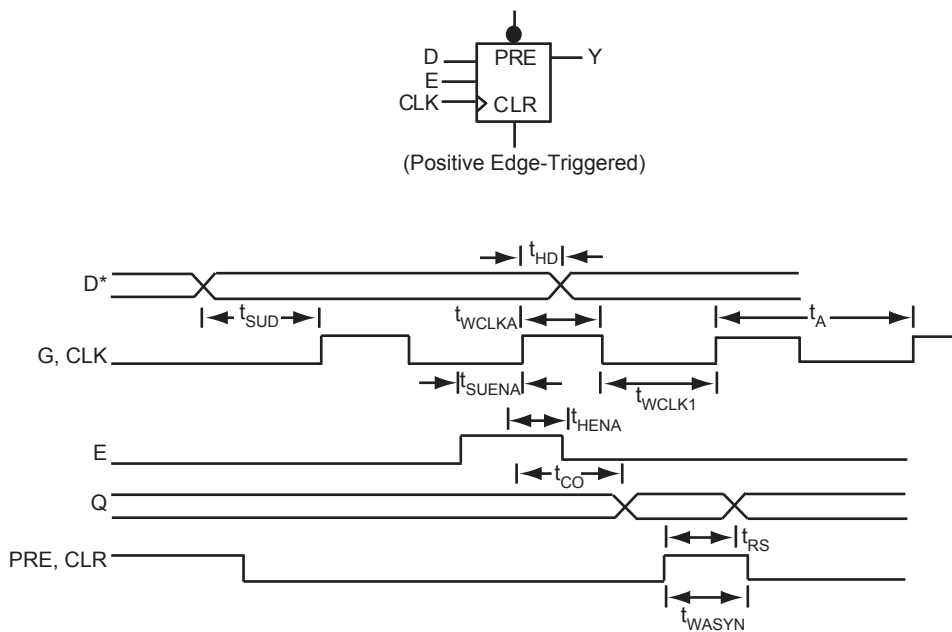


**Figure 1-23 • Module Delays**

## Sequential Module Timing Characteristics



**Note:** \*D represents all data functions involving A, B, and S for multiplexed flip-flops.

**Figure 1-24 • Flip-Flops and Latches**

## Sequential Timing Characteristics

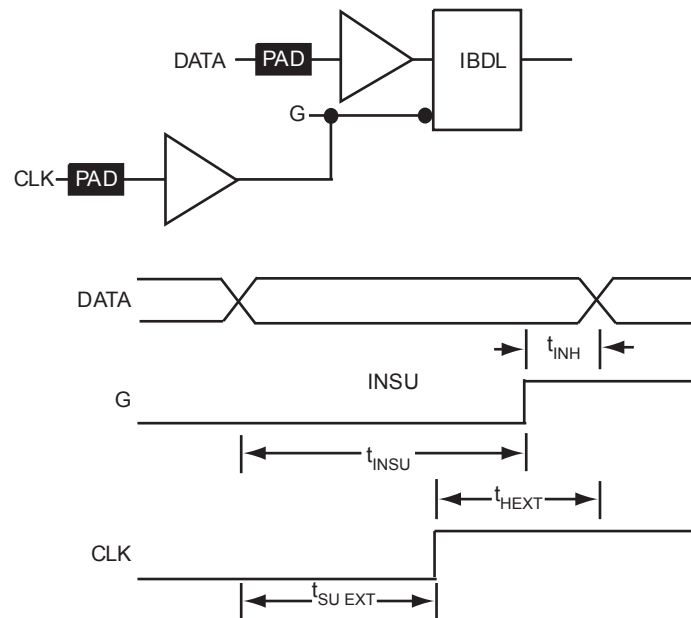


**Figure 1-25 • Input Buffer Latches**

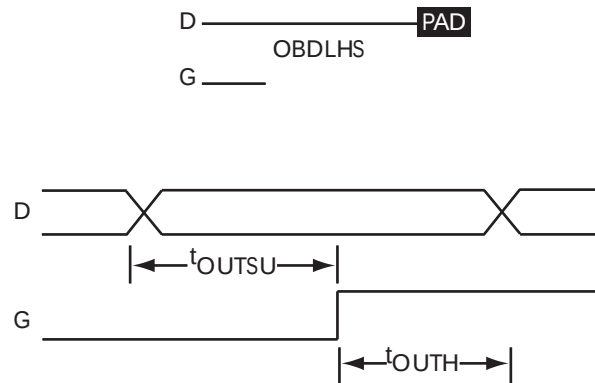


**Figure 1-26 • Output Buffer Latches**

## Decode Module Timing

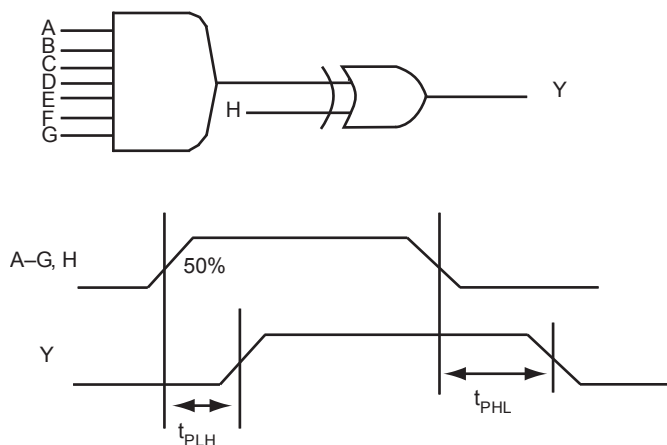


Figure 1-27 • Decode Module Timing

## SRAM Timing Characteristics

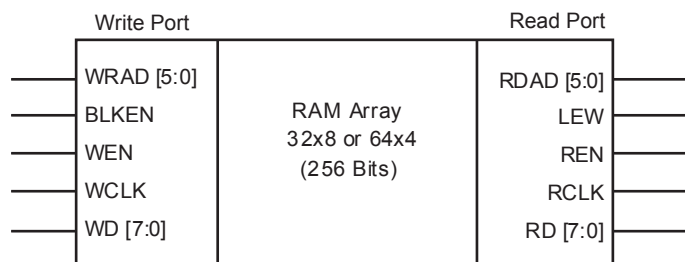
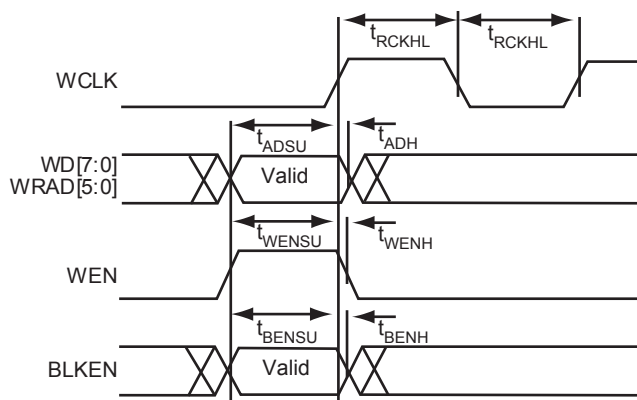


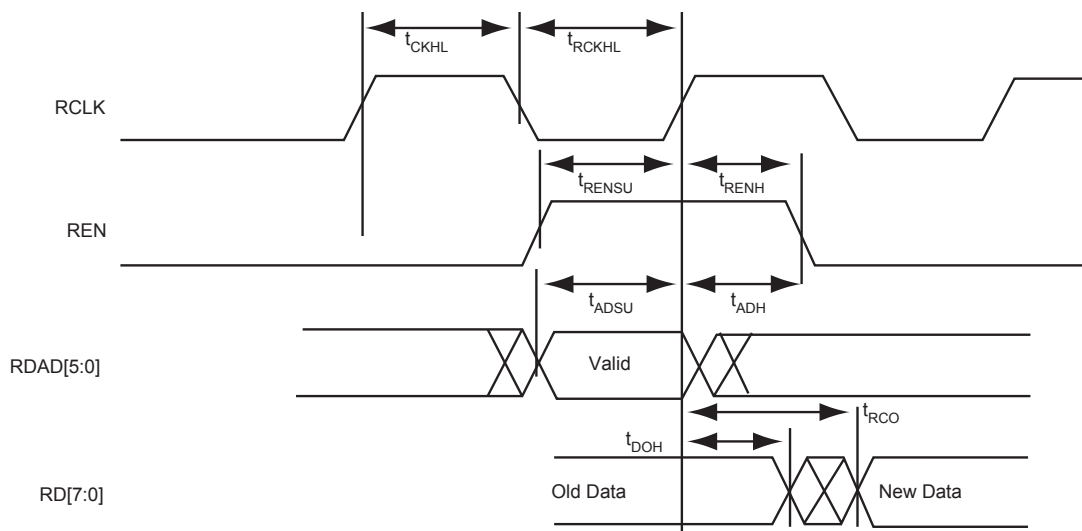
Figure 1-28 • SRAM Timing Characteristics

## Dual-Port SRAM Timing Waveforms



*Note:* Identical timing for falling edge clock.

Figure 1-29 • 42MX SRAM Write Operation



*Note:* Identical timing for falling edge clock.

**Figure 1-30 • 42MX SRAM Synchronous Read Operation**

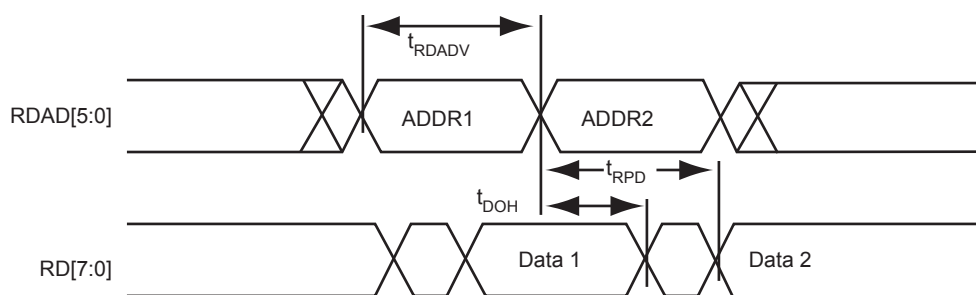


**Figure 1-31 • 42MX SRAM Asynchronous Read Operation—Type 1 (Read Address Controlled)**

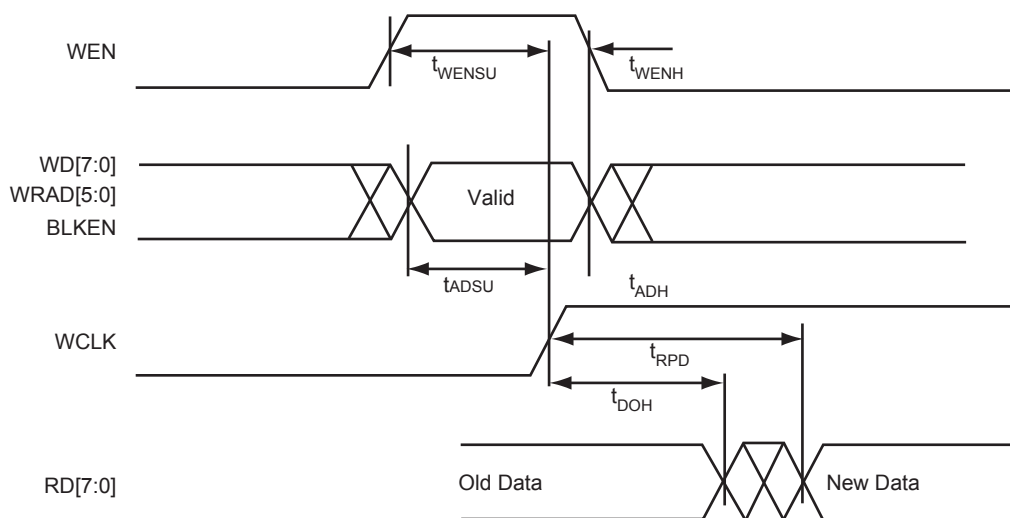


**Figure 1-32 • 42MX SRAM Asynchronous Read Operation—Type 2 (Write Address Controlled)**

## Predictable Performance: Tight Delay Distributions

Propagation delay between logic modules depends on the resistive and capacitive loading of the routing tracks, the interconnect elements, and the module inputs being driven. Propagation delay increases as the length of routing tracks, the number of interconnect elements, or the number of inputs increases.

From a design perspective, the propagation delay can be statistically correlated or modeled by the fanout (number of loads) driven by a module. Higher fanout usually requires some paths to have longer routing tracks.

The MX FPGAs deliver a tight fanout delay distribution, which is achieved in two ways: by decreasing the delay of the interconnect elements and by decreasing the number of interconnect elements per path.

Microsemi's patented antifuse offers a very low resistive/capacitive interconnect. The antifuses, fabricated in 0.45  $\mu\text{m}$  lithography, offer nominal levels of 100  $\Omega$  resistance and 7.0 fF capacitance per antifuse.

MX fanout distribution is also tight due to the low number of antifuses required for each interconnect path. The proprietary architecture limits the number of antifuses per path to a maximum of four, with 90 percent of interconnects using only two antifuses.

## Timing Characteristics

Device timing characteristics fall into three categories: family-dependent, device-dependent, and design-dependent. The input and output buffer characteristics are common to all MX devices. Internal routing delays are device-dependent; actual delays are not determined until after place-and-route of the user's design is complete. Delay values may then be determined by using the Designer software utility or by performing simulation with post-layout delays.

## Critical Nets and Typical Nets

Propagation delays are expressed only for typical nets, which are used for initial design performance evaluation. Critical net delays can then be applied to the most timing critical paths. Critical nets are determined by net property assignment in Microsemi's Designer software prior to placement and routing. Up to 6% of the nets in a design may be designated as critical.

## Long Tracks

Some nets in the design use long tracks, which are special routing resources that span multiple rows, columns, or modules. Long tracks employ three and sometimes four antifuse connections, which increase capacitance and resistance, resulting in longer net delays for macros connected to long tracks. Typically, up to 6 percent of nets in a fully utilized device require long tracks. Long tracks add approximately a 3 ns to a 6 ns delay, which is represented statistically in higher fanout (FO=8) routing delays in the data sheet specifications section, shown in [Table 1-28 on page 1-40](#).

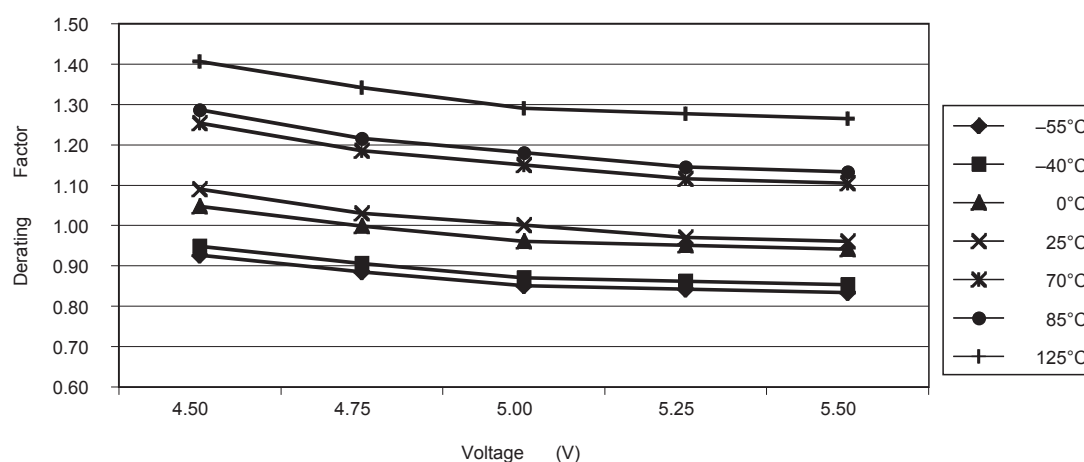
## Timing Derating

MX devices are manufactured with a CMOS process. Therefore, device performance varies according to temperature, voltage, and process changes. Minimum timing parameters reflect maximum operating voltage, minimum operating temperature and best-case processing. Maximum timing parameters reflect minimum operating voltage, maximum operating temperature and worst-case processing.

## Temperature and Voltage Derating Factors

**Table 1-22 • 42MX Temperature and Voltage Derating Factors**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CCA} = 5.0\text{ V}$ )

| 42MX Voltage | Temperature         |                     |                   |                    |                    |                    |                     |
|--------------|---------------------|---------------------|-------------------|--------------------|--------------------|--------------------|---------------------|
|              | $-55^\circ\text{C}$ | $-40^\circ\text{C}$ | $0^\circ\text{C}$ | $25^\circ\text{C}$ | $70^\circ\text{C}$ | $85^\circ\text{C}$ | $125^\circ\text{C}$ |
| 4.50         | 0.93                | 0.95                | 1.05              | 1.09               | 1.25               | 1.29               | 1.41                |
| 4.75         | 0.88                | 0.90                | 1.00              | 1.03               | 1.18               | 1.22               | 1.34                |
| 5.00         | 0.85                | 0.87                | 0.96              | 1.00               | 1.15               | 1.18               | 1.29                |
| 5.25         | 0.84                | 0.86                | 0.95              | 0.97               | 1.12               | 1.14               | 1.28                |
| 5.50         | 0.83                | 0.85                | 0.94              | 0.96               | 1.10               | 1.13               | 1.26                |

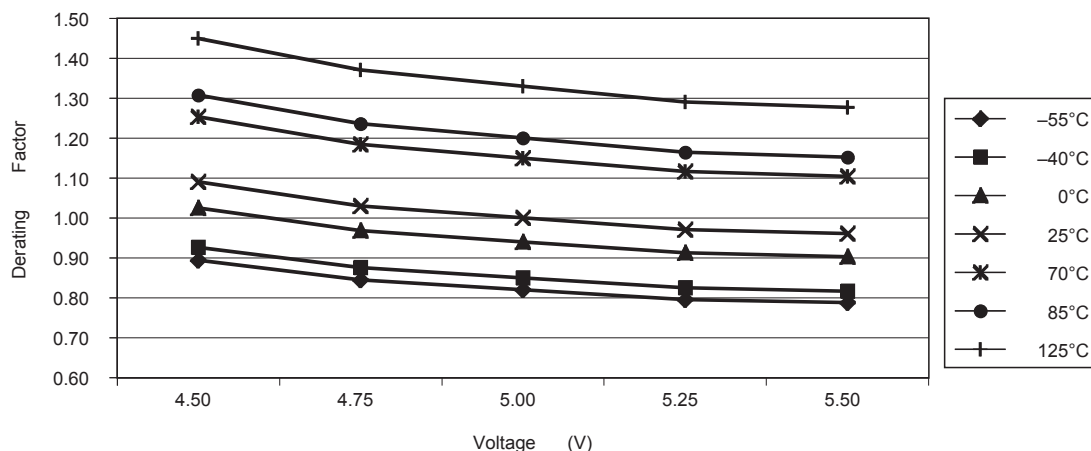


*Note:* This derating factor applies to all routing and propagation delays.

**Figure 1-33 • 42MX Junction Temperature and Voltage Derating Curves**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CCA} = 5.0\text{ V}$ )

**Table 1-23 • 40MX Temperature and Voltage Derating Factors**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V}$ )

| 40MX Voltage | Temperature         |                     |                   |                    |                    |                    |                     |
|--------------|---------------------|---------------------|-------------------|--------------------|--------------------|--------------------|---------------------|
|              | $-55^\circ\text{C}$ | $-40^\circ\text{C}$ | $0^\circ\text{C}$ | $25^\circ\text{C}$ | $70^\circ\text{C}$ | $85^\circ\text{C}$ | $125^\circ\text{C}$ |
| 4.50         | 0.89                | 0.93                | 1.02              | 1.09               | 1.25               | 1.31               | 1.45                |
| 4.75         | 0.84                | 0.88                | 0.97              | 1.03               | 1.18               | 1.24               | 1.37                |
| 5.00         | 0.82                | 0.85                | 0.94              | 1.00               | 1.15               | 1.20               | 1.33                |
| 5.25         | 0.80                | 0.82                | 0.91              | 0.97               | 1.12               | 1.16               | 1.29                |
| 5.50         | 0.79                | 0.82                | 0.90              | 0.96               | 1.10               | 1.15               | 1.28                |

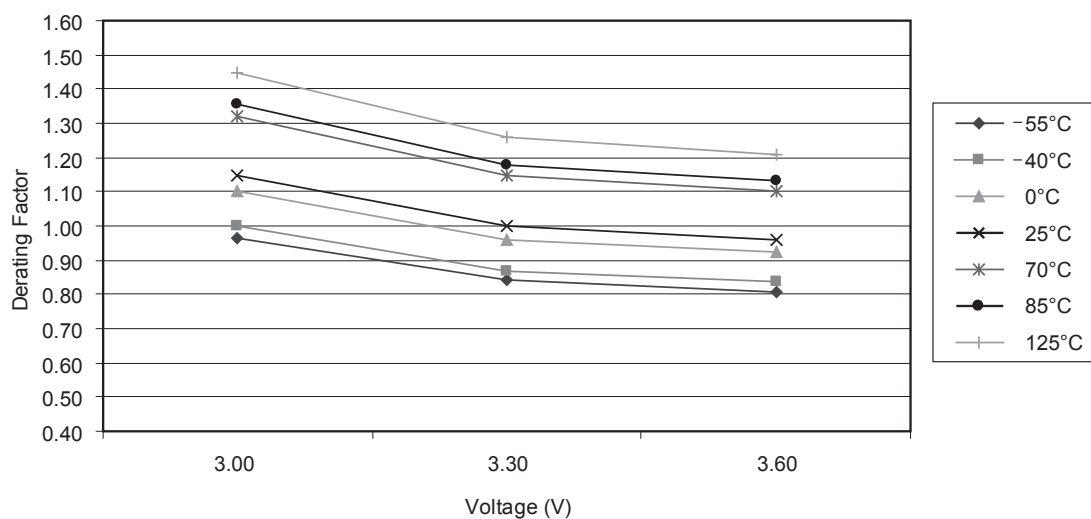


*Note:* This derating factor applies to all routing and propagation delays

**Figure 1-34 • 40MX Junction Temperature and Voltage Derating Curves**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V}$ )

**Table 1-24 • 42MX Temperature and Voltage Derating Factors**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CCA} = 3.3\text{ V}$ )

| 42MX Voltage | Temperature         |                     |                   |                    |                    |                    |                     |
|--------------|---------------------|---------------------|-------------------|--------------------|--------------------|--------------------|---------------------|
|              | $-55^\circ\text{C}$ | $-40^\circ\text{C}$ | $0^\circ\text{C}$ | $25^\circ\text{C}$ | $70^\circ\text{C}$ | $85^\circ\text{C}$ | $125^\circ\text{C}$ |
| 3.00         | 0.97                | 1.00                | 1.10              | 1.15               | 1.32               | 1.36               | 1.45                |
| 3.30         | 0.84                | 0.87                | 0.96              | 1.00               | 1.15               | 1.18               | 1.26                |
| 3.60         | 0.81                | 0.84                | 0.92              | 0.96               | 1.10               | 1.13               | 1.21                |

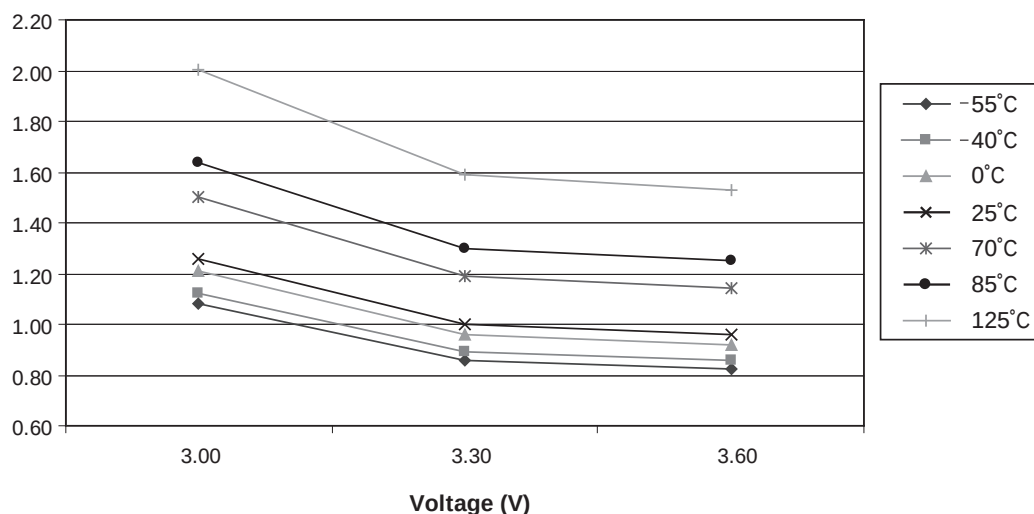


*Note:* This derating factor applies to all routing and propagation delays.

**Figure 1-35 • 42MX Junction Temperature and Voltage Derating Curves**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CCA} = 3.3\text{ V}$ )

**Table 1-25 • 40MX Temperature and Voltage Derating Factors**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CC} = 3.3\text{ V}$ )

| 40MX Voltage | Temperature         |                     |                   |                    |                    |                    |                     |
|--------------|---------------------|---------------------|-------------------|--------------------|--------------------|--------------------|---------------------|
|              | $-55^\circ\text{C}$ | $-40^\circ\text{C}$ | $0^\circ\text{C}$ | $25^\circ\text{C}$ | $70^\circ\text{C}$ | $85^\circ\text{C}$ | $125^\circ\text{C}$ |
| 3.00         | 1.08                | 1.12                | 1.21              | 1.26               | 1.50               | 1.64               | 2.00                |
| 3.30         | 0.86                | 0.89                | 0.96              | 1.00               | 1.19               | 1.30               | 1.59                |
| 3.60         | 0.83                | 0.85                | 0.92              | 0.96               | 1.14               | 1.25               | 1.53                |



*Note:* This derating factor applies to all routing and propagation delays.

**Figure 1-36 • 40MX Junction Temperature and Voltage Derating Curves**  
(Normalized to  $T_J = 25^\circ\text{C}$ ,  $V_{CC} = 3.3\text{ V}$ )

## PCI System Timing Specification

Table 1-26 and Table 1-27 list the critical PCI timing parameters and the corresponding timing parameters for the MX PCI-compliant devices.

### PCI Models

Microsemi provides synthesizable VHDL and Verilog-HDL models for a PCI Target interface, a PCI Target and Target+DMA Master interface. Contact your Microsemi sales representative for more details.

**Table 1-26 • Clock Specification for 33 MHz PCI**

| Symbol            | Parameter      | PCI  |      | A42MX24 |      | A42MX36 |      | Units |
|-------------------|----------------|------|------|---------|------|---------|------|-------|
|                   |                | Min. | Max. | Min.    | Max. | Min.    | Max. |       |
| t <sub>CYC</sub>  | CLK Cycle Time | 30   | –    | 4.0     | –    | 4.0     | –    | ns    |
| t <sub>HIGH</sub> | CLK High Time  | 11   | –    | 1.9     | –    | 1.9     | –    | ns    |
| t <sub>LOW</sub>  | CLK Low Time   | 11   | –    | 1.9     | –    | 1.9     | –    | ns    |

**Table 1-27 • Timing Parameters for 33 MHz PCI**

| Symbol                | Parameter                               | PCI                 |      | A42MX24 |                  | A42MX36 |                  | Units |
|-----------------------|-----------------------------------------|---------------------|------|---------|------------------|---------|------------------|-------|
|                       |                                         | Min.                | Max. | Min.    | Max.             | Min.    | Max.             |       |
| t <sub>VAL</sub>      | CLK to Signal Valid—Bused Signals       | 2                   | 11   | 2.0     | 9.0              | 2.0     | 9.0              | ns    |
| t <sub>VAL(PTP)</sub> | CLK to Signal Valid—Point-to-Point      | 2 <sup>2</sup>      | 12   | 2.0     | 9.0              | 2.0     | 9.0              | ns    |
| t <sub>ON</sub>       | Float to Active                         | 2                   | –    | 2.0     | 4.0              | 2.0     | 4.0              | ns    |
| t <sub>OFF</sub>      | Active to Float                         | –                   | 28   | –       | 8.3 <sup>1</sup> | –       | 8.3 <sup>1</sup> | ns    |
| t <sub>SU</sub>       | Input Set-Up Time to CLK—Bused Signals  | 7                   | –    | 1.5     | –                | 1.5     | –                | ns    |
| t <sub>SU(PTP)</sub>  | Input Set-Up Time to CLK—Point-to-Point | 10, 12 <sup>2</sup> | –    | 1.5     | –                | 1.5     | –                | ns    |
| t <sub>H</sub>        | Input Hold to CLK                       | 0                   | –    | 0       | –                | 0       | –                | ns    |

**Notes:**

1. T<sub>OFF</sub> is system dependent. MX PCI devices have 7.4 ns turn-off time, reflection is typically an additional 10 ns.
2. REQ# and GNT# are point-to-point signals and have different output valid delay and input setup times than do bused signals. GNT# has a setup of 10; REW# has a setup of 12.

## Timing Characteristics

**Table 1-28 • A40MX02 Timing Characteristics (Nominal 5.0 V Operation)**  
(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                              | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                              | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays                    |                                              |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                |          | 1.2  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.7  | ns    |
| t <sub>PD2</sub>                                   | Dual-Module Macros                           |          | 2.7  |          | 3.1  |          | 3.5  |           | 4.1  |          | 5.7  | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                        |          | 1.2  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.7  | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                 |          | 1.2  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.7  | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                 |          | 1.2  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.7  | ns    |
| Logic Module Predicted Routing Delays <sup>1</sup> |                                              |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                         |          | 1.3  |          | 1.5  |          | 1.7  |           | 2.0  |          | 2.8  | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                         |          | 1.8  |          | 2.1  |          | 2.4  |           | 2.8  |          | 3.9  | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                         |          | 2.3  |          | 2.7  |          | 3.0  |           | 3.6  |          | 5.0  | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                         |          | 2.9  |          | 3.3  |          | 3.7  |           | 4.4  |          | 6.1  | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                         |          | 4.9  |          | 5.7  |          | 6.5  |           | 7.6  |          | 10.6 | ns    |
| Logic Module Sequential Timing <sup>2</sup>        |                                              |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Data Input Set-Up          | 3.1      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>HD</sub> <sup>3</sup>                       | Flip-Flop (Latch) Data Input Hold            | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up              | 3.1      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch) Clock Active Pulse Width   | 3.3      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch) Asynchronous Pulse Width   | 3.3      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                 | 4.8      |      | 5.6      |      | 6.3      |      | 7.5       |      | 10.4     |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency (FO = 128) |          | 181  |          | 168  |          | 154  |           | 134  |          | 80   | MHz   |
| Input Module Propagation Delays                    |                                              |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH                                |          | 0.7  |          | 0.8  |          | 0.9  |           | 1.1  |          | 1.5  | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                                 |          | 0.6  |          | 0.7  |          | 0.8  |           | 1.0  |          | 1.3  | ns    |

### Notes:

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35pF loading.

**Table 1-28 • A40MX02 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                          |                     | –3 Speed   |            | –2 Speed   |            | –1 Speed    |            | Std Speed  |            | –F Speed     |              | Units |
|----------------------------------------------------|--------------------------|---------------------|------------|------------|------------|------------|-------------|------------|------------|------------|--------------|--------------|-------|
|                                                    |                          |                     | Min.       | Max.       | Min.       | Max.       | Min.        | Max.       | Min.       | Max.       | Min.         | Max.         |       |
| Input Module Predicted Routing Delays <sup>1</sup> |                          |                     |            |            |            |            |             |            |            |            |              |              |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay     |                     | 2.1        |            | 2.4        |            | 2.2         |            | 3.2        |            | 4.5          | ns           |       |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay     |                     | 2.6        |            | 3.0        |            | 3.4         |            | 4.0        |            | 5.6          | ns           |       |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay     |                     | 3.1        |            | 3.6        |            | 4.1         |            | 4.8        |            | 6.7          | ns           |       |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay     |                     | 3.6        |            | 4.2        |            | 4.8         |            | 5.6        |            | 7.8          | ns           |       |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay     |                     | 5.7        |            | 6.6        |            | 7.5         |            | 8.8        |            | 12.4         | ns           |       |
| Global Clock Network                               |                          |                     |            |            |            |            |             |            |            |            |              |              |       |
| t <sub>CKH</sub>                                   | Input Low to HIGH        | FO = 16<br>FO = 128 |            | 4.6<br>4.6 |            | 5.3<br>5.3 |             | 6.0<br>6.0 |            | 7.0<br>7.0 |              | 9.8<br>9.8   | ns    |
| t <sub>CKL</sub>                                   | Input High to LOW        | FO = 16<br>FO = 128 |            | 4.8<br>4.8 |            | 5.6<br>5.6 |             | 6.3<br>6.3 |            | 7.4<br>7.4 |              | 10.4<br>10.4 | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH | FO = 16<br>FO = 128 | 2.2<br>2.4 |            | 2.6<br>2.7 |            | 2.9<br>3.1  |            | 3.4<br>3.6 |            | 4.8<br>5.1   |              | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW  | FO = 16<br>FO = 128 | 2.2<br>2.4 |            | 2.6<br>2.7 |            | 2.9<br>3.01 |            | 3.4<br>3.6 |            | 4.8<br>5.1   |              | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew             | FO = 16<br>FO = 128 |            | 0.4<br>0.5 |            | 0.5<br>0.6 |             | 0.5<br>0.7 |            | 0.6<br>0.8 |              | 0.8<br>1.2   | ns    |
| t <sub>P</sub>                                     | Minimum Period           | FO = 16<br>FO = 128 | 4.7<br>4.8 |            | 5.4<br>5.6 |            | 6.1<br>6.3  |            | 7.2<br>7.5 |            | 10.0<br>10.4 |              | ns    |
| f <sub>MAX</sub>                                   | Maximum Frequency        | FO = 16<br>FO = 128 |            | 188<br>181 |            | 175<br>168 |             | 160<br>154 |            | 139<br>134 |              | 83<br>80     | MHz   |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35pF loading.

**Table 1-28 • A40MX02 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                      |  | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------|--|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                      |  | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing <sup>4</sup>  |                      |  |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |  |          | 3.3  |          | 3.8  |          | 4.3  |           | 5.1  |          | 7.2  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |  |          | 4.0  |          | 4.6  |          | 5.2  |           | 6.1  |          | 8.6  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |  |          | 3.7  |          | 4.3  |          | 4.9  |           | 5.8  |          | 8.0  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |  |          | 4.7  |          | 5.4  |          | 6.1  |           | 7.2  |          | 10.1 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |  |          | 7.9  |          | 9.1  |          | 10.4 |           | 12.2 |          | 17.1 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |  |          | 5.9  |          | 6.8  |          | 7.7  |           | 9.0  |          | 12.6 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |  |          | 0.02 |          | 0.02 |          | 0.03 |           | 0.03 |          | 0.04 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |  |          | 0.03 |          | 0.03 |          | 0.03 |           | 0.04 |          | 0.06 | ns/pF |
| CMOS Output Module Timing <sup>4</sup> |                      |  |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |  |          | 3.9  |          | 4.5  |          | 5.1  |           | 6.05 |          | 8.5  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |  |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |  |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |  |          | 4.9  |          | 5.6  |          | 6.4  |           | 7.5  |          | 10.5 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |  |          | 7.9  |          | 9.1  |          | 10.4 |           | 12.2 |          | 17.0 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |  |          | 5.9  |          | 6.8  |          | 7.7  |           | 9.0  |          | 12.6 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |  |          | 0.03 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |  |          | 0.02 |          | 0.02 |          | 0.03 |           | 0.03 |          | 0.04 | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35pF loading.

**Table 1-29 • A40MX02 Timing Characteristics (Nominal 3.3 V Operation)**  
**(Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                                 | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                                 | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays                    |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                   |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>PD2</sub>                                   | Dual-Module Macros                              |          | 3.7  |          | 4.3  |          | 4.9  |           | 5.7  |          | 8.0  | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                           |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                    |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                    |          | 1.7  |          | 2.0  |          | 2.3  |           | 2.7  |          | 3.7  | ns    |
| Logic Module Predicted Routing Delays <sup>1</sup> |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                            |          | 2.0  |          | 2.2  |          | 2.5  |           | 3.0  |          | 4.2  | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                            |          | 2.7  |          | 3.1  |          | 3.5  |           | 4.1  |          | 5.7  | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                            |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                            |          | 4.2  |          | 4.8  |          | 5.4  |           | 6.3  |          | 8.9  | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                            |          | 7.1  |          | 8.2  |          | 9.2  |           | 10.9 |          | 15.2 | ns    |
| Logic Module Sequential Timing <sup>2</sup>        |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch)<br>Data Input Set-Up          | 4.3      |      | 4.9      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>HD</sub> <sup>3</sup>                       | Flip-Flop (Latch)<br>Data Input Hold            | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up                 | 4.3      |      | 4.9      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width   | 4.6      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width   | 4.6      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                    | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock<br>Frequency (FO = 128) |          | 109  |          | 101  |          | 92   |           | 80   |          | 48   | MHz   |
| Input Module Propagation Delays                    |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH                                   |          | 1.0  |          | 1.1  |          | 1.3  |           | 1.5  |          | 2.1  | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                                    |          | 0.9  |          | 1.0  |          | 1.1  |           | 1.3  |          | 1.9  | ns    |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-29 • A40MX02 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                          |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|--------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                          |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays <sup>1</sup> |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay     |          | 2.9      |      | 3.4      |      | 3.8      |      | 4.5       |      | 6.3      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay     |          | 3.6      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay     |          | 4.4      |      | 5.0      |      | 5.7      |      | 6.7       |      | 9.4      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay     |          | 5.1      |      | 5.9      |      | 6.7      |      | 7.8       |      | 11.0     |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay     |          | 8.0      |      | 9.26     |      | 10.5     |      | 12.6      |      | 17.3     |      | ns    |
| Global Clock Network                               |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH        | FO = 16  | 6.4      |      | 7.4      |      | 8.3      |      | 9.8       |      | 13.7     |      | ns    |
|                                                    |                          | FO = 128 | 6.4      |      | 7.4      |      | 8.3      |      | 9.8       |      | 13.7     |      |       |
| t <sub>CKL</sub>                                   | Input HIGH to LOW        | FO = 16  | 6.7      |      | 7.8      |      | 8.8      |      | 10.4      |      | 14.5     |      | ns    |
|                                                    |                          | FO = 128 | 6.7      |      | 7.8      |      | 8.8      |      | 10.4      |      | 14.5     |      |       |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH | FO = 16  | 3.1      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
|                                                    |                          | FO = 128 | 3.3      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      |       |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW  | FO = 16  | 3.1      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
|                                                    |                          | FO = 128 | 3.3      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      |       |
| t <sub>CKSW</sub>                                  | Maximum Skew             | FO = 16  | 0.6      |      | 0.6      |      | 0.7      |      | 0.8       |      | 1.2      |      | ns    |
|                                                    |                          | FO = 128 | 0.8      |      | 0.9      |      | 1.0      |      | 1.2       |      | 1.6      |      |       |
| t <sub>P</sub>                                     | Minimum Period           | FO = 16  | 6.5      |      | 7.5      |      | 8.5      |      | 10.1      |      | 14.1     |      | ns    |
|                                                    |                          | FO = 128 | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      |       |
| f <sub>MAX</sub>                                   | Maximum Frequency        | FO = 16  | 113      |      | 105      |      | 96       |      | 83        |      | 50       |      | MHz   |
|                                                    |                          | FO = 128 | 109      |      | 101      |      | 92       |      | 80        |      | 48       |      |       |
| TTL Output Module Timing <sup>4</sup>              |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                                   | Data-to-Pad HIGH         |          | 4.7      |      | 5.4      |      | 6.1      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>DHL</sub>                                   | Data-to-Pad LOW          |          | 5.6      |      | 6.4      |      | 7.3      |      | 8.6       |      | 12.0     |      | ns    |
| t <sub>ENZH</sub>                                  | Enable Pad Z to HIGH     |          | 5.2      |      | 6.0      |      | 6.8      |      | 8.1       |      | 11.3     |      | ns    |
| t <sub>ENZL</sub>                                  | Enable Pad Z to LOW      |          | 6.6      |      | 7.6      |      | 8.6      |      | 10.1      |      | 14.1     |      | ns    |
| t <sub>ENHZ</sub>                                  | Enable Pad HIGH to Z     |          | 11.1     |      | 12.8     |      | 14.5     |      | 17.1      |      | 23.9     |      | ns    |
| t <sub>ENLZ</sub>                                  | Enable Pad LOW to Z      |          | 8.2      |      | 9.5      |      | 10.7     |      | 12.6      |      | 17.7     |      | ns    |
| d <sub>TLH</sub>                                   | Delta LOW to HIGH        |          | 0.03     |      | 0.03     |      | 0.04     |      | 0.04      |      | 0.06     |      | ns/pF |
| d <sub>THL</sub>                                   | Delta HIGH to LOW        |          | 0.04     |      | 0.04     |      | 0.05     |      | 0.06      |      | 0.08     |      | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-29 • A40MX02 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                      | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                      | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>4</sup> |                      |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |          | 5.5  |          | 6.4  |          | 7.2  |           | 8.5  |          | 11.9 | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |          | 4.8  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |          | 4.7  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |          | 6.8  |          | 7.9  |          | 8.9  |           | 10.5 |          | 14.7 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |          | 11.1 |          | 12.8 |          | 14.5 |           | 17.1 |          | 23.9 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |          | 8.2  |          | 9.5  |          | 10.7 |           | 12.6 |          | 17.7 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |          | 0.05 |          | 0.05 |          | 0.06 |           | 0.07 |          | 0.10 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |          | 0.03 |          | 0.03 |          | 0.04 |           | 0.04 |          | 0.06 | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-30 • A40MX04 Timing Characteristics (Nominal 5.0 V Operation)**  
**(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                                    | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|----------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                                    | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays                    |                                                    |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                      | 1.2      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>PD2</sub>                                   | Dual-Module Macros                                 | 2.3      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                              | 1.2      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                       | 1.2      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                       | 1.2      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| Logic Module Predicted Routing Delays <sup>1</sup> |                                                    |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                               | 1.2      |      | 1.6      |      | 1.8      |      | 2.1       |      | 3.0      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                               | 1.9      |      | 2.2      |      | 2.5      |      | 2.9       |      | 4.1      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                               | 2.4      |      | 2.8      |      | 3.2      |      | 3.7       |      | 5.2      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                               | 2.9      |      | 3.4      |      | 3.9      |      | 4.5       |      | 6.3      |      | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                               | 5.0      |      | 5.8      |      | 6.6      |      | 7.8       |      | 10.9     |      | ns    |
| Logic Module Sequential Timing <sup>2</sup>        |                                                    |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch)<br>Data Input Set-Up             | 3.1      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>HD</sub> <sup>3</sup>                       | Flip-Flop (Latch)<br>Data Input Hold               | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch)<br>Enable Set-Up                 | 3.1      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch)<br>Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width      | 3.3      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width      | 3.3      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                       | 4.8      |      | 5.6      |      | 6.3      |      | 7.5       |      | 10.4     |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch)<br>Clock Frequency<br>(FO = 128) | 181      |      | 167      |      | 154      |      | 134       |      | 80       |      | MHz   |
| Input Module Propagation Delays                    |                                                    |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH                                      | 0.7      |      | 0.8      |      | 0.9      |      | 1.1       |      | 1.5      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                                       | 0.6      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.3      |      | ns    |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer utility from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-30 • A40MX04 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                          |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|--------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                          |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays <sup>1</sup> |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay     |          | 2.1      |      | 2.4      |      | 2.2      |      | 3.2       |      | 4.5      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay     |          | 2.6      |      | 3.0      |      | 3.4      |      | 4.0       |      | 5.6      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay     |          | 3.1      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay     |          | 3.6      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay     |          | 5.7      |      | 6.6      |      | 7.5      |      | 8.8       |      | 12.4     |      | ns    |
| Global Clock Network                               |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input Low to HIGH        | FO = 16  | 4.6      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
|                                                    |                          | FO = 128 | 4.6      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      |       |
| t <sub>CKL</sub>                                   | Input High to LOW        | FO = 16  | 4.8      |      | 5.6      |      | 6.3      |      | 7.4       |      | 10.4     |      | ns    |
|                                                    |                          | FO = 128 | 4.8      |      | 5.6      |      | 6.3      |      | 7.4       |      | 10.4     |      |       |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH | FO = 16  | 2.2      |      | 2.6      |      | 2.9      |      | 3.4       |      | 4.8      |      | ns    |
|                                                    |                          | FO = 128 | 2.4      |      | 2.7      |      | 3.1      |      | 3.6       |      | 5.1      |      |       |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW  | FO = 16  | 2.2      |      | 2.6      |      | 2.9      |      | 3.4       |      | 4.8      |      | ns    |
|                                                    |                          | FO = 128 | 2.4      |      | 2.7      |      | 3.01     |      | 3.6       |      | 5.1      |      |       |
| t <sub>CKSW</sub>                                  | Maximum Skew             | FO = 16  | 0.4      |      | 0.5      |      | 0.5      |      | 0.6       |      | 0.8      |      | ns    |
|                                                    |                          | FO = 128 | 0.5      |      | 0.6      |      | 0.7      |      | 0.8       |      | 1.2      |      |       |
| t <sub>P</sub>                                     | Minimum Period           | FO = 16  | 4.7      |      | 5.4      |      | 6.1      |      | 7.2       |      | 10.0     |      | ns    |
|                                                    |                          | FO = 128 | 4.8      |      | 5.6      |      | 6.3      |      | 7.5       |      | 10.4     |      |       |
| f <sub>MAX</sub>                                   | Maximum Frequency        | FO = 16  | 188      |      | 175      |      | 160      |      | 139       |      | 83       |      | MHz   |
|                                                    |                          | FO = 128 | 181      |      | 168      |      | 154      |      | 134       |      | 80       |      |       |
| TTL Output Module Timing <sup>4</sup>              |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                                   | Data-to-Pad HIGH         |          | 3.3      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.2      |      | ns    |
| t <sub>DHL</sub>                                   | Data-to-Pad LOW          |          | 4.0      |      | 4.6      |      | 5.2      |      | 6.1       |      | 8.6      |      | ns    |
| t <sub>ENZH</sub>                                  | Enable Pad Z to HIGH     |          | 3.7      |      | 4.3      |      | 4.9      |      | 5.8       |      | 8.0      |      | ns    |
| t <sub>ENZL</sub>                                  | Enable Pad Z to LOW      |          | 4.7      |      | 5.4      |      | 6.1      |      | 7.2       |      | 10.1     |      | ns    |
| t <sub>ENHZ</sub>                                  | Enable Pad HIGH to Z     |          | 7.9      |      | 9.1      |      | 10.4     |      | 12.2      |      | 17.1     |      | ns    |
| t <sub>ENLZ</sub>                                  | Enable Pad LOW to Z      |          | 5.9      |      | 6.8      |      | 7.7      |      | 9.0       |      | 12.6     |      | ns    |
| d <sub>TLH</sub>                                   | Delta LOW to HIGH        |          | 0.02     |      | 0.02     |      | 0.03     |      | 0.03      |      | 0.04     |      | ns/pF |
| d <sub>THL</sub>                                   | Delta HIGH to LOW        |          | 0.03     |      | 0.03     |      | 0.03     |      | 0.04      |      | 0.06     |      | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer utility from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-30 • A40MX04 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCC = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                      | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                      | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>1</sup> |                      |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |          | 3.9  |          | 4.5  |          | 5.1  |           | 6.05 |          | 8.5  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |          | 3.4  |          | 3.9  |          | 4.4  |           | 5.2  |          | 7.3  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |          | 4.9  |          | 5.6  |          | 6.4  |           | 7.5  |          | 10.5 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |          | 7.9  |          | 9.1  |          | 10.4 |           | 12.2 |          | 17.0 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |          | 5.9  |          | 6.8  |          | 7.7  |           | 9.0  |          | 12.6 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |          | 0.03 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |          | 0.02 |          | 0.02 |          | 0.03 |           | 0.03 |          | 0.04 | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer utility from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-31 • A40MX04 Timing Characteristics (Nominal 3.3 V Operation)**  
 (Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                                 | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                                 | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays                    |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                   | 1.7      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>PD2</sub>                                   | Dual-Module Macros                              | 3.7      |      | 4.3      |      | 4.9      |      | 5.7       |      | 8.0      |      | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                           | 1.7      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                    | 1.7      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                    | 1.7      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| Logic Module Predicted Routing Delays <sup>1</sup> |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                            | 1.9      |      | 2.2      |      | 2.5      |      | 3.0       |      | 4.2      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                            | 2.7      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                            | 3.4      |      | 3.9      |      | 4.4      |      | 5.2       |      | 7.3      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                            | 4.1      |      | 4.8      |      | 5.4      |      | 6.3       |      | 8.9      |      | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                            | 7.1      |      | 8.1      |      | 9.2      |      | 10.9      |      | 15.2     |      | ns    |
| Logic Module Sequential Timing <sup>2</sup>        |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch)<br>Data Input Set-Up          | 4.3      |      | 5.0      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>HD</sub> <sup>3</sup>                       | Flip-Flop (Latch) Data Input Hold               | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up                 | 4.3      |      | 5.0      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width   | 4.6      |      | 5.3      |      | 5.6      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width   | 4.6      |      | 5.3      |      | 5.6      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                    | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency<br>(FO = 128) | 109      |      | 101      |      | 92       |      | 80        |      | 48       |      | MHz   |
| Input Module Propagation Delays                    |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH                                   | 1.0      |      | 1.1      |      | 1.3      |      | 1.5       |      | 2.1      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                                    | 0.9      |      | 1.0      |      | 1.1      |      | 1.3       |      | 1.9      |      | ns    |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-31 • A40MX04 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                          |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|--------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                          |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays <sup>1</sup> |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay     |          | 2.9      |      | 3.3      |      | 3.8      |      | 4.5       |      | 6.3      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay     |          | 3.6      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay     |          | 4.4      |      | 5.0      |      | 5.7      |      | 6.7       |      | 9.4      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay     |          | 5.1      |      | 5.9      |      | 6.7      |      | 7.8       |      | 11.0     |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay     |          | 8.0      |      | 9.3      |      | 10.5     |      | 12.4      |      | 17.2     |      | ns    |
| Global Clock Network                               |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH        | FO = 16  | 6.4      |      | 7.4      |      | 8.4      |      | 9.9       |      | 13.8     |      | ns    |
|                                                    |                          | FO = 128 | 6.4      |      | 7.4      |      | 8.4      |      | 9.9       |      | 13.8     |      |       |
| t <sub>CKL</sub>                                   | Input HIGH to LOW        | FO = 16  | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      | ns    |
|                                                    |                          | FO = 128 | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      |       |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH | FO = 16  | 3.1      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
|                                                    |                          | FO = 128 | 3.3      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      |       |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW  | FO = 16  | 3.1      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
|                                                    |                          | FO = 128 | 3.3      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      |       |
| t <sub>CKSW</sub>                                  | Maximum Skew             | FO = 16  | 0.6      |      | 0.6      |      | 0.7      |      | 0.8       |      | 1.2      |      | ns    |
|                                                    |                          | FO = 128 | 0.8      |      | 0.9      |      | 1.0      |      | 1.2       |      | 1.6      |      |       |
| t <sub>P</sub>                                     | Minimum Period           | FO = 16  | 6.5      |      | 7.5      |      | 8.5      |      | 10.1      |      | 14.1     |      | ns    |
|                                                    |                          | FO = 128 | 6.8      |      | 7.8      |      | 8.9      |      | 10.4      |      | 14.6     |      |       |
| f <sub>MAX</sub>                                   | Maximum Frequency        | FO = 16  | 113      |      | 105      |      | 96       |      | 83        |      | 50       |      | MHz   |
|                                                    |                          | FO = 128 | 109      |      | 101      |      | 92       |      | 80        |      | 48       |      |       |
| TTL Output Module Timing <sup>4</sup>              |                          |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                                   | Data-to-Pad HIGH         |          | 4.7      |      | 5.4      |      | 6.1      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>DHL</sub>                                   | Data-to-Pad LOW          |          | 5.6      |      | 6.4      |      | 7.3      |      | 8.6       |      | 12.0     |      | ns    |
| t <sub>ENZH</sub>                                  | Enable Pad Z to HIGH     |          | 5.2      |      | 6.0      |      | 6.9      |      | 8.1       |      | 11.3     |      | ns    |
| t <sub>ENZL</sub>                                  | Enable Pad Z to LOW      |          | 6.6      |      | 7.6      |      | 8.6      |      | 10.1      |      | 14.1     |      | ns    |
| t <sub>ENHZ</sub>                                  | Enable Pad HIGH to Z     |          | 11.1     |      | 12.8     |      | 14.5     |      | 17.1      |      | 23.9     |      | ns    |
| t <sub>ENLZ</sub>                                  | Enable Pad LOW to Z      |          | 8.2      |      | 9.5      |      | 10.7     |      | 12.6      |      | 17.7     |      | ns    |
| d <sub>TLH</sub>                                   | Delta LOW to HIGH        |          | 0.03     |      | 0.03     |      | 0.04     |      | 0.04      |      | 0.06     |      | ns/pF |
| d <sub>THL</sub>                                   | Delta HIGH to LOW        |          | 0.04     |      | 0.04     |      | 0.05     |      | 0.06      |      | 0.08     |      | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-31 • A40MX04 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCC = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                      | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                      | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>4</sup> |                      |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH     |          | 5.5  |          | 6.4  |          | 7.2  |           | 8.5  |          | 11.9 | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW      |          | 4.8  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH |          | 4.7  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW  |          | 6.8  |          | 7.9  |          | 8.9  |           | 10.5 |          | 14.7 | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z |          | 11.1 |          | 12.8 |          | 14.5 |           | 17.1 |          | 23.9 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z  |          | 8.2  |          | 9.5  |          | 10.7 |           | 12.6 |          | 17.7 | ns    |
| d <sub>TLH</sub>                       | Delta LOW to HIGH    |          | 0.05 |          | 0.05 |          | 0.06 |           | 0.07 |          | 0.10 | ns/pF |
| d <sub>THL</sub>                       | Delta HIGH to LOW    |          | 0.03 |          | 0.03 |          | 0.04 |           | 0.04 |          | 0.06 | ns/pF |

**Notes:**

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility.
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35 pF loading.

**Table 1-32 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation)**  
**(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                            | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|--------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                            | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays <sup>1</sup>       |                                            |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                              | 1.2      |      | 1.3      |      | 1.5      |      | 1.8       |      | 2.5      |      | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                      | 1.3      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                               | 1.2      |      | 1.4      |      | 1.6      |      | 1.8       |      | 2.6      |      | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q               | 1.2      |      | 1.6      |      | 1.8      |      | 2.1       |      | 2.9      |      | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                            |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                       | 0.7      |      | 0.8      |      | 0.9      |      | 1.0       |      | 1.4      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                       | 0.9      |      | 1.0      |      | 1.2      |      | 1.4       |      | 1.9      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                       | 1.2      |      | 1.3      |      | 1.5      |      | 1.7       |      | 2.4      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                       | 1.4      |      | 1.5      |      | 1.7      |      | 2.0       |      | 2.9      |      | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                       | 2.3      |      | 2.6      |      | 2.9      |      | 3.4       |      | 4.8      |      | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                            |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Data Input Set-Up        | 0.3      |      | 0.4      |      | 0.4      |      | 0.5       |      | 0.7      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Data Input Hold          | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up            | 0.4      |      | 0.5      |      | 0.5      |      | 0.6       |      | 0.8      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold              | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch) Clock Active Pulse Width | 3.4      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch) Asynchronous Pulse Width | 4.5      |      | 4.9      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period               | 3.5      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      | ns    |
| t <sub>INH</sub>                                   | Input Buffer Latch Hold                    | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                                  | Input Buffer Latch Set-Up                  | 0.3      |      | 0.3      |      | 0.4      |      | 0.4       |      | 0.6      |      | ns    |
| t <sub>OUTH</sub>                                  | Output Buffer Latch Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>OUTSU</sub>                                 | Output Buffer Latch Set-Up                 | 0.3      |      | 0.3      |      | 0.4      |      | 0.4       |      | 0.6      |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency          | 268      |      | 244      |      | 224      |      | 195       |      | 117      |      | MHz   |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-32 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                             |          | −3 Speed |      | −2 Speed |      | −1 Speed |      | Std Speed |      | −F Speed |      | Units |
|----------------------------------------------------|-----------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                             |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Propagation Delays                    |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH               |          | 1.0      |      | 1.2      |      | 1.3      |      | 1.6       |      | 2.2      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                |          | 0.8      |      | 0.9      |      | 1.0      |      | 1.2       |      | 1.7      |      | ns    |
| t <sub>INGH</sub>                                  | G to Y HIGH                 |          | 1.3      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>INGL</sub>                                  | G to Y LOW                  |          | 1.3      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| Input Module Predicted Routing Delays <sup>2</sup> |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay        |          | 2.0      |      | 2.2      |      | 2.5      |      | 3.0       |      | 4.2      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay        |          | 2.3      |      | 2.5      |      | 2.9      |      | 3.4       |      | 4.7      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay        |          | 2.5      |      | 2.8      |      | 3.2      |      | 3.7       |      | 5.2      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay        |          | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay        |          | 3.7      |      | 4.1      |      | 4.7      |      | 5.5       |      | 7.7      |      | ns    |
| Global Clock Network                               |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH           | FO = 32  | 2.4      |      | 2.7      |      | 3.0      |      | 3.6       |      | 5.0      |      | ns    |
|                                                    |                             | FO = 256 | 2.7      |      | 3.0      |      | 3.4      |      | 4.0       |      | 5.5      |      | ns    |
| t <sub>CKL</sub>                                   | Input HIGH to LOW           | FO = 32  | 3.5      |      | 3.9      |      | 4.4      |      | 5.2       |      | 7.3      |      | ns    |
|                                                    |                             | FO = 256 | 3.9      |      | 4.3      |      | 4.9      |      | 5.7       |      | 8.0      |      | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH    | FO = 32  | 1.2      |      | 1.4      |      | 1.5      |      | 1.8       |      | 2.5      |      | ns    |
|                                                    |                             | FO = 256 | 1.3      |      | 1.5      |      | 1.7      |      | 2.0       |      | 2.7      |      | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW     | FO = 32  | 1.2      |      | 1.4      |      | 1.5      |      | 1.8       |      | 2.5      |      | ns    |
|                                                    |                             | FO = 256 | 1.3      |      | 1.5      |      | 1.7      |      | 2.0       |      | 2.7      |      | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew                | FO = 32  | 0.3      |      | 0.3      |      | 0.4      |      | 0.5       |      | 0.6      |      | ns    |
|                                                    |                             | FO = 256 | 0.3      |      | 0.3      |      | 0.4      |      | 0.5       |      | 0.6      |      | ns    |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                                                    |                             | FO = 256 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>                                  | Input Latch External Hold   | FO = 32  | 2.3      |      | 2.6      |      | 3.0      |      | 3.5       |      | 4.9      |      | ns    |
|                                                    |                             | FO = 256 | 2.2      |      | 2.4      |      | 3.3      |      | 3.9       |      | 5.5      |      | ns    |
| t <sub>p</sub>                                     | Minimum Period              | FO = 32  | 3.4      |      | 3.7      |      | 4.0      |      | 4.7       |      | 7.8      |      | ns    |
|                                                    |                             | FO = 256 | 3.7      |      | 4.1      |      | 4.5      |      | 5.2       |      | 8.6      |      | ns    |
| f <sub>MAX</sub>                                   | Maximum Frequency           | FO = 32  | 296      |      | 269      |      | 247      |      | 215       |      | 129      |      | MHz   |
|                                                    |                             | FO = 256 | 268      |      | 244      |      | 224      |      | 195       |      | 117      |      | MHz   |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-32 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description               |                                                          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|---------------------------------------|----------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                       |                                                          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing <sup>5</sup> |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                                         |          | 2.5  |          | 2.7  |          | 3.1  |           | 3.6  |          | 5.1  | ns    |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                                          |          | 2.9  |          | 3.2  |          | 3.6  |           | 4.3  |          | 6.0  | ns    |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                                     |          | 2.6  |          | 2.9  |          | 3.3  |           | 3.9  |          | 5.5  | ns    |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                                      |          | 2.9  |          | 3.2  |          | 3.7  |           | 4.3  |          | 6.1  | ns    |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                                     |          | 4.9  |          | 5.4  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENLZ</sub>                     | Enable Pad LOW to Z                                      |          | 5.3  |          | 5.9  |          | 6.7  |           | 7.9  |          | 11.1 | ns    |
| t <sub>GLH</sub>                      | G-to-Pad HIGH                                            |          | 2.6  |          | 2.9  |          | 3.3  |           | 3.8  |          | 5.3  | ns    |
| t <sub>GHL</sub>                      | G-to-Pad LOW                                             |          | 2.6  |          | 2.9  |          | 3.3  |           | 3.8  |          | 5.3  | ns    |
| t <sub>LSU</sub>                      | I/O Latch Set-Up                                         | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| t <sub>LH</sub>                       | I/O Latch Hold                                           | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>LCO</sub>                      | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading |          | 5.2  |          | 5.8  |          | 6.6  |           | 7.7  |          | 10.8 | ns    |
| t <sub>ACO</sub>                      | Array Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading     |          | 7.4  |          | 8.2  |          | 9.3  |           | 10.9 |          | 15.3 | ns    |
| d <sub>TLH</sub>                      | Capacity Loading, LOW to HIGH                            |          | 0.03 |          | 0.03 |          | 0.03 |           | 0.04 |          | 0.06 | ns/pF |
| d <sub>THL</sub>                      | Capacity Loading, HIGH to LOW                            |          | 0.04 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-32 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                                                          | -3 Speed |      | -2 Speed |      | -1 Speed |      | Std Speed |      | -F Speed |      | Units |
|----------------------------------------|----------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                                                          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>5</sup> |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                         |          | 2.4  |          | 2.7  |          | 3.1  |           | 3.6  |          | 5.1  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                          |          | 2.9  |          | 3.2  |          | 3.6  |           | 4.3  |          | 6.0  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                                     |          | 2.7  |          | 2.9  |          | 3.3  |           | 3.9  |          | 5.5  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                                      |          | 2.9  |          | 3.2  |          | 3.7  |           | 4.3  |          | 6.1  | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                                     |          | 4.9  |          | 5.4  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                                      |          | 5.3  |          | 5.9  |          | 6.7  |           | 7.9  |          | 11.1 | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                            |          | 4.2  |          | 4.6  |          | 5.2  |           | 6.1  |          | 8.6  | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                             |          | 4.2  |          | 4.6  |          | 5.2  |           | 6.1  |          | 8.6  | ns    |
| t <sub>LSU</sub>                       | I/O Latch Set-Up                                         | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| t <sub>LH</sub>                        | I/O Latch Hold                                           | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading |          | 5.2  |          | 5.8  |          | 6.6  |           | 7.7  |          | 10.8 | ns    |
| t <sub>ACO</sub>                       | Array Clock-to-Out (<br>Pad-to-Pad), 64 Clock Loading    |          | 7.4  |          | 8.2  |          | 9.3  |           | 10.9 |          | 15.3 | ns    |
| d <sub>TLH</sub>                       | Capacity Loading, LOW to HIGH                            |          | 0.03 |          | 0.03 |          | 0.03 |           | 0.04 |          | 0.06 | ns/pF |
| d <sub>THL</sub>                       | Capacity Loading, HIGH to LOW                            |          | 0.04 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-33 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation)**  
(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                               | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                               | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays <sup>1</sup>       |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                 | 1.6      |      | 1.8      |      | 2.1      |      | 2.5       |      | 3.5      |      | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                         | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.8      |      | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                  | 1.7      |      | 1.9      |      | 2.1      |      | 2.5       |      | 3.5      |      | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                  | 2.0      |      | 2.2      |      | 2.5      |      | 2.9       |      | 4.1      |      | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                          | 1.0      |      | 1.1      |      | 1.2      |      | 1.4       |      | 2.0      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                          | 1.3      |      | 1.4      |      | 1.6      |      | 1.9       |      | 2.7      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                          | 1.6      |      | 1.8      |      | 2.0      |      | 2.4       |      | 3.3      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                          | 1.9      |      | 2.1      |      | 2.4      |      | 2.9       |      | 4.0      |      | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                          | 3.2      |      | 3.6      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Data Input Set-Up           | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 0.9      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Data Input Hold             | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up               | 0.6      |      | 0.6      |      | 0.7      |      | 0.8       |      | 1.2      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width | 4.7      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width | 6.2      |      | 6.9      |      | 7.8      |      | 9.2       |      | 12.9     |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                  | 5.0      |      | 5.6      |      | 6.2      |      | 7.1       |      | 9.9      |      | ns    |
| t <sub>INH</sub>                                   | Input Buffer Latch Hold                       | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                                  | Input Buffer Latch Set-Up                     | 0.3      |      | 0.3      |      | 0.3      |      | 0.4       |      | 0.6      |      | ns    |
| t <sub>OUTH</sub>                                  | Output Buffer Latch Hold                      | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>OUTSU</sub>                                 | Output Buffer Latch Set-Up                    | 0.3      |      | 0.3      |      | 0.3      |      | 0.4       |      | 0.6      |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency             | 161      |      | 146      |      | 135      |      | 117       |      | 70       |      | MHz   |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-33 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                             |          |     | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------|----------|-----|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                             |          |     | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Propagation Delays                    |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH               |          |     | 1.5      |      | 1.6      |      | 1.8      |      | 2.17      |      | 3.0      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                |          |     | 1.2      |      | 1.3      |      | 1.4      |      | 1.7       |      | 2.4      |      | ns    |
| t <sub>INGH</sub>                                  | G to Y HIGH                 |          |     | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>INGL</sub>                                  | G to Y LOW                  |          |     | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| Input Module Predicted Routing Delays <sup>2</sup> |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay        |          |     | 2.8      |      | 3.2      |      | 3.6      |      | 4.2       |      | 5.9      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay        |          |     | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay        |          |     | 3.5      |      | 3.9      |      | 4.4      |      | 5.2       |      | 7.3      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay        |          |     | 3.9      |      | 4.3      |      | 4.9      |      | 5.7       |      | 8.0      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay        |          |     | 5.2      |      | 5.8      |      | 6.6      |      | 7.7       |      | 10.8     |      | ns    |
| Global Clock Network                               |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH           | FO = 32  | 4.1 |          | 4.5  |          | 5.1  |          | 6.0  |           | 8.4  |          | ns   |       |
|                                                    |                             | FO = 256 | 4.5 |          | 5.0  |          | 5.6  |          | 6.7  |           | 9.3  |          | ns   |       |
| t <sub>CKL</sub>                                   | Input HIGH to LOW           | FO = 32  | 5.0 |          | 5.5  |          | 6.2  |          | 7.3  |           | 10.2 |          | ns   |       |
|                                                    |                             | FO = 256 | 5.4 |          | 6.0  |          | 6.8  |          | 8.0  |           | 11.2 |          | ns   |       |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH    | FO = 32  | 1.7 |          | 1.9  |          | 2.1  |          | 2.5  |           | 3.5  |          | ns   |       |
|                                                    |                             | FO = 256 | 1.9 |          | 2.1  |          | 2.3  |          | 2.7  |           | 3.8  |          | ns   |       |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW     | FO = 32  | 1.7 |          | 1.9  |          | 2.1  |          | 2.5  |           | 3.5  |          | ns   |       |
|                                                    |                             | FO = 256 | 1.9 |          | 2.1  |          | 2.3  |          | 2.7  |           | 3.8  |          | ns   |       |
| t <sub>CKSW</sub>                                  | Maximum Skew                | FO = 32  | 0.4 |          | 0.5  |          | 0.5  |          | 0.6  |           | 0.9  |          | ns   |       |
|                                                    |                             | FO = 256 | 0.4 |          | 0.5  |          | 0.5  |          | 0.6  |           | 0.9  |          | ns   |       |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up | FO = 32  | 0.0 |          | 0.0  |          | 0.0  |          | 0.0  |           | 0.0  |          | ns   |       |
|                                                    |                             | FO = 256 | 0.0 |          | 0.0  |          | 0.0  |          | 0.0  |           | 0.0  |          | ns   |       |
| t <sub>HEXT</sub>                                  | Input Latch External Hold   | FO = 32  | 3.3 |          | 3.7  |          | 4.2  |          | 4.9  |           | 6.9  |          | ns   |       |
|                                                    |                             | FO = 256 | 3.7 |          | 4.1  |          | 4.6  |          | 5.5  |           | 7.6  |          | ns   |       |
| t <sub>p</sub>                                     | Minimum Period              | FO = 32  | 5.6 |          | 6.2  |          | 6.7  |          | 7.8  |           | 12.9 |          | ns   |       |
|                                                    |                             | FO = 256 | 6.1 |          | 6.8  |          | 7.4  |          | 8.5  |           | 14.2 |          | ns   |       |
| f <sub>MAX</sub>                                   | Maximum Frequency           | FO = 32  | 177 |          | 161  |          | 148  |          | 129  |           | 77   |          | MHz  |       |
|                                                    |                             | FO = 256 | 161 |          | 146  |          | 135  |          | 117  |           | 70   |          | MHz  |       |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-33 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description               |                                                          | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|---------------------------------------|----------------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                       |                                                          | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| TTL Output Module Timing <sup>5</sup> |                                                          |           |           |           |           |           |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                                         | 3.4       | 3.8       | 4.3       | 5.1       | 7.1       | ns    |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                                          | 4.0       | 4.5       | 5.1       | 6.1       | 8.3       | ns    |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                                     | 3.7       | 4.1       | 4.6       | 5.5       | 7.6       | ns    |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                                      | 4.1       | 4.5       | 5.1       | 6.1       | 8.5       | ns    |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                                     | 6.9       | 7.6       | 8.6       | 10.2      | 14.2      | ns    |
| t <sub>ENLZ</sub>                     | Enable Pad LOW to Z                                      | 7.5       | 8.3       | 9.4       | 11.1      | 15.5      | ns    |
| t <sub>GLH</sub>                      | G-to-Pad HIGH                                            | 5.8       | 6.5       | 7.3       | 8.6       | 12.0      | ns    |
| t <sub>GHL</sub>                      | G-to-Pad LOW                                             | 5.8       | 6.5       | 7.3       | 8.6       | 12.0      | ns    |
| t <sub>LSU</sub>                      | I/O Latch Set-Up                                         | 0.7       | 0.8       | 0.9       | 1.0       | 1.4       | ns    |
| t <sub>LH</sub>                       | I/O Latch Hold                                           | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                      | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 8.7       | 9.7       | 10.9      | 12.9      | 18.0      | ns    |
| t <sub>ACO</sub>                      | Array Clock-to-Out<br>(Pad-to-Pad),64 Clock Loading      | 12.2      | 13.5      | 15.4      | 18.1      | 25.3      | ns    |
| d <sub>TLH</sub>                      | Capacity Loading, LOW to HIGH                            | 0.00      | 0.00      | 0.00      | 0.10      | 0.01      | ns/pF |
| d <sub>THL</sub>                      | Capacity Loading, HIGH to LOW                            | 0.09      | 0.10      | 0.10      | 0.10      | 0.10      | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-33 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                |                                                          | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|----------------------------------------|----------------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                        |                                                          | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| CMOS Output Module Timing <sup>5</sup> |                                                          |           |           |           |           |           |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                         | 3.4       | 3.8       | 5.5       | 6.4       | 9.0       | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                          | 4.1       | 4.5       | 4.2       | 5.0       | 7.0       | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                                     | 3.7       | 4.1       | 4.6       | 5.5       | 7.6       | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                                      | 4.1       | 4.5       | 5.1       | 6.1       | 8.5       | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                                     | 6.9       | 7.6       | 8.6       | 10.2      | 14.2      | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                                      | 7.5       | 8.3       | 9.4       | 11.1      | 15.5      | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                            | 5.8       | 6.5       | 7.3       | 8.6       | 12.0      | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                             | 5.8       | 6.5       | 7.3       | 8.6       | 12.0      | ns    |
| t <sub>LSU</sub>                       | I/O Latch Set-Up                                         | 0.7       | 0.8       | 0.9       | 1.0       | 1.4       | ns    |
| t <sub>LH</sub>                        | I/O Latch Hold                                           | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 8.7       | 9.7       | 10.9      | 12.9      | 18.0      | ns    |
| t <sub>ACO</sub>                       | Array Clock-to-Out<br>(Pad-to-Pad),<br>64 Clock Loading  | 12.2      | 13.5      | 15.4      | 18.1      | 25.3      | ns    |
| d <sub>TLH</sub>                       | Capacity Loading, LOW to HIGH                            | 0.04      | 0.04      | 0.05      | 0.06      | 0.08      | ns/pF |
| d <sub>THL</sub>                       | Capacity Loading, HIGH to LOW                            | 0.05      | 0.05      | 0.06      | 0.07      | 0.10      | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-34 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                            | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|----------------------------------------------------|--------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                                    |                                            | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| Logic Module Propagation Delays <sup>1</sup>       |                                            |           |           |           |           |           |       |
| t <sub>PD1</sub>                                   | Single Module                              | 1.4       | 1.5       | 1.7       | 2.0       | 2.8       | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                      | 1.4       | 1.6       | 1.8       | 2.1       | 3.0       | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                               | 1.4       | 1.5       | 1.7       | 2.0       | 2.8       | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q               | 1.6       | 1.7       | 2.0       | 2.3       | 3.3       | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                            |           |           |           |           |           |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                       | 0.8       | 0.9       | 1.0       | 1.2       | 1.6       | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                       | 1.0       | 1.2       | 1.3       | 1.5       | 2.1       | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                       | 1.3       | 1.4       | 1.6       | 1.9       | 2.7       | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                       | 1.6       | 1.7       | 2.0       | 2.3       | 3.2       | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                       | 2.6       | 2.9       | 3.2       | 3.8       | 5.3       | ns    |
| Logic Module Sequential Timing <sup>3,4</sup>      |                                            |           |           |           |           |           |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Data Input Set-Up        | 0.3       | 0.4       | 0.4       | 0.5       | 0.7       | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Data Input Hold          | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up            | 0.7       | 0.8       | 0.9       | 1.0       | 1.4       | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold              | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch) Clock Active Pulse Width | 3.4       | 3.8       | 4.3       | 5.0       | 7.1       | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch) Asynchronous Pulse Width | 4.5       | 5.0       | 5.6       | 6.6       | 9.2       | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period               | 6.8       | 7.6       | 8.6       | 10.1      | 14.1      | ns    |
| t <sub>INH</sub>                                   | Input Buffer Latch Hold                    | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>INSU</sub>                                  | Input Buffer Latch Set-Up                  | 0.5       | 0.5       | 0.6       | 0.7       | 1.0       | ns    |
| t <sub>OUTH</sub>                                  | Output Buffer Latch Hold                   | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>OUTSU</sub>                                 | Output Buffer Latch Set-Up                 | 0.5       | 0.5       | 0.6       | 0.7       | 1.0       | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency          | 215       | 195       | 179       | 156       | 94        | MHz   |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, point and position whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-34 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                             |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                             |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Propagation Delays                    |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH               |          | 1.1      |      | 1.2      |      | 1.3      |      | 1.6       |      | 2.2      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                |          | 0.8      |      | 0.9      |      | 1.0      |      | 1.2       |      | 1.7      |      | ns    |
| t <sub>INGH</sub>                                  | G to Y HIGH                 |          | 1.4      |      | 1.6      |      | 1.8      |      | 2.1       |      | 2.9      |      | ns    |
| t <sub>INGL</sub>                                  | G to Y LOW                  |          | 1.4      |      | 1.6      |      | 1.8      |      | 2.1       |      | 2.9      |      | ns    |
| Input Module Predicted Routing Delays <sup>2</sup> |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay        |          | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 4.0      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay        |          | 2.1      |      | 2.3      |      | 2.6      |      | 3.1       |      | 4.3      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay        |          | 2.3      |      | 2.6      |      | 3.0      |      | 3.5       |      | 4.9      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay        |          | 2.6      |      | 3.0      |      | 3.3      |      | 3.9       |      | 5.4      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay        |          | 3.6      |      | 4.0      |      | 4.6      |      | 5.4       |      | 7.5      |      | ns    |
| Global Clock Network                               |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH           | FO = 32  | 2.6      |      | 2.9      |      | 3.3      |      | 3.9       |      | 5.4      |      | ns    |
|                                                    |                             | FO = 384 | 2.9      |      | 3.2      |      | 3.6      |      | 4.3       |      | 6.0      |      | ns    |
| t <sub>CKL</sub>                                   | Input HIGH to LOW           | FO = 32  | 3.8      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
|                                                    |                             | FO = 384 | 4.5      |      | 5.0      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH    | FO = 32  | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
|                                                    |                             | FO = 384 | 3.7      |      | 4.1      |      | 4.6      |      | 5.4       |      | 7.6      |      | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW     | FO = 32  | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
|                                                    |                             | FO = 384 | 3.7      |      | 4.1      |      | 4.6      |      | 5.4       |      | 7.6      |      | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew                | FO = 32  | 0.3      |      | 0.4      |      | 0.4      |      | 0.5       |      | 0.7      |      | ns    |
|                                                    |                             | FO = 384 | 0.3      |      | 0.4      |      | 0.4      |      | 0.5       |      | 0.7      |      | ns    |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                                                    |                             | FO = 384 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>                                  | Input Latch External Hold   | FO = 32  | 2.8      |      | 3.1      |      | 5.5      |      | 4.1       |      | 5.7      |      | ns    |
|                                                    |                             | FO = 384 | 3.2      |      | 3.5      |      | 4.0      |      | 4.7       |      | 6.6      |      | ns    |
| t <sub>p</sub>                                     | Minimum Period              | FO = 32  | 4.2      |      | 4.67     |      | 5.1      |      | 5.8       |      | 9.7      |      | ns    |
|                                                    |                             | FO = 384 | 4.6      |      | 5.1      |      | 5.6      |      | 6.4       |      | 10.7     |      | ns    |
| f <sub>MAX</sub>                                   | Maximum Frequency           | FO = 32  | 237      |      | 215      |      | 198      |      | 172       |      | 103      |      | MHz   |
|                                                    |                             | FO = 384 | 215      |      | 195      |      | 179      |      | 156       |      | 94       |      | MHz   |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, point and position whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-34 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description               |                                                          | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|---------------------------------------|----------------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                       |                                                          | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| TTL Output Module Timing <sup>5</sup> |                                                          |           |           |           |           |           |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                                         | 2.5       | 2.8       | 3.2       | 3.7       | 5.2       | ns    |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                                          | 3.0       | 3.3       | 3.7       | 4.4       | 6.1       | ns    |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                                     | 2.7       | 3.0       | 3.4       | 4.0       | 5.6       | ns    |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                                      | 3.0       | 3.3       | 3.8       | 4.4       | 6.2       | ns    |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                                     | 5.4       | 6.0       | 6.8       | 8.0       | 11.2      | ns    |
| t <sub>ENLZ</sub>                     | Enable Pad LOW to Z                                      | 5.0       | 5.6       | 6.3       | 7.4       | 10.4      | ns    |
| t <sub>GLH</sub>                      | G-to-Pad HIGH                                            | 2.9       | 3.2       | 3.6       | 4.3       | 6.0       | ns    |
| t <sub>GHL</sub>                      | G-to-Pad LOW                                             | 2.9       | 3.2       | 3.6       | 4.3       | 6.0       | ns    |
| t <sub>LCO</sub>                      | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 5.7       | 6.3       | 7.1       | 8.4       | 11.9      | ns    |
| t <sub>ACO</sub>                      | Array Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading     | 8.0       | 8.9       | 10.1      | 11.9      | 16.7      | ns    |
| d <sub>TLH</sub>                      | Capacitive Loading, LOW to HIGH                          | 0.03      | 0.03      | 0.03      | 0.04      | 0.06      | ns/pF |
| d <sub>THL</sub>                      | Capacitive Loading, HIGH to LOW                          | 0.04      | 0.04      | 0.04      | 0.05      | 0.07      | ns/pF |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, point and position whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-34 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                                                          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|----------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                                                          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| CMOS Output Module Timing <sup>5</sup> |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                         |          | 3.2  |          | 3.6  |          | 4.0  |           | 4.7  |          | 6.6  | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                          |          | 2.5  |          | 2.7  |          | 3.1  |           | 3.6  |          | 5.1  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                                     |          | 2.7  |          | 3.0  |          | 3.4  |           | 4.0  |          | 5.6  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                                      |          | 3.0  |          | 3.3  |          | 3.8  |           | 4.4  |          | 6.2  | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                                     |          | 5.4  |          | 6.0  |          | 6.8  |           | 8.0  |          | 11.2 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                                      |          | 5.0  |          | 5.6  |          | 6.3  |           | 7.4  |          | 10.4 | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                            |          | 5.1  |          | 5.6  |          | 6.4  |           | 7.5  |          | 10.5 | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                             |          | 5.1  |          | 5.6  |          | 6.4  |           | 7.5  |          | 10.5 | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading |          | 5.7  |          | 6.3  |          | 7.1  |           | 8.4  |          | 11.9 | ns    |
| t <sub>ACO</sub>                       | Array Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading     |          | 8.0  |          | 8.9  |          | 10.1 |           | 11.9 |          | 16.7 | ns    |
| d <sub>TLH</sub>                       | Capacitive Loading, LOW to HIGH                          |          | 0.03 |          | 0.03 |          | 0.03 |           | 0.04 |          | 0.06 | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , point and position whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-35 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                               | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                               | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Propagation Delays <sup>1</sup>       |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD1</sub>                                   | Single Module                                 | 1.9      |      | 2.1      |      | 2.4      |      | 2.8       |      | 4.0      |      | ns    |
| t <sub>CO</sub>                                    | Sequential Clock-to-Q                         | 2.0      |      | 2.2      |      | 2.5      |      | 3.0       |      | 4.2      |      | ns    |
| t <sub>GO</sub>                                    | Latch G-to-Q                                  | 1.9      |      | 2.1      |      | 2.4      |      | 2.8       |      | 4.0      |      | ns    |
| t <sub>RS</sub>                                    | Flip-Flop (Latch) Reset-to-Q                  | 2.2      |      | 2.4      |      | 2.8      |      | 3.3       |      | 4.6      |      | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                          | 1.1      |      | 1.2      |      | 1.4      |      | 1.6       |      | 2.3      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                          | 1.5      |      | 1.6      |      | 1.8      |      | 2.1       |      | 3.0      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                          | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.8      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                          | 2.2      |      | 2.4      |      | 2.7      |      | 3.2       |      | 4.5      |      | ns    |
| t <sub>RD8</sub>                                   | FO = 8 Routing Delay                          | 3.6      |      | 4.0      |      | 4.5      |      | 5.3       |      | 7.5      |      | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch)<br>Data Input Set-Up        | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 0.9      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Data Input Hold             | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up               | 1.0      |      | 1.1      |      | 1.2      |      | 1.4       |      | 2.0      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width | 4.8      |      | 5.3      |      | 6.0      |      | 7.1       |      | 9.9      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width | 6.2      |      | 6.9      |      | 7.9      |      | 9.2       |      | 12.9     |      | ns    |
| t <sub>A</sub>                                     | Flip-Flop Clock Input Period                  | 9.5      |      | 10.6     |      | 12.0     |      | 14.1      |      | 19.8     |      | ns    |
| t <sub>INH</sub>                                   | Input Buffer Latch Hold                       | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                                  | Input Buffer Latch Set-Up                     | 0.7      |      | 0.8      |      | 0.9      |      | 1.01      |      | 1.4      |      | ns    |
| t <sub>OUTH</sub>                                  | Output Buffer Latch Hold                      | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>OUTSU</sub>                                 | Output Buffer Latch Set-Up                    | 0.7      |      | 0.8      |      | 0.89     |      | 1.01      |      | 1.4      |      | ns    |
| f <sub>MAX</sub>                                   | Flip-Flop (Latch) Clock Frequency             | 129      |      | 117      |      | 108      |      | 94        |      | 56       |      | MHz   |

**Notes:**

1. For dual-module macros use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>aped</sub>, to + t<sub>RD1</sub> + t<sub>aped</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>usk</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-35 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                             |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                             |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Propagation Delays                    |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INYH</sub>                                  | Pad-to-Y HIGH               |          | 1.5      |      | 1.6      |      | 1.9      |      | 2.2       |      | 3.1      |      | ns    |
| t <sub>INYL</sub>                                  | Pad-to-Y LOW                |          | 1.1      |      | 1.3      |      | 1.4      |      | 1.7       |      | 2.4      |      | ns    |
| t <sub>INGH</sub>                                  | G to Y HIGH                 |          | 2.0      |      | 2.2      |      | 2.5      |      | 2.9       |      | 4.1      |      | ns    |
| t <sub>INGL</sub>                                  | G to Y LOW                  |          | 2.0      |      | 2.2      |      | 2.5      |      | 2.9       |      | 4.1      |      | ns    |
| Input Module Predicted Routing Delays <sup>2</sup> |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay        |          | 2.6      |      | 2.9      |      | 3.2      |      | 3.8       |      | 5.3      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay        |          | 2.9      |      | 3.2      |      | 3.7      |      | 4.3       |      | 6.1      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay        |          | 3.3      |      | 3.6      |      | 4.1      |      | 4.9       |      | 6.8      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay        |          | 3.6      |      | 4.0      |      | 4.6      |      | 5.4       |      | 7.6      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay        |          | 5.1      |      | 5.6      |      | 6.4      |      | 7.5       |      | 10.5     |      | ns    |
| Global Clock Network                               |                             |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH           | FO = 32  | 4.4      |      | 4.8      |      | 5.5      |      | 6.5       |      | 9.0      |      | ns    |
|                                                    |                             | FO = 384 | 4.8      |      | 5.3      |      | 6.0      |      | 7.1       |      | 9.9      |      | ns    |
| t <sub>CKL</sub>                                   | Input HIGH to LOW           | FO = 32  | 5.3      |      | 5.9      |      | 6.7      |      | 7.8       |      | 11.0     |      | ns    |
|                                                    |                             | FO = 384 | 6.2      |      | 6.9      |      | 7.9      |      | 9.2       |      | 12.9     |      | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH    | FO = 32  | 5.7      |      | 6.3      |      | 7.1      |      | 8.4       |      | 11.8     |      | ns    |
|                                                    |                             | FO = 384 | 6.6      |      | 7.4      |      | 8.3      |      | 9.8       |      | 13.7     |      | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW     | FO = 32  | 5.3      |      | 5.9      |      | 6.7      |      | 7.8       |      | 11.0     |      | ns    |
|                                                    |                             | FO = 384 | 6.2      |      | 6.9      |      | 7.9      |      | 9.2       |      | 12.9     |      | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew                | FO = 32  | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
|                                                    |                             | FO = 384 | 2.2      |      | 2.4      |      | 2.7      |      | 3.2       |      | 4.5      |      | ns    |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                                                    |                             | FO = 384 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>                                  | Input Latch External Hold   | FO = 32  | 3.9      |      | 4.3      |      | 4.9      |      | 5.7       |      | 8.0      |      | ns    |
|                                                    |                             | FO = 384 | 4.5      |      | 4.9      |      | 5.6      |      | 6.6       |      | 9.2      |      | ns    |
| t <sub>p</sub>                                     | Minimum Period              | FO = 32  | 7.0      |      | 7.8      |      | 8.4      |      | 9.7       |      | 16.2     |      | ns    |
|                                                    |                             | FO = 384 | 7.7      |      | 8.6      |      | 9.3      |      | 10.7      |      | 17.8     |      | ns    |
| f <sub>MAX</sub>                                   | Maximum Frequency           | FO = 32  | 142      |      | 129      |      | 119      |      | 103       |      | 62       |      | MHz   |
|                                                    |                             | FO = 384 | 129      |      | 117      |      | 108      |      | 94        |      | 56       |      | MHz   |

**Notes:**

1. For dual-module macros use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>aped</sub>, to + t<sub>RD1</sub> + t<sub>aped</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>usk</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-35 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description    |                                                          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------|----------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                            |                                                          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing5  |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>           | Data-to-Pad HIGH                                         | 3.5      |      | 3.9      |      | 4.4      |      | 5.2       |      | 7.3      |      | ns    |
| t <sub>DHL</sub>           | Data-to-Pad LOW                                          | 4.1      |      | 4.6      |      | 5.2      |      | 6.1       |      | 8.6      |      | ns    |
| t <sub>ENZH</sub>          | Enable Pad Z to HIGH                                     | 3.8      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>ENZL</sub>          | Enable Pad Z to LOW                                      | 4.2      |      | 4.6      |      | 5.3      |      | 6.2       |      | 8.7      |      | ns    |
| t <sub>ENHZ</sub>          | Enable Pad HIGH to Z                                     | 7.6      |      | 8.4      |      | 9.5      |      | 11.2      |      | 15.7     |      | ns    |
| t <sub>ENLZ</sub>          | Enable Pad LOW to Z                                      | 7.0      |      | 7.8      |      | 8.8      |      | 10.4      |      | 14.5     |      | ns    |
| t <sub>GLH</sub>           | G-to-Pad HIGH                                            | 4.8      |      | 5.3      |      | 6.0      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>GHL</sub>           | G-to-Pad LOW                                             | 4.8      |      | 5.3      |      | 6.0      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>LCO</sub>           | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 8.0      |      | 8.9      |      | 10.1     |      | 11.9      |      | 16.7     |      | ns    |
| t <sub>ACO</sub>           | Array Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading     | 11.3     |      | 12.5     |      | 14.2     |      | 16.7      |      | 23.3     |      | ns    |
| d <sub>TLH</sub>           | Capacitive Loading, LOW to HIGH                          | 0.04     |      | 0.04     |      | 0.05     |      | 0.06      |      | 0.08     |      | ns/pF |
| d <sub>THL</sub>           | Capacitive Loading, HIGH to LOW                          | 0.05     |      | 0.05     |      | 0.06     |      | 0.07      |      | 0.10     |      | ns/pF |
| CMOS Output Module Timing5 |                                                          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>           | Data-to-Pad HIGH                                         | 4.5      |      | 5.0      |      | 5.6      |      | 6.6       |      | 9.3      |      | ns    |
| t <sub>DHL</sub>           | Data-to-Pad LOW                                          | 3.4      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      | ns    |
| t <sub>ENZH</sub>          | Enable Pad Z to HIGH                                     | 3.8      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>ENZL</sub>          | Enable Pad Z to LOW                                      | 4.2      |      | 4.6      |      | 5.3      |      | 6.2       |      | 8.7      |      | ns    |
| t <sub>ENHZ</sub>          | Enable Pad HIGH to Z                                     | 7.6      |      | 8.4      |      | 9.5      |      | 11.2      |      | 15.7     |      | ns    |
| t <sub>ENLZ</sub>          | Enable Pad LOW to Z                                      | 7.0      |      | 7.8      |      | 8.8      |      | 10.4      |      | 14.5     |      | ns    |
| t <sub>GLH</sub>           | G-to-Pad HIGH                                            | 7.1      |      | 7.9      |      | 8.9      |      | 10.5      |      | 14.7     |      | ns    |
| t <sub>GHL</sub>           | G-to-Pad LOW                                             | 7.1      |      | 7.9      |      | 8.9      |      | 10.5      |      | 14.7     |      | ns    |
| t <sub>LCO</sub>           | I/O Latch Clock-to-Out<br>(Pad-to-Pad), 64 Clock Loading | 8.0      |      | 8.9      |      | 10.1     |      | 11.9      |      | 16.7     |      | ns    |
| t <sub>ACO</sub>           | Array Clock-to-Out<br>(Pad-to-Pad),64 Clock Loading      | 11.3     |      | 12.5     |      | 14.2     |      | 16.7      |      | 23.3     |      | ns    |
| d <sub>TLH</sub>           | Capacitive Loading, LOW to HIGH                          | 0.04     |      | 0.04     |      | 0.05     |      | 0.06      |      | 0.08     |      | ns/pF |
| d <sub>THL</sub>           | Capacitive Loading, HIGH to LOW                          | 0.05     |      | 0.05     |      | 0.06     |      | 0.07      |      | 0.10     |      | ns/pF |

**Notes:**

1. For dual-module macros use  $t_{PD1} + t_{RD1} + t_{aped}$ , to +  $t_{RD1} + t_{aped}$ , or  $t_{PD1} + t_{RD1} + t_{usk}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-36 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                               | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                               | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Combinatorial Functions <sup>1</sup>  |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD</sub>                                    | Internal Array Module Delay                   |          | 1.2  |          | 1.3  |          | 1.5  |           | 1.8  |          | 2.5  | ns    |
| t <sub>PDD</sub>                                   | Internal Decode Module Delay                  |          | 1.4  |          | 1.6  |          | 1.8  |           | 2.1  |          | 3.0  | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                          |          | 0.8  |          | 0.9  |          | 1.0  |           | 1.2  |          | 1.7  | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                          |          | 1.0  |          | 1.2  |          | 1.3  |           | 1.5  |          | 2.1  | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                          |          | 1.3  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.6  | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                          |          | 1.5  |          | 1.7  |          | 1.9  |           | 2.2  |          | 3.1  | ns    |
| t <sub>RD5</sub>                                   | FO = 8 Routing Delay                          |          | 2.4  |          | 2.7  |          | 3.0  |           | 3.6  |          | 5.0  | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CO</sub>                                    | Flip-Flop Clock-to-Output                     |          | 1.3  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.7  | ns    |
| t <sub>GO</sub>                                    | Latch Gate-to-Output                          |          | 1.2  |          | 1.3  |          | 1.5  |           | 1.8  |          | 2.5  | ns    |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Set-Up Time                 | 0.3      |      | 0.4      |      | 0.4      |      | 0.5       |      | 0.7      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Hold Time                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RO</sub>                                    | Flip-Flop (Latch) Reset-to-Output             |          | 1.4  |          | 1.6  |          | 1.8  |           | 2.1  |          | 2.9  | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up               | 0.4      |      | 0.5      |      | 0.5      |      | 0.6       |      | 0.8      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width | 3.3      |      | 3.7      |      | 4.2      |      | 4.9       |      | 6.9      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width | 4.4      |      | 4.8      |      | 5.3      |      | 6.5       |      | 9.0      |      | ns    |
| Input Module Propagation Delays                    |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INPY</sub>                                  | Input Data Pad-to-Y                           |          | 1.0  |          | 1.1  |          | 1.3  |           | 1.5  |          | 2.1  | ns    |
| t <sub>INGO</sub>                                  | Input Latch Gate-to-Output                    |          | 1.3  |          | 1.4  |          | 1.6  |           | 1.9  |          | 2.6  | ns    |
| t <sub>INH</sub>                                   | Input Latch Hold                              | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                                  | Input Latch Set-Up                            | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| t <sub>ILA</sub>                                   | Latch Active Pulse Width                      | 4.7      |      | 5.2      |      | 5.9      |      | 6.9       |      | 9.7      |      | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-36 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                      |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|--------------------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                      |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays <sup>2</sup> |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay                 |          | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.8      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay                 |          | 2.1      |      | 2.3      |      | 2.6      |      | 3.1       |      | 4.3      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay                 |          | 2.3      |      | 2.5      |      | 2.9      |      | 3.4       |      | 4.8      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay                 |          | 2.5      |      | 2.8      |      | 3.2      |      | 3.7       |      | 5.2      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay                 |          | 3.4      |      | 3.8      |      | 4.3      |      | 5.1       |      | 7.1      |      | ns    |
| Global Clock Network                               |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH                    | FO = 32  | 2.6      |      | 2.9      |      | 3.3      |      | 3.9       |      | 5.4      |      | ns    |
|                                                    |                                      | FO = 486 | 2.9      |      | 3.2      |      | 3.6      |      | 4.3       |      | 5.9      |      | ns    |
| t <sub>CKL</sub>                                   | Input HIGH to LOW                    | FO = 32  | 3.7      |      | 4.1      |      | 4.6      |      | 5.4       |      | 7.6      |      | ns    |
|                                                    |                                      | FO = 486 | 4.3      |      | 4.7      |      | 5.4      |      | 6.3       |      | 8.8      |      | ns    |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH             | FO = 32  | 2.2      |      | 2.4      |      | 2.7      |      | 3.2       |      | 4.5      |      | ns    |
|                                                    |                                      | FO = 486 | 2.4      |      | 2.6      |      | 3.0      |      | 3.5       |      | 4.9      |      | ns    |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW              | FO = 32  | 2.2      |      | 2.4      |      | 2.7      |      | 3.2       |      | 4.5      |      | ns    |
|                                                    |                                      | FO = 486 | 2.4      |      | 2.6      |      | 3.0      |      | 3.5       |      | 4.9      |      | ns    |
| t <sub>CKSW</sub>                                  | Maximum Skew                         | FO = 32  |          | 0.5  |          | 0.6  |          | 0.7  |           | 0.8  |          | 1.1  | ns    |
|                                                    |                                      | FO = 486 |          | 0.5  |          | 0.6  |          | 0.7  |           | 0.8  |          | 1.1  | ns    |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up          | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                                                    |                                      | FO = 486 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>                                  | Input Latch External Hold            | FO = 32  | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
|                                                    |                                      | FO = 486 | 3.3      |      | 3.7      |      | 4.2      |      | 4.9       |      | 6.9      |      | ns    |
| t <sub>P</sub>                                     | Minimum Period (1/f <sub>MAX</sub> ) | FO = 32  | 4.7      |      | 5.2      |      | 5.7      |      | 6.5       |      | 10.9     |      | ns    |
|                                                    |                                      | FO = 486 | 5.1      |      | 5.7      |      | 6.2      |      | 7.1       |      | 11.9     |      | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-36 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description               |                                                 | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|---------------------------------------|-------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                       |                                                 | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing <sup>5</sup> |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                                |          | 2.4  |          | 2.7  |          | 3.1  |           | 3.6  |          | 5.1  | ns    |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                                 |          | 2.8  |          | 3.2  |          | 3.6  |           | 4.2  |          | 5.9  | ns    |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                            |          | 2.5  |          | 2.8  |          | 3.2  |           | 3.8  |          | 5.3  | ns    |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                             |          | 2.8  |          | 3.1  |          | 3.5  |           | 4.2  |          | 5.9  | ns    |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                            |          | 5.2  |          | 5.7  |          | 6.5  |           | 7.6  |          | 10.7 | ns    |
| t <sub>ENLZ</sub>                     | Enable Pad LOW to Z                             |          | 4.8  |          | 5.3  |          | 6.0  |           | 7.1  |          | 9.9  | ns    |
| t <sub>GLH</sub>                      | G-to-Pad HIGH                                   |          | 2.9  |          | 3.2  |          | 3.6  |           | 4.3  |          | 6.0  | ns    |
| t <sub>GHL</sub>                      | G-to-Pad LOW                                    |          | 2.9  |          | 3.2  |          | 3.6  |           | 4.3  |          | 6.0  | ns    |
| t <sub>LSU</sub>                      | I/O Latch Output Set-Up                         | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| t <sub>LH</sub>                       | I/O Latch Output Hold                           | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>LCO</sub>                      | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   |          | 5.6  |          | 6.1  |          | 6.9  |           | 8.1  |          | 11.4 | ns    |
| t <sub>ACO</sub>                      | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O |          | 10.6 |          | 11.8 |          | 13.4 |           | 15.7 |          | 22.0 | ns    |
| d <sub>TLH</sub>                      | Capacitive Loading, LOW to HIGH                 |          | 0.04 |          | 0.04 |          | 0.04 |           | 0.05 |          | 0.07 | ns/pF |
| d <sub>THL</sub>                      | Capacitive Loading, HIGH to LOW                 |          | 0.03 |          | 0.03 |          | 0.03 |           | 0.04 |          | 0.06 | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-36 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                                                 | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|----------------------------------------|-------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                        |                                                 | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| CMOS Output Module Timing <sup>5</sup> |                                                 |           |           |           |           |           |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                | 3.1       | 3.5       | 3.9       | 4.6       | 6.4       | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                 | 2.4       | 2.6       | 3.0       | 3.5       | 4.9       | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                            | 2.5       | 2.8       | 3.2       | 3.8       | 5.3       | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                             | 2.8       | 3.1       | 3.5       | 4.2       | 5.8       | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                            | 5.2       | 5.7       | 6.5       | 7.6       | 10.7      | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                             | 4.8       | 5.3       | 6.0       | 7.1       | 9.9       | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                   | 4.9       | 5.4       | 6.2       | 7.2       | 10.1      | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                    | 4.9       | 5.4       | 6.2       | 7.2       | 10.1      | ns    |
| t <sub>LSU</sub>                       | I/O Latch Set-Up                                | 0.5       | 0.5       | 0.6       | 0.7       | 1.0       | ns    |
| t <sub>LH</sub>                        | I/O Latch Hold                                  | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   | 5.5       | 6.1       | 6.9       | 8.1       | 11.3      | ns    |
| t <sub>ACO</sub>                       | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O | 10.6      | 11.8      | 13.4      | 15.7      | 22.0      | ns    |
| d <sub>TLH</sub>                       | Capacitive Loading, LOW to HIGH                 | 0.04      | 0.04      | 0.04      | 0.05      | 0.07      | ns/pF |
| d <sub>THL</sub>                       | Capacitive Loading, HIGH to LOW                 | 0.03      | 0.03      | 0.03      | 0.04      | 0.06      | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-37 • A42MX24 Timing Characteristics (Nominal 3.3 V Operation)**  
 (Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                               | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                               | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Combinatorial Functions <sup>1</sup>  |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD</sub>                                    | Internal Array Module Delay                   | 2.0      |      | 1.8      |      | 2.1      |      | 2.5       |      | 3.4      |      | ns    |
| t <sub>PDD</sub>                                   | Internal Decode Module Delay                  | 1.1      |      | 2.2      |      | 2.5      |      | 3.0       |      | 4.2      |      | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                          | 1.7      |      | 1.3      |      | 1.4      |      | 1.7       |      | 2.3      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                          | 2.0      |      | 1.6      |      | 1.8      |      | 2.1       |      | 3.0      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                          | 1.1      |      | 2.0      |      | 2.2      |      | 2.6       |      | 3.7      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                          | 1.5      |      | 2.3      |      | 2.6      |      | 3.1       |      | 4.3      |      | ns    |
| t <sub>RD5</sub>                                   | FO = 8 Routing Delay                          | 1.8      |      | 3.7      |      | 4.2      |      | 5.0       |      | 7.0      |      | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CO</sub>                                    | Flip-Flop Clock-to-Output                     | 2.1      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>GO</sub>                                    | Latch Gate-to-Output                          | 3.4      |      | 1.9      |      | 2.1      |      | 2.5       |      | 3.4      |      | ns    |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Set-Up Time                 | 0.4      |      | 0.5      |      | 0.6      |      | 0.7       |      | 0.9      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Hold Time                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RO</sub>                                    | Flip-Flop (Latch) Reset-to-Output             | 2.0      |      | 2.2      |      | 2.5      |      | 2.9       |      | 4.1      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up               | 0.6      |      | 0.6      |      | 0.7      |      | 0.8       |      | 1.2      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width | 4.6      |      | 5.2      |      | 5.8      |      | 6.9       |      | 9.6      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width | 6.1      |      | 6.8      |      | 7.7      |      | 9.0       |      | 12.6     |      | ns    |
| Input Module Propagation Delays                    |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INPY</sub>                                  | Input Data Pad-to-Y                           | 1.4      |      | 1.6      |      | 1.8      |      | 2.2       |      | 3.0      |      | ns    |
| t <sub>INGO</sub>                                  | Input Latch Gate-to-Output                    | 1.8      |      | 1.9      |      | 2.2      |      | 2.6       |      | 3.6      |      | ns    |
| t <sub>INH</sub>                                   | Input Latch Hold                              | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                                  | Input Latch Set-Up                            | 0.7      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.4      |      | ns    |
| t <sub>ILA</sub>                                   | Latch Active Pulse Width                      | 6.5      |      | 7.3      |      | 8.2      |      | 9.7       |      | 13.5     |      | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-37 • A42MX24 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                             |          |     | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------|----------|-----|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                             |          |     | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays <sup>2</sup> |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                                  | FO = 1 Routing Delay        |          |     | 2.6      |      | 2.9      |      | 3.2      |      | 3.8       |      | 5.3      |      | ns    |
| t <sub>IRD2</sub>                                  | FO = 2 Routing Delay        |          |     | 2.9      |      | 3.2      |      | 3.6      |      | 4.3       |      | 6.0      |      | ns    |
| t <sub>IRD3</sub>                                  | FO = 3 Routing Delay        |          |     | 3.2      |      | 3.6      |      | 4.0      |      | 4.8       |      | 6.6      |      | ns    |
| t <sub>IRD4</sub>                                  | FO = 4 Routing Delay        |          |     | 3.5      |      | 3.9      |      | 4.4      |      | 5.2       |      | 7.3      |      | ns    |
| t <sub>IRD8</sub>                                  | FO = 8 Routing Delay        |          |     | 4.8      |      | 5.3      |      | 6.1      |      | 7.1       |      | 10.0     |      | ns    |
| Global Clock Network                               |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                                   | Input LOW to HIGH           | FO = 32  | 4.4 |          | 4.8  |          | 5.5  |          | 6.5  |           | 9.1  |          | ns   |       |
|                                                    |                             | FO = 486 | 4.8 |          | 5.3  |          | 6.0  |          | 7.1  |           | 10.0 |          | ns   |       |
| t <sub>CKL</sub>                                   | Input HIGH to LOW           | FO = 32  | 5.1 |          | 5.7  |          | 6.4  |          | 7.6  |           | 10.6 |          | ns   |       |
|                                                    |                             | FO = 486 | 6.0 |          | 6.6  |          | 7.5  |          | 8.8  |           | 12.4 |          | ns   |       |
| t <sub>PWH</sub>                                   | Minimum Pulse Width HIGH    | FO = 32  | 3.0 |          | 3.3  |          | 3.8  |          | 4.5  |           | 6.3  |          | ns   |       |
|                                                    |                             | FO = 486 | 3.3 |          | 3.7  |          | 4.2  |          | 4.9  |           | 6.9  |          | ns   |       |
| t <sub>PWL</sub>                                   | Minimum Pulse Width LOW     | FO = 32  | 3.0 |          | 3.4  |          | 3.8  |          | 4.5  |           | 6.3  |          | ns   |       |
|                                                    |                             | FO = 486 | 3.3 |          | 3.7  |          | 4.2  |          | 4.9  |           | 6.9  |          | ns   |       |
| t <sub>CKSW</sub>                                  | Maximum Skew                | FO = 32  | 0.8 |          | 0.8  |          | 1.0  |          | 1.1  |           | 1.6  |          | ns   |       |
|                                                    |                             | FO = 486 | 0.8 |          | 0.8  |          | 1.0  |          | 1.1  |           | 1.6  |          | ns   |       |
| t <sub>SUEXT</sub>                                 | Input Latch External Set-Up | FO = 32  | 0.0 |          | 0.0  |          | 0.0  |          | 0.0  |           | 0.0  |          | ns   |       |
|                                                    |                             | FO = 486 | 0.0 |          | 0.0  |          | 0.0  |          | 0.0  |           | 0.0  |          | ns   |       |
| TTL Output Module Timing <sup>5</sup>              |                             |          |     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                                   | Data-to-Pad HIGH            |          |     | 3.4      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.1      |      | ns    |
| t <sub>DHL</sub>                                   | Data-to-Pad LOW             |          |     | 4.0      |      | 4.4      |      | 5.0      |      | 5.9       |      | 8.3      |      | ns    |
| t <sub>ENZH</sub>                                  | Enable Pad Z to HIGH        |          |     | 3.6      |      | 4.0      |      | 4.5      |      | 5.3       |      | 7.4      |      | ns    |
| t <sub>ENZL</sub>                                  | Enable Pad Z to LOW         |          |     | 3.9      |      | 4.4      |      | 5.0      |      | 5.8       |      | 8.2      |      | ns    |
| t <sub>ENHZ</sub>                                  | Enable Pad HIGH to Z        |          |     | 7.2      |      | 8.0      |      | 9.1      |      | 10.7      |      | 14.9     |      | ns    |
| t <sub>ENLZ</sub>                                  | Enable Pad LOW to Z         |          |     | 6.7      |      | 7.5      |      | 8.5      |      | 9.9       |      | 13.9     |      | ns    |
| t <sub>GLH</sub>                                   | G-to-Pad HIGH               |          |     | 4.8      |      | 5.3      |      | 6.0      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>GHL</sub>                                   | G-to-Pad LOW                |          |     | 4.8      |      | 5.3      |      | 6.0      |      | 7.2       |      | 10.0     |      | ns    |
| t <sub>LSU</sub>                                   | I/O Latch Output Set-Up     |          |     | 0.7      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.4      |      | ns    |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-37 • A42MX24 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                           |                                                 |          | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|---------------------------------------------------|-------------------------------------------------|----------|-----------|-----------|-----------|-----------|-----------|-------|
|                                                   |                                                 |          | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| TTL Output Module Timing <sup>5</sup> (continued) |                                                 |          |           |           |           |           |           |       |
| t <sub>LH</sub>                                   | I/O Latch Output Hold                           |          | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                                  | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   |          | 7.7       | 8.5       | 9.6       | 11.3      | 15.9      | ns    |
| t <sub>ACO</sub>                                  | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O |          | 14.8      | 16.5      | 18.7      | 22.0      | 30.8      | ns    |
| d <sub>TLH</sub>                                  | Capacitive Loading, LOW to HIGH                 |          | 0.05      | 0.05      | 0.06      | 0.07      | 0.10      | ns/pF |
| d <sub>THL</sub>                                  | Capacitive Loading, HIGH to LOW                 |          | 0.04      | 0.04      | 0.05      | 0.06      | 0.08      | ns/pF |
| CMOS Output Module Timing <sup>5</sup>            |                                                 |          |           |           |           |           |           |       |
| t <sub>DLH</sub>                                  | Data-to-Pad HIGH                                |          | 4.8       | 5.3       | 5.5       | 6.4       | 9.0       | ns    |
| t <sub>DHL</sub>                                  | Data-to-Pad LOW                                 |          | 3.5       | 3.9       | 4.1       | 4.9       | 6.8       | ns    |
| t <sub>ENZH</sub>                                 | Enable Pad Z to HIGH                            |          | 3.6       | 4.0       | 4.5       | 5.3       | 7.4       | ns    |
| t <sub>ENZL</sub>                                 | Enable Pad Z to LOW                             |          | 3.4       | 4.0       | 5.0       | 5.8       | 8.2       | ns    |
| t <sub>ENHZ</sub>                                 | Enable Pad HIGH to Z                            |          | 7.2       | 8.0       | 9.0       | 10.7      | 14.9      | ns    |
| t <sub>ENLZ</sub>                                 | Enable Pad LOW to Z                             |          | 6.7       | 7.5       | 8.5       | 9.9       | 13.9      | ns    |
| t <sub>GLH</sub>                                  | G-to-Pad HIGH                                   |          | 6.8       | 7.6       | 8.6       | 10.1      | 14.2      | ns    |
| t <sub>GHL</sub>                                  | G-to-Pad LOW                                    |          | 6.8       | 7.6       | 8.6       | 10.1      | 14.2      | ns    |
| t <sub>LSU</sub>                                  | I/O Latch Set-Up                                |          | 0.7       | 0.7       | 0.8       | 1.0       | 1.4       | ns    |
| t <sub>LH</sub>                                   | I/O Latch Hold                                  |          | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                                  | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   |          | 7.7       | 8.5       | 9.6       | 11.3      | 15.9      | ns    |
| t <sub>ACO</sub>                                  | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O |          | 14.8      | 16.5      | 18.7      | 22.0      | 30.8      | ns    |
| d <sub>TLH</sub>                                  | Capacitive Loading, LOW to HIGH                 |          | 0.05      | 0.05      | 0.06      | 0.07      | 0.10      | ns/pF |
| d <sub>THL</sub>                                  | Capacitive Loading, HIGH to LOW                 |          | 0.04      | 0.04      | 0.05      | 0.06      | 0.08      | ns/pF |
| t <sub>HEXT</sub>                                 | Input Latch External Hold                       | FO = 32  | 3.9       | 4.3       | 4.9       | 5.7       | 8.1       | ns    |
|                                                   |                                                 | FO = 486 | 4.6       | 5.2       | 5.8       | 6.9       | 9.6       | ns    |
| t <sub>P</sub>                                    | Minimum Period<br>(1/f <sub>MAX</sub> )         | FO = 32  | 7.8       | 8.7       | 9.5       | 10.8      | 18.2      | ns    |
|                                                   |                                                 | FO = 486 | 8.6       | 9.5       | 10.4      | 11.9      | 19.9      | ns    |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-38 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                            |                                            | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|----------------------------------------------------|--------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                                    |                                            | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| Logic Module Combinatorial Functions <sup>1</sup>  |                                            |           |           |           |           |           |       |
| t <sub>PD</sub>                                    | Internal Array Module Delay                | 1.3       | 1.5       | 1.7       | 2.0       | 2.7       | ns    |
| t <sub>PDD</sub>                                   | Internal Decode Module Delay               | 1.6       | 1.8       | 2.0       | 2.4       | 3.3       | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                            |           |           |           |           |           |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                       | 0.9       | 1.0       | 1.2       | 1.4       | 2.0       | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                       | 1.3       | 1.4       | 1.6       | 1.9       | 2.7       | ns    |
| t <sub>RD3</sub>                                   | FO =3 Routing Delay                        | 1.6       | 1.8       | 2.0       | 2.4       | 3.4       | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                       | 2.0       | 2.2       | 2.5       | 2.9       | 4.1       | ns    |
| t <sub>RD5</sub>                                   | FO = 8 Routing Delay                       | 3.3       | 3.7       | 4.2       | 4.9       | 6.9       | ns    |
| t <sub>RDD</sub>                                   | Decode-to-Output Routing Delay             | 0.3       | 0.4       | 0.4       | 0.5       | 0.7       | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                            |           |           |           |           |           |       |
| t <sub>CO</sub>                                    | Flip-Flop Clock-to-Output                  | 1.3       | 1.4       | 1.6       | 1.9       | 2.7       | ns    |
| t <sub>GO</sub>                                    | Latch Gate-to-Output                       | 1.3       | 1.4       | 1.6       | 1.9       | 2.7       | ns    |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Set-Up Time              | 0.3       | 0.3       | 0.4       | 0.5       | 0.7       | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Hold Time                | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>RO</sub>                                    | Flip-Flop (Latch) Reset-to-Output          | 1.6       | 1.7       | 2.0       | 2.3       | 3.2       | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up            | 0.7       | 0.8       | 0.9       | 1.0       | 1.4       | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold              | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch) Clock Active Pulse Width | 3.3       | 3.7       | 4.2       | 4.9       | 6.9       | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch) Asynchronous Pulse Width | 4.4       | 4.8       | 5.5       | 6.4       | 9.0       | ns    |
| Synchronous SRAM Operations                        |                                            |           |           |           |           |           |       |
| t <sub>RC</sub>                                    | Read Cycle Time                            | 6.8       | 7.5       | 8.5       | 10.0      | 14.0      | ns    |
| t <sub>WC</sub>                                    | Write Cycle Time                           | 6.8       | 7.5       | 8.5       | 10.0      | 14.0      | ns    |
| t <sub>RCKHL</sub>                                 | Clock HIGH/LOW Time                        | 3.4       | 3.8       | 4.3       | 5.0       | 7.0       | ns    |
| t <sub>RCO</sub>                                   | Data Valid After Clock HIGH/LOW            | 3.4       | 3.8       | 4.3       | 5.0       | 7.0       | ns    |
| t <sub>ADSU</sub>                                  | Address/Data Set-Up Time                   | 1.6       | 1.8       | 2.0       | 2.4       | 3.4       | ns    |
| Synchronous SRAM Operations (continued)            |                                            |           |           |           |           |           |       |
| t <sub>ADH</sub>                                   | Address/Data Hold Time                     | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-38 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)**  
 (Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                                 | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|---------------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                         | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| t <sub>RENSU</sub> Read Enable Set-Up                   | 0.6      |      | 0.7      |      | 0.8      |      | 0.9       |      | 1.3      |      | ns    |
| t <sub>RENH</sub> Read Enable Hold                      | 3.4      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>WENSU</sub> Write Enable Set-Up                  | 2.7      |      | 3.0      |      | 3.4      |      | 4.0       |      | 5.6      |      | ns    |
| t <sub>WENH</sub> Write Enable Hold                     | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>BENS</sub> Block Enable Set-Up                   | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>BENH</sub> Block Enable Hold                     | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| <b>Asynchronous SRAM Operations</b>                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RPD</sub> Asynchronous Access Time               |          | 8.1  |          | 9.0  |          | 10.2 |           | 12.0 |          | 16.8 | ns    |
| t <sub>RDADV</sub> Read Address Valid                   | 8.8      |      | 9.8      |      | 11.1     |      | 13.0      |      | 18.2     |      | ns    |
| t <sub>ADSU</sub> Address/Data Set-Up Time              | 1.6      |      | 1.8      |      | 2.0      |      | 2.4       |      | 3.4      |      | ns    |
| t <sub>ADH</sub> Address/Data Hold Time                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RENSUA</sub> Read Enable Set-Up to Address Valid | 0.6      |      | 0.7      |      | 0.8      |      | 0.9       |      | 1.3      |      | ns    |
| t <sub>RENHA</sub> Read Enable Hold                     | 3.4      |      | 3.8      |      | 4.3      |      | 5.0       |      | 7.0      |      | ns    |
| t <sub>WENSU</sub> Write Enable Set-Up                  | 2.7      |      | 3.0      |      | 3.4      |      | 4.0       |      | 5.6      |      | ns    |
| t <sub>WENH</sub> Write Enable Hold                     | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>DOH</sub> Data Out Hold Time                     |          | 1.2  |          | 1.3  |          | 1.5  |           | 1.8  |          | 2.5  | ns    |
| <b>Input Module Propagation Delays</b>                  |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INPY</sub> Input Data Pad-to-Y                   |          | 1.0  |          | 1.1  |          | 1.3  |           | 1.5  |          | 2.1  | ns    |
| t <sub>INGO</sub> Input Latch Gate-to-Output            |          | 1.4  |          | 1.6  |          | 1.8  |           | 2.1  |          | 2.9  | ns    |
| t <sub>INH</sub> Input Latch Hold                       | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub> Input Latch Set-Up                    | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| t <sub>ILA</sub> Latch Active Pulse Width               | 4.7      |      | 5.2      |      | 5.9      |      | 6.9       |      | 9.7      |      | ns    |
| <b>Input Module Predicted Routing Delays2</b>           |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub> FO = 1 Routing Delay                  |          | 2.0  |          | 2.2  |          | 2.5  |           | 2.9  |          | 4.1  | ns    |
| t <sub>IRD2</sub> FO = 2 Routing Delay                  |          | 2.3  |          | 2.6  |          | 2.9  |           | 3.4  |          | 4.8  | ns    |
| t <sub>IRD3</sub> FO = 3 Routing Delay                  |          | 2.6  |          | 2.9  |          | 3.3  |           | 3.9  |          | 5.5  | ns    |
| t <sub>IRD4</sub> FO = 4 Routing Delay                  |          | 3.0  |          | 3.3  |          | 3.8  |           | 4.4  |          | 6.2  | ns    |
| t <sub>IRD8</sub> FO = 8 Routing Delay                  |          | 4.3  |          | 4.8  |          | 5.5  |           | 6.4  |          | 9.0  | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-38 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description               |                                      |          | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|---------------------------------------|--------------------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                       |                                      |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Global Clock Network                  |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                      | Input LOW to HIGH                    | FO = 32  | 2.7      | 3.0  | 3.4      | 4.0  | 5.6      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 3.0      | 3.3  | 3.8      | 4.4  | 6.2      | ns   |           |      |          |      |       |
| t <sub>CKL</sub>                      | Input HIGH to LOW                    | FO = 32  | 3.8      | 4.2  | 4.8      | 5.6  | 7.8      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 4.9      | 5.4  | 6.1      | 7.2  | 10.1     | ns   |           |      |          |      |       |
| t <sub>PWH</sub>                      | Minimum Pulse Width HIGH             | FO = 32  | 1.8      | 2.0  | 2.2      | 2.6  | 3.6      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 2.0      | 2.2  | 2.5      | 2.9  | 4.1      | ns   |           |      |          |      |       |
| t <sub>PWL</sub>                      | Minimum Pulse Width LOW              | FO = 32  | 1.8      | 2.0  | 2.2      | 2.6  | 3.6      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 2.0      | 2.2  | 2.5      | 2.9  | 4.1      | ns   |           |      |          |      |       |
| t <sub>CKSW</sub>                     | Maximum Skew                         | FO = 32  | 0.8      | 0.8  | 0.9      | 1.0  | 1.4      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 0.8      | 0.8  | 0.9      | 1.0  | 1.4      | ns   |           |      |          |      |       |
| t <sub>SUEXT</sub>                    | Input Latch External Set-Up          | FO = 32  | 0.0      | 0.0  | 0.0      | 0.0  | 0.0      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 0.0      | 0.0  | 0.0      | 0.0  | 0.0      | ns   |           |      |          |      |       |
| t <sub>HEXT</sub>                     | Input Latch External Hold            | FO = 32  | 2.8      | 3.2  | 3.6      | 4.2  | 5.9      | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 3.3      | 3.7  | 4.2      | 4.9  | 6.9      | ns   |           |      |          |      |       |
| t <sub>P</sub>                        | Minimum Period (1/f <sub>MAX</sub> ) | FO = 32  | 5.5      | 6.1  | 6.6      | 7.6  | 12.7     | ns   |           |      |          |      |       |
|                                       |                                      | FO = 635 | 6.0      | 6.6  | 7.2      | 8.3  | 13.8     | ns   |           |      |          |      |       |
| f <sub>MAX</sub>                      | Maximum Datapath Frequency           | FO = 32  | 180      | 164  | 151      | 131  | 79       | MHz  |           |      |          |      |       |
|                                       |                                      | FO = 635 | 166      | 151  | 139      | 121  | 73       | MHz  |           |      |          |      |       |
| TTL Output Module Timing <sup>5</sup> |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                      | Data-to-Pad HIGH                     |          | 2.6      | 2.8  | 3.2      | 3.8  | 5.3      | ns   |           |      |          |      |       |
| t <sub>DHL</sub>                      | Data-to-Pad LOW                      |          | 3.0      | 3.3  | 3.7      | 4.4  | 6.2      | ns   |           |      |          |      |       |
| t <sub>ENZH</sub>                     | Enable Pad Z to HIGH                 |          | 2.7      | 3.0  | 3.3      | 3.9  | 5.5      | ns   |           |      |          |      |       |
| t <sub>ENZL</sub>                     | Enable Pad Z to LOW                  |          | 3.0      | 3.3  | 3.7      | 4.3  | 6.1      | ns   |           |      |          |      |       |
| t <sub>ENHZ</sub>                     | Enable Pad HIGH to Z                 |          | 5.3      | 5.8  | 6.6      | 7.8  | 10.9     | ns   |           |      |          |      |       |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-38 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)**  
**(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                           |                                                 | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|---------------------------------------------------|-------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                                   |                                                 | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| TTL Output Module Timing <sup>5</sup> (Continued) |                                                 |           |           |           |           |           |       |
| t <sub>ENLZ</sub>                                 | Enable Pad LOW to Z                             | 4.9       | 5.5       | 6.2       | 7.3       | 10.2      | ns    |
| t <sub>GLH</sub>                                  | G-to-Pad HIGH                                   | 2.9       | 3.3       | 3.7       | 4.4       | 6.1       | ns    |
| t <sub>GHL</sub>                                  | G-to-Pad LOW                                    | 2.9       | 3.3       | 3.7       | 4.4       | 6.1       | ns    |
| t <sub>LSU</sub>                                  | I/O Latch Output Set-Up                         | 0.5       | 0.5       | 0.6       | 0.7       | 1.0       | ns    |
| t <sub>LH</sub>                                   | I/O Latch Output Hold                           | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                                  | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   | 5.7       | 6.3       | 7.1       | 8.4       | 11.8      | ns    |
| t <sub>ACO</sub>                                  | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O | 7.8       | 8.6       | 9.8       | 11.5      | 16.1      | ns    |
| d <sub>TLH</sub>                                  | Capacitive Loading,<br>LOW to HIGH              | 0.07      | 0.08      | 0.09      | 0.10      | 0.14      | ns/pF |
| d <sub>THL</sub>                                  | Capacitive Loading,<br>HIGH to LOW              | 0.07      | 0.08      | 0.09      | 0.10      | 0.14      | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-38 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)**  
(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                                                 | –3 Speed  | –2 Speed  | –1 Speed  | Std Speed | –F Speed  | Units |
|----------------------------------------|-------------------------------------------------|-----------|-----------|-----------|-----------|-----------|-------|
|                                        |                                                 | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |       |
| CMOS Output Module Timing <sup>5</sup> |                                                 |           |           |           |           |           |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                | 3.5       | 3.9       | 4.5       | 5.2       | 7.3       | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                 | 2.5       | 2.7       | 3.1       | 3.6       | 5.1       | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                            | 2.7       | 3.0       | 3.3       | 3.9       | 5.5       | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                             | 2.9       | 3.3       | 3.7       | 4.3       | 6.1       | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                            | 5.3       | 5.8       | 6.6       | 7.8       | 10.9      | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                             | 4.9       | 5.5       | 6.2       | 7.3       | 10.2      | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                   | 5.0       | 5.6       | 6.3       | 7.5       | 10.4      | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                    | 5.0       | 5.6       | 6.3       | 7.5       | 10.4      | ns    |
| t <sub>LSU</sub>                       | I/O Latch Set-Up                                | 0.5       | 0.5       | 0.6       | 0.7       | 1.0       | ns    |
| t <sub>LH</sub>                        | I/O Latch Hold                                  | 0.0       | 0.0       | 0.0       | 0.0       | 0.0       | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   | 5.7       | 6.3       | 7.1       | 8.4       | 11.8      | ns    |
| t <sub>ACO</sub>                       | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O | 7.8       | 8.6       | 9.8       | 11.5      | 16.1      | ns    |
| d <sub>TLH</sub>                       | Capacitive Loading,<br>LOW to HIGH              | 0.07      | 0.08      | 0.09      | 0.10      | 0.14      | ns/pF |
| d <sub>THL</sub>                       | Capacitive Loading,<br>HIGH to LOW              | 0.07      | 0.08      | 0.09      | 0.10      | 0.14      | ns/pF |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-39 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                            |                                               | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------------------|-----------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                                    |                                               | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Logic Module Combinatorial Functions <sup>1</sup>  |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>PD</sub>                                    | Internal Array Module Delay                   | 1.9      |      | 2.1      |      | 2.3      |      | 2.7       |      | 3.8      |      | ns    |
| t <sub>PDD</sub>                                   | Internal Decode Module Delay                  | 2.2      |      | 2.5      |      | 2.8      |      | 3.3       |      | 4.7      |      | ns    |
| Logic Module Predicted Routing Delays <sup>2</sup> |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RD1</sub>                                   | FO = 1 Routing Delay                          | 1.3      |      | 1.5      |      | 1.7      |      | 2.0       |      | 2.7      |      | ns    |
| t <sub>RD2</sub>                                   | FO = 2 Routing Delay                          | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>RD3</sub>                                   | FO = 3 Routing Delay                          | 2.3      |      | 2.5      |      | 2.8      |      | 3.4       |      | 4.7      |      | ns    |
| t <sub>RD4</sub>                                   | FO = 4 Routing Delay                          | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>RD5</sub>                                   | FO = 8 Routing Delay                          | 4.6      |      | 5.2      |      | 5.8      |      | 6.9       |      | 9.6      |      | ns    |
| t <sub>RDD</sub>                                   | Decode-to-Output Routing Delay                | 0.5      |      | 0.5      |      | 0.6      |      | 0.7       |      | 1.0      |      | ns    |
| Logic Module Sequential Timing <sup>3, 4</sup>     |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CO</sub>                                    | Flip-Flop Clock-to-Output                     | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>GO</sub>                                    | Latch Gate-to-Output                          | 1.8      |      | 2.0      |      | 2.3      |      | 2.7       |      | 3.7      |      | ns    |
| t <sub>SUD</sub>                                   | Flip-Flop (Latch) Set-Up Time                 | 0.4      |      | 0.5      |      | 0.6      |      | 0.7       |      | 0.9      |      | ns    |
| t <sub>HD</sub>                                    | Flip-Flop (Latch) Hold Time                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RO</sub>                                    | Flip-Flop (Latch) Reset-to-Output             | 2.2      |      | 2.4      |      | 2.7      |      | 3.2       |      | 4.5      |      | ns    |
| t <sub>SUENA</sub>                                 | Flip-Flop (Latch) Enable Set-Up               | 1.0      |      | 1.1      |      | 1.2      |      | 1.4       |      | 2.0      |      | ns    |
| t <sub>HENA</sub>                                  | Flip-Flop (Latch) Enable Hold                 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>WCLKA</sub>                                 | Flip-Flop (Latch)<br>Clock Active Pulse Width | 4.6      |      | 5.2      |      | 5.8      |      | 6.9       |      | 9.6      |      | ns    |
| t <sub>WASYN</sub>                                 | Flip-Flop (Latch)<br>Asynchronous Pulse Width | 6.1      |      | 6.8      |      | 7.7      |      | 9.0       |      | 12.6     |      | ns    |
| Synchronous SRAM Operations                        |                                               |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RC</sub>                                    | Read Cycle Time                               | 9.5      |      | 10.5     |      | 11.9     |      | 14.0      |      | 19.6     |      | ns    |
| t <sub>WC</sub>                                    | Write Cycle Time                              | 9.5      |      | 10.5     |      | 11.9     |      | 14.0      |      | 19.6     |      | ns    |
| t <sub>RCKHL</sub>                                 | Clock HIGH/LOW Time                           | 4.8      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>RCO</sub>                                   | Data Valid After Clock HIGH/LOW               | 4.8      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>ADSU</sub>                                  | Address/Data Set-Up Time                      | 2.3      |      | 2.5      |      | 2.8      |      | 3.4       |      | 4.8      |      | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-39 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                 |                                     | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|-----------------------------------------|-------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                         |                                     | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Synchronous SRAM Operations (continued) |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>ADH</sub>                        | Address/Data Hold Time              | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RENSU</sub>                      | Read Enable Set-Up                  | 0.9      |      | 1.0      |      | 1.1      |      | 1.3       |      | 1.8      |      | ns    |
| t <sub>RENH</sub>                       | Read Enable Hold                    | 4.8      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>WENSU</sub>                      | Write Enable Set-Up                 | 3.8      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>WENH</sub>                       | Write Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>BENS</sub>                       | Block Enable Set-Up                 | 3.9      |      | 4.3      |      | 4.9      |      | 5.7       |      | 8.0      |      | ns    |
| t <sub>BENH</sub>                       | Block Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| Asynchronous SRAM Operations            |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>RPD</sub>                        | Asynchronous Access Time            |          | 11.3 |          | 12.6 |          | 14.3 |           | 16.8 |          | 23.5 | ns    |
| t <sub>RDADV</sub>                      | Read Address Valid                  | 12.3     |      | 13.7     |      | 15.5     |      | 18.2      |      | 25.5     |      | ns    |
| t <sub>ADSU</sub>                       | Address/Data Set-Up Time            | 2.3      |      | 2.5      |      | 2.8      |      | 3.4       |      | 4.8      |      | ns    |
| t <sub>ADH</sub>                        | Address/Data Hold Time              | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>RENSUA</sub>                     | Read Enable Set-Up to Address Valid | 0.9      |      | 1.0      |      | 1.1      |      | 1.3       |      | 1.8      |      | ns    |
| t <sub>RENHA</sub>                      | Read Enable Hold                    | 4.8      |      | 5.3      |      | 6.0      |      | 7.0       |      | 9.8      |      | ns    |
| t <sub>WENSU</sub>                      | Write Enable Set-Up                 | 3.8      |      | 4.2      |      | 4.8      |      | 5.6       |      | 7.8      |      | ns    |
| t <sub>WENH</sub>                       | Write Enable Hold                   | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>DOH</sub>                        | Data Out Hold Time                  |          | 1.8  |          | 2.0  |          | 2.1  |           | 2.5  |          | 3.5  | ns    |
| Input Module Propagation Delays         |                                     |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>INPY</sub>                       | Input Data Pad-to-Y                 |          | 1.4  |          | 1.6  |          | 1.8  |           | 2.1  |          | 3.0  | ns    |
| t <sub>INGO</sub>                       | Input Latch Gate-to-Output          |          | 2.0  |          | 2.2  |          | 2.5  |           | 2.9  |          | 4.1  | ns    |
| t <sub>INH</sub>                        | Input Latch Hold                    | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>INSU</sub>                       | Input Latch Set-Up                  | 0.7      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.4      |      | ns    |
| t <sub>ILA</sub>                        | Latch Active Pulse Width            | 6.5      |      | 7.3      |      | 8.2      |      | 9.7       |      | 13.5     |      | ns    |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-39 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

| Parameter / Description                |                                      |          | -3 Speed |      | -2 Speed |      | -1 Speed |      | Std Speed |      | -F Speed |      | Units |
|----------------------------------------|--------------------------------------|----------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                                      |          | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| Input Module Predicted Routing Delays2 |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>IRD1</sub>                      | FO = 1 Routing Delay                 |          | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>IRD2</sub>                      | FO = 2 Routing Delay                 |          | 3.2      |      | 3.5      |      | 4.1      |      | 4.8       |      | 6.7      |      | ns    |
| t <sub>IRD3</sub>                      | FO = 3 Routing Delay                 |          | 3.7      |      | 4.1      |      | 4.7      |      | 5.5       |      | 7.7      |      | ns    |
| t <sub>IRD4</sub>                      | FO = 4 Routing Delay                 |          | 4.2      |      | 4.6      |      | 5.3      |      | 6.2       |      | 8.7      |      | ns    |
| t <sub>IRD8</sub>                      | FO = 8 Routing Delay                 |          | 6.1      |      | 6.8      |      | 7.7      |      | 9.0       |      | 12.6     |      | ns    |
| Global Clock Network                   |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>CKH</sub>                       | Input LOW to HIGH                    | FO = 32  | 4.6      |      | 5.1      |      | 5.7      |      | 6.7       |      | 9.3      |      | ns    |
|                                        |                                      | FO = 635 | 5.0      |      | 5.6      |      | 6.3      |      | 7.4       |      | 10.3     |      | ns    |
| t <sub>CKL</sub>                       | Input HIGH to LOW                    | FO = 32  | 5.3      |      | 5.9      |      | 6.7      |      | 7.8       |      | 11.0     |      | ns    |
|                                        |                                      | FO = 635 | 6.8      |      | 7.6      |      | 8.6      |      | 10.1      |      | 14.1     |      | ns    |
| t <sub>PWH</sub>                       | Minimum Pulse Width HIGH             | FO = 32  | 2.5      |      | 2.7      |      | 3.1      |      | 3.6       |      | 5.1      |      | ns    |
|                                        |                                      | FO = 635 | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>PWL</sub>                       | Minimum Pulse Width LOW              | FO = 32  | 2.5      |      | 2.7      |      | 3.1      |      | 3.6       |      | 5.1      |      | ns    |
|                                        |                                      | FO = 635 | 2.8      |      | 3.1      |      | 3.5      |      | 4.1       |      | 5.7      |      | ns    |
| t <sub>CKSW</sub>                      | Maximum Skew                         | FO = 32  | 1.0      |      | 1.2      |      | 1.3      |      | 1.5       |      | 2.2      |      | ns    |
|                                        |                                      | FO = 635 | 1.0      |      | 1.2      |      | 1.3      |      | 1.5       |      | 2.2      |      | ns    |
| t <sub>SUEXT</sub>                     | Input Latch External Set-Up          | FO = 32  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
|                                        |                                      | FO = 635 | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>HEXT</sub>                      | Input Latch External Hold            | FO = 32  | 4.0      |      | 4.4      |      | 5.0      |      | 5.9       |      | 8.2      |      | ns    |
|                                        |                                      | FO = 635 | 4.6      |      | 5.2      |      | 5.9      |      | 6.9       |      | 9.6      |      | ns    |
| t <sub>P</sub>                         | Minimum Period (1/f <sub>MAX</sub> ) | FO = 32  | 9.2      |      | 10.2     |      | 11.1     |      | 12.7      |      | 21.2     |      | ns    |
|                                        |                                      | FO = 635 | 9.9      |      | 11.0     |      | 12.0     |      | 13.8      |      | 23.0     |      | ns    |
| f <sub>MAX</sub>                       | Maximum Datapath Frequency           | FO = 32  | 108      |      | 98       |      | 90       |      | 79        |      | 47       |      | MHz   |
|                                        |                                      | FO = 635 | 100      |      | 91       |      | 83       |      | 73        |      | 44       |      | MHz   |
| TTL Output Module Timing5              |                                      |          |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                     |          | 3.6      |      | 4.0      |      | 4.5      |      | 5.3       |      | 7.4      |      | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                      |          | 4.2      |      | 4.6      |      | 5.2      |      | 6.2       |      | 8.6      |      | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                 |          | 3.7      |      | 4.2      |      | 4.7      |      | 5.5       |      | 7.7      |      | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                  |          | 4.1      |      | 4.6      |      | 5.2      |      | 6.1       |      | 8.5      |      | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                 |          | 7.34     |      | 8.2      |      | 9.3      |      | 10.9      |      | 15.3     |      | ns    |

**Notes:**

1. For dual-module macros, use  $t_{PD1} + t_{RD1} + t_{PDn}$ ,  $t_{CO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

**Table 1-39 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation) (continued)**  
(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)

| Parameter / Description                |                                                 | –3 Speed |      | –2 Speed |      | –1 Speed |      | Std Speed |      | –F Speed |      | Units |
|----------------------------------------|-------------------------------------------------|----------|------|----------|------|----------|------|-----------|------|----------|------|-------|
|                                        |                                                 | Min.     | Max. | Min.     | Max. | Min.     | Max. | Min.      | Max. | Min.     | Max. |       |
| TTL Output Module Timing <sup>5</sup>  |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                             |          | 6.9  |          | 7.6  |          | 8.7  |           | 10.2 |          | 14.3 | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                   |          | 4.9  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                    |          | 4.9  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.2 | ns    |
| t <sub>LSU</sub>                       | I/O Latch Output Set-Up                         | 0.7      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.4      |      | ns    |
| t <sub>LH</sub>                        | I/O Latch Output Hold                           | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   |          | 7.9  |          | 8.8  |          | 10.0 |           | 11.8 |          | 16.5 | ns    |
| t <sub>ACO</sub>                       | Array Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O |          | 10.9 |          | 12.1 |          | 13.7 |           | 16.1 |          | 22.5 | ns    |
| d <sub>TLH</sub>                       | Capacitive Loading, LOW to HIGH                 |          | 0.10 |          | 0.11 |          | 0.12 |           | 0.14 |          | 0.20 | ns/pF |
| d <sub>THL</sub>                       | Capacitive Loading, HIGH to LOW                 |          | 0.10 |          | 0.11 |          | 0.12 |           | 0.14 |          | 0.20 | ns/pF |
| CMOS Output Module Timing <sup>5</sup> |                                                 |          |      |          |      |          |      |           |      |          |      |       |
| t <sub>DLH</sub>                       | Data-to-Pad HIGH                                |          | 4.9  |          | 5.5  |          | 6.2  |           | 7.3  |          | 10.3 | ns    |
| t <sub>DHL</sub>                       | Data-to-Pad LOW                                 |          | 3.4  |          | 3.8  |          | 4.3  |           | 5.1  |          | 7.1  | ns    |
| t <sub>ENZH</sub>                      | Enable Pad Z to HIGH                            |          | 3.7  |          | 4.1  |          | 4.7  |           | 5.5  |          | 7.7  | ns    |
| t <sub>ENZL</sub>                      | Enable Pad Z to LOW                             |          | 4.1  |          | 4.6  |          | 5.2  |           | 6.1  |          | 8.5  | ns    |
| t <sub>ENHZ</sub>                      | Enable Pad HIGH to Z                            |          | 7.4  |          | 8.2  |          | 9.3  |           | 10.9 |          | 15.3 | ns    |
| t <sub>ENLZ</sub>                      | Enable Pad LOW to Z                             |          | 6.9  |          | 7.6  |          | 8.7  |           | 10.2 |          | 14.3 | ns    |
| t <sub>GLH</sub>                       | G-to-Pad HIGH                                   |          | 7.0  |          | 7.8  |          | 8.9  |           | 10.4 |          | 14.6 | ns    |
| t <sub>GHL</sub>                       | G-to-Pad LOW                                    |          | 7.0  |          | 7.8  |          | 8.9  |           | 10.4 |          | 14.6 | ns    |
| t <sub>LSU</sub>                       | I/O Latch Set-Up                                | 0.7      |      | 0.7      |      | 0.8      |      | 1.0       |      | 1.4      |      | ns    |
| t <sub>LH</sub>                        | I/O Latch Hold                                  | 0.0      |      | 0.0      |      | 0.0      |      | 0.0       |      | 0.0      |      | ns    |
| t <sub>LCO</sub>                       | I/O Latch Clock-to-Out<br>(Pad-to-Pad) 32 I/O   |          | 7.9  |          | 8.8  |          | 10.0 |           | 11.8 |          | 16.5 | ns    |

**Notes:**

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the Input Buffer Latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading.

## Pin Descriptions

### CLK/A/B, I/O      Global Clock

Clock inputs for clock distribution networks. CLK is for 40MX while CLKA and CLKB are for 42MX devices. The clock input is buffered prior to clocking the logic modules. This pin can also be used as an I/O.

### DCLK, I/O      Diagnostic Clock

Clock input for diagnostic probe and device programming. DCLK is active when the MODE pin is HIGH. This pin functions as an I/O when the MODE pin is LOW.

### GND      Ground

Input LOW supply voltage.

### I/O      Input/Output

Input, output, tristate or bidirectional buffer. Input and output levels are compatible with standard TTL and CMOS specifications. Unused I/Os pins are configured by the Designer software as shown in [Table 1-40](#).

**Table 1-40 • Configuration of Unused I/Os**

| Device           | Configuration |
|------------------|---------------|
| A40MX02, A40MX04 | Pulled LOW    |
| A42MX09, A42MX16 | Pulled LOW    |
| A42MX24, A42MX36 | Tristated     |

In all cases, it is recommended to tie all unused MX I/O pins to LOW on the board. This applies to all dual-purpose pins when configured as I/Os as well.

### LP      Low Power Mode

Controls the low power mode of all 42MX devices. The device is placed in the low power mode by connecting the LP pin to logic HIGH. In low power mode, all I/Os are tristated, all input buffers are turned OFF, and the core of the device is turned OFF. To exit the low power mode, the LP pin must be set LOW. The device enters the low power mode 800 ns after the LP pin is driven to a logic HIGH. It will resume normal operation in 200  $\mu$ s after the LP pin is driven to a logic LOW.

### MODE      Mode

Controls the use of multifunction pins (DCLK, PRA, PRB, SDI, TDO). The MODE pin is held HIGH to provide verification capability. The MODE pin should be terminated to GND through a 10k $\Omega$  resistor so that the MODE pin can be pulled HIGH when required.

### NC      No Connection

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

### PRA, I/O

### PRB, I/O      Probe A/B

The Probe pin is used to output data from any user-defined design node within the device. Each diagnostic pin can be used in conjunction with the other probe pin to allow real-time diagnostic output of any signal path within the device. The Probe pin can be used as a user-defined I/O when verification has been completed. The pin's probe capabilities can be permanently disabled to protect programmed design confidentiality. The Probe pin is accessible when the MODE pin is HIGH. This pin functions as an I/O when the MODE pin is LOW.

### QCLKA/B/C/D, I/O      Quadrant Clock

Quadrant clock inputs for A42MX36 devices. When not used as a register control signal, these pins can function as user I/Os.

**SDI, I/O                      Serial Data Input**

Serial data input for diagnostic probe and device programming. SDI is active when the MODE pin is HIGH. This pin functions as an I/O when the MODE pin is LOW.

**SDO, I/O                      Serial Data Output**

Serial data output for diagnostic probe and device programming. SDO is active when the MODE pin is HIGH. This pin functions as an I/O when the MODE pin is LOW. SDO is available for 42MX devices only.

When Silicon Explorer II is being used, SDO will act as an output while the "checksum" command is run. It will return to user I/O when "checksum" is complete.

**TCK, I/O                      Test Clock**

Clock signal to shift the Boundary Scan Test (BST) data into the device. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

**TDI, I/O                      Test Data In**

Serial data input for BST instructions and data. Data is shifted in on the rising edge of TCK. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

**TDO, I/O                      Test Data Out**

Serial data output for BST instructions and test data. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

**TMS, I/O                      Test Mode Select**

The TMS pin controls the use of the IEEE 1149.1 Boundary Scan pins (TCK, TDI, TDO). In flexible mode when the TMS pin is set LOW, the TCK, TDI and TDO pins are boundary scan pins. Once the boundary scan pins are in test mode, they will remain in that mode until the internal boundary scan state machine reaches the "logic reset" state. At this point, the boundary scan pins will be released and will function as regular I/O pins. The "logic reset" state is reached 5 TCK cycles after the TMS pin is set HIGH. In dedicated test mode, TMS functions as specified in the IEEE 1149.1 specifications. IEEE JTAG specification recommends a 10k $\Omega$  pull-up resistor on the pin. BST pins are only available in A42MX24 and A42MX36 devices.

**VCC                              Supply Voltage**

Input supply voltage for 40MX devices

**VCCA                            Supply Voltage**

Supply voltage for array in 42MX devices

**VCCI                            Supply Voltage**

Supply voltage for I/Os in 42MX devices

**WD, I/O                      Wide Decode Output**

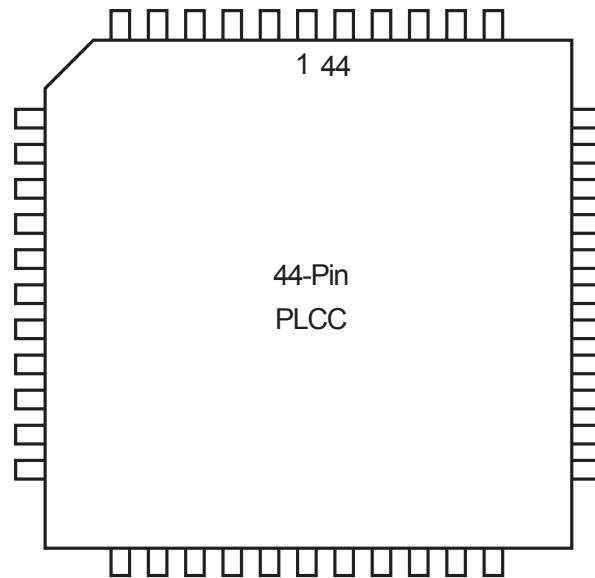
When a wide decode module is used in a 42MX device this pin can be used as a dedicated output from the wide decode module. This direct connection eliminates additional interconnect delays associated with regular logic modules. To implement the direct I/O connection, connect an output buffer of any type to the output of the wide decode macro and place this output on one of the reserved WD pins.

## 2 – Package Pin Assignments

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### PL44

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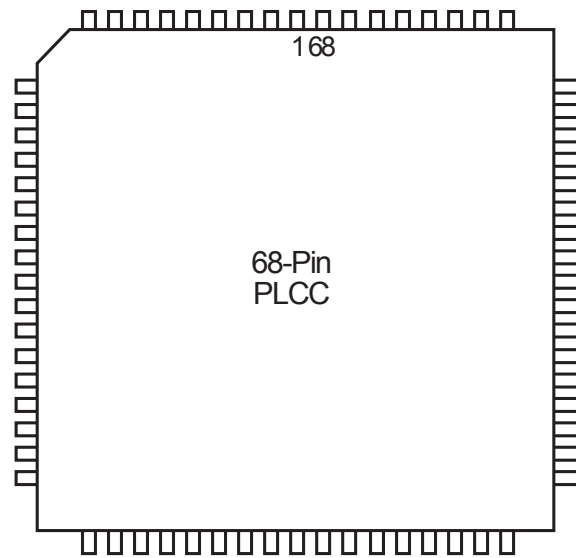


| PL44       |                  |                  |
|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function |
| 1          | I/O              | I/O              |
| 2          | I/O              | I/O              |
| 3          | VCC              | VCC              |
| 4          | I/O              | I/O              |
| 5          | I/O              | I/O              |
| 6          | I/O              | I/O              |
| 7          | I/O              | I/O              |
| 8          | I/O              | I/O              |
| 9          | I/O              | I/O              |
| 10         | GND              | GND              |
| 11         | I/O              | I/O              |
| 12         | I/O              | I/O              |
| 13         | I/O              | I/O              |
| 14         | VCC              | VCC              |
| 15         | I/O              | I/O              |
| 16         | VCC              | VCC              |
| 17         | I/O              | I/O              |
| 18         | I/O              | I/O              |
| 19         | I/O              | I/O              |
| 20         | I/O              | I/O              |
| 21         | GND              | GND              |
| 22         | I/O              | I/O              |
| 23         | I/O              | I/O              |
| 24         | I/O              | I/O              |
| 25         | VCC              | VCC              |
| 26         | I/O              | I/O              |
| 27         | I/O              | I/O              |
| 28         | I/O              | I/O              |
| 29         | I/O              | I/O              |
| 30         | I/O              | I/O              |
| 31         | I/O              | I/O              |
| 32         | GND              | GND              |
| 33         | CLK, I/O         | CLK, I/O         |
| 34         | MODE             | MODE             |
| 35         | VCC              | VCC              |
| 36         | SDI, I/O         | SDI, I/O         |

| PL44       |                  |                  |
|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function |
| 37         | DCLK, I/O        | DCLK, I/O        |
| 38         | PRA, I/O         | PRA, I/O         |
| 39         | PRB, I/O         | PRB, I/O         |
| 40         | I/O              | I/O              |
| 41         | I/O              | I/O              |
| 42         | I/O              | I/O              |
| 43         | GND              | GND              |
| 44         | I/O              | I/O              |

## PL68

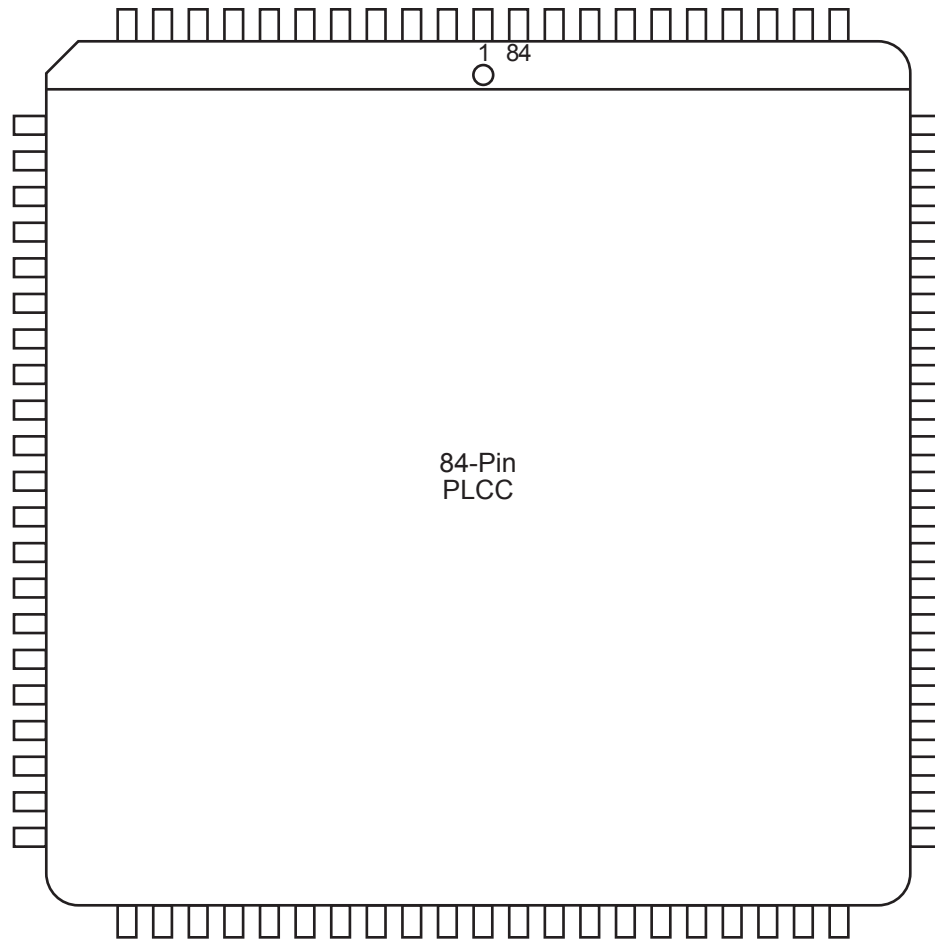
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| PL68       |                  |                  |
|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function |
| 1          | I/O              | I/O              |
| 2          | I/O              | I/O              |
| 3          | I/O              | I/O              |
| 4          | VCC              | VCC              |
| 5          | I/O              | I/O              |
| 6          | I/O              | I/O              |
| 7          | I/O              | I/O              |
| 8          | I/O              | I/O              |
| 9          | I/O              | I/O              |
| 10         | I/O              | I/O              |
| 11         | I/O              | I/O              |
| 12         | I/O              | I/O              |
| 13         | I/O              | I/O              |
| 14         | GND              | GND              |
| 15         | GND              | GND              |
| 16         | I/O              | I/O              |
| 17         | I/O              | I/O              |
| 18         | I/O              | I/O              |
| 19         | I/O              | I/O              |
| 20         | I/O              | I/O              |
| 21         | VCC              | VCC              |
| 22         | I/O              | I/O              |
| 23         | I/O              | I/O              |
| 24         | I/O              | I/O              |
| 25         | VCC              | VCC              |
| 26         | I/O              | I/O              |
| 27         | I/O              | I/O              |
| 28         | I/O              | I/O              |
| 29         | I/O              | I/O              |
| 30         | I/O              | I/O              |
| 31         | I/O              | I/O              |
| 32         | GND              | GND              |
| 33         | I/O              | I/O              |
| 34         | I/O              | I/O              |
| 35         | I/O              | I/O              |

| PL68       |                  |                  |
|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function |
| 36         | I/O              | I/O              |
| 37         | I/O              | I/O              |
| 38         | VCC              | VCC              |
| 39         | I/O              | I/O              |
| 40         | I/O              | I/O              |
| 41         | I/O              | I/O              |
| 42         | I/O              | I/O              |
| 43         | I/O              | I/O              |
| 44         | I/O              | I/O              |
| 45         | I/O              | I/O              |
| 46         | I/O              | I/O              |
| 47         | I/O              | I/O              |
| 48         | I/O              | I/O              |
| 49         | GND              | GND              |
| 50         | I/O              | I/O              |
| 51         | I/O              | I/O              |
| 52         | CLK, I/O         | CLK, I/O         |
| 53         | I/O              | I/O              |
| 54         | MODE             | MODE             |
| 55         | VCC              | VCC              |
| 56         | SDI, I/O         | SDI, I/O         |
| 57         | DCLK, I/O        | DCLK, I/O        |
| 58         | PRA, I/O         | PRA, I/O         |
| 59         | PRB, I/O         | PRB, I/O         |
| 60         | I/O              | I/O              |
| 61         | I/O              | I/O              |
| 62         | I/O              | I/O              |
| 63         | I/O              | I/O              |
| 64         | I/O              | I/O              |
| 65         | I/O              | I/O              |
| 66         | GND              | GND              |
| 67         | I/O              | I/O              |
| 68         | I/O              | I/O              |

## PL84



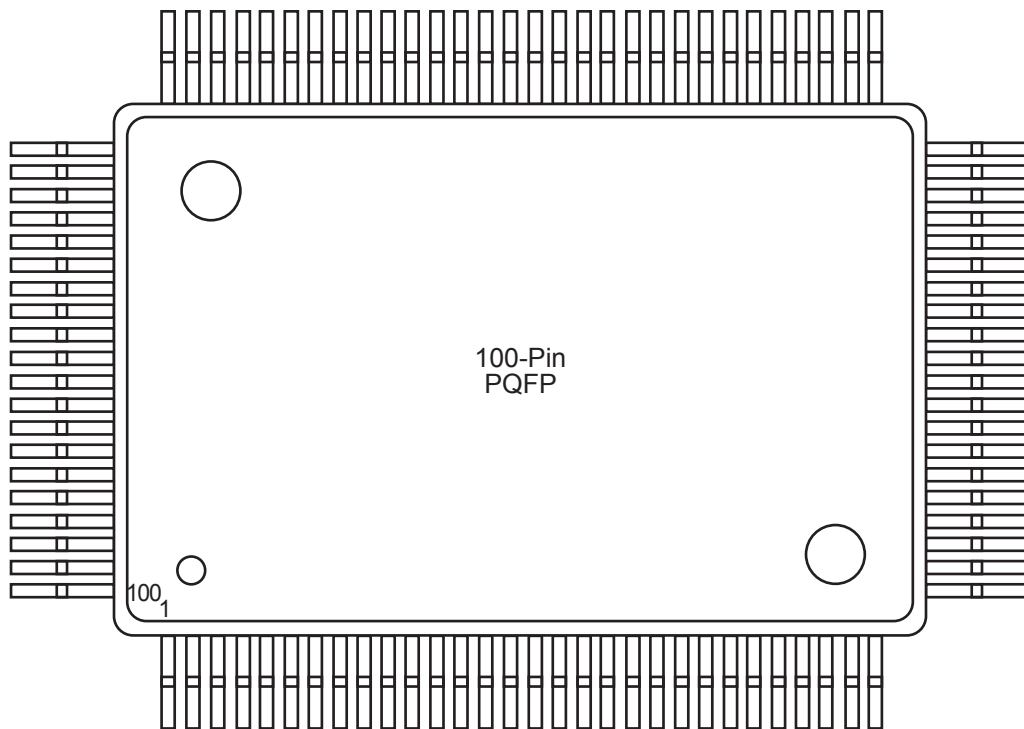
| PL84       |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX04 Function | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 1          | I/O              | I/O              | I/O              | I/O              |
| 2          | I/O              | CLKB, I/O        | CLKB, I/O        | CLKB, I/O        |
| 3          | I/O              | I/O              | I/O              | I/O              |
| 4          | VCC              | PRB, I/O         | PRB, I/O         | PRB, I/O         |
| 5          | I/O              | I/O              | I/O              | WD, I/O          |
| 6          | I/O              | GND              | GND              | GND              |
| 7          | I/O              | I/O              | I/O              | I/O              |
| 8          | I/O              | I/O              | I/O              | WD, I/O          |
| 9          | I/O              | I/O              | I/O              | WD, I/O          |
| 10         | I/O              | DCLK, I/O        | DCLK, I/O        | DCLK, I/O        |
| 11         | I/O              | I/O              | I/O              | I/O              |
| 12         | NC               | MODE             | MODE             | MODE             |
| 13         | I/O              | I/O              | I/O              | I/O              |
| 14         | I/O              | I/O              | I/O              | I/O              |
| 15         | I/O              | I/O              | I/O              | I/O              |
| 16         | I/O              | I/O              | I/O              | I/O              |
| 17         | I/O              | I/O              | I/O              | I/O              |
| 18         | GND              | I/O              | I/O              | I/O              |
| 19         | GND              | I/O              | I/O              | I/O              |
| 20         | I/O              | I/O              | I/O              | I/O              |
| 21         | I/O              | I/O              | I/O              | I/O              |
| 22         | I/O              | VCCA             | VCCI             | VCCI             |
| 23         | I/O              | VCCI             | VCCA             | VCCA             |
| 24         | I/O              | I/O              | I/O              | I/O              |
| 25         | VCC              | I/O              | I/O              | I/O              |
| 26         | VCC              | I/O              | I/O              | I/O              |
| 27         | I/O              | I/O              | I/O              | I/O              |
| 28         | I/O              | GND              | GND              | GND              |
| 29         | I/O              | I/O              | I/O              | I/O              |
| 30         | I/O              | I/O              | I/O              | I/O              |
| 31         | I/O              | I/O              | I/O              | I/O              |
| 32         | I/O              | I/O              | I/O              | I/O              |
| 33         | VCC              | I/O              | I/O              | I/O              |
| 34         | I/O              | I/O              | I/O              | TMS, I/O         |
| 35         | I/O              | I/O              | I/O              | TDI, I/O         |
| 36         | I/O              | I/O              | I/O              | WD, I/O          |

| PL84       |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX04 Function | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 37         | I/O              | I/O              | I/O              | I/O              |
| 38         | I/O              | I/O              | I/O              | WD, I/O          |
| 39         | I/O              | I/O              | I/O              | WD, I/O          |
| 40         | GND              | I/O              | I/O              | I/O              |
| 41         | I/O              | I/O              | I/O              | I/O              |
| 42         | I/O              | I/O              | I/O              | I/O              |
| 43         | I/O              | VCCA             | VCCA             | VCCA             |
| 44         | I/O              | I/O              | I/O              | WD, I/O          |
| 45         | I/O              | I/O              | I/O              | WD, I/O          |
| 46         | VCC              | I/O              | I/O              | WD, I/O          |
| 47         | I/O              | I/O              | I/O              | WD, I/O          |
| 48         | I/O              | I/O              | I/O              | I/O              |
| 49         | I/O              | GND              | GND              | GND              |
| 50         | I/O              | I/O              | I/O              | WD, I/O          |
| 51         | I/O              | I/O              | I/O              | WD, I/O          |
| 52         | I/O              | SDO, I/O         | SDO, I/O         | SDO, TDO, I/O    |
| 53         | I/O              | I/O              | I/O              | I/O              |
| 54         | I/O              | I/O              | I/O              | I/O              |
| 55         | I/O              | I/O              | I/O              | I/O              |
| 56         | I/O              | I/O              | I/O              | I/O              |
| 57         | I/O              | I/O              | I/O              | I/O              |
| 58         | I/O              | I/O              | I/O              | I/O              |
| 59         | I/O              | I/O              | I/O              | I/O              |
| 60         | GND              | I/O              | I/O              | I/O              |
| 61         | GND              | I/O              | I/O              | I/O              |
| 62         | I/O              | I/O              | I/O              | TCK, I/O         |
| 63         | I/O              | LP               | LP               | LP               |
| 64         | CLK, I/O         | VCCA             | VCCA             | VCCA             |
| 65         | I/O              | VCCI             | VCCI             | VCCI             |
| 66         | MODE             | I/O              | I/O              | I/O              |
| 67         | VCC              | I/O              | I/O              | I/O              |
| 68         | VCC              | I/O              | I/O              | I/O              |
| 69         | I/O              | I/O              | I/O              | I/O              |
| 70         | I/O              | GND              | GND              | GND              |
| 71         | I/O              | I/O              | I/O              | I/O              |
| 72         | SDI, I/O         | I/O              | I/O              | I/O              |

| PL84       |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX04 Function | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 73         | DCLK, I/O        | I/O              | I/O              | I/O              |
| 74         | PRA, I/O         | I/O              | I/O              | I/O              |
| 75         | PRB, I/O         | I/O              | I/O              | I/O              |
| 76         | I/O              | SDI, I/O         | SDI, I/O         | SDI, I/O         |
| 77         | I/O              | I/O              | I/O              | I/O              |
| 78         | I/O              | I/O              | I/O              | WD, I/O          |
| 79         | I/O              | I/O              | I/O              | WD, I/O          |
| 80         | I/O              | I/O              | I/O              | WD, I/O          |
| 81         | I/O              | PRA, I/O         | PRA, I/O         | PRA, I/O         |
| 82         | GND              | I/O              | I/O              | I/O              |
| 83         | I/O              | CLKA, I/O        | CLKA, I/O        | CLKA, I/O        |
| 84         | I/O              | VCCA             | VCCA             | VCCA             |

## PQ100

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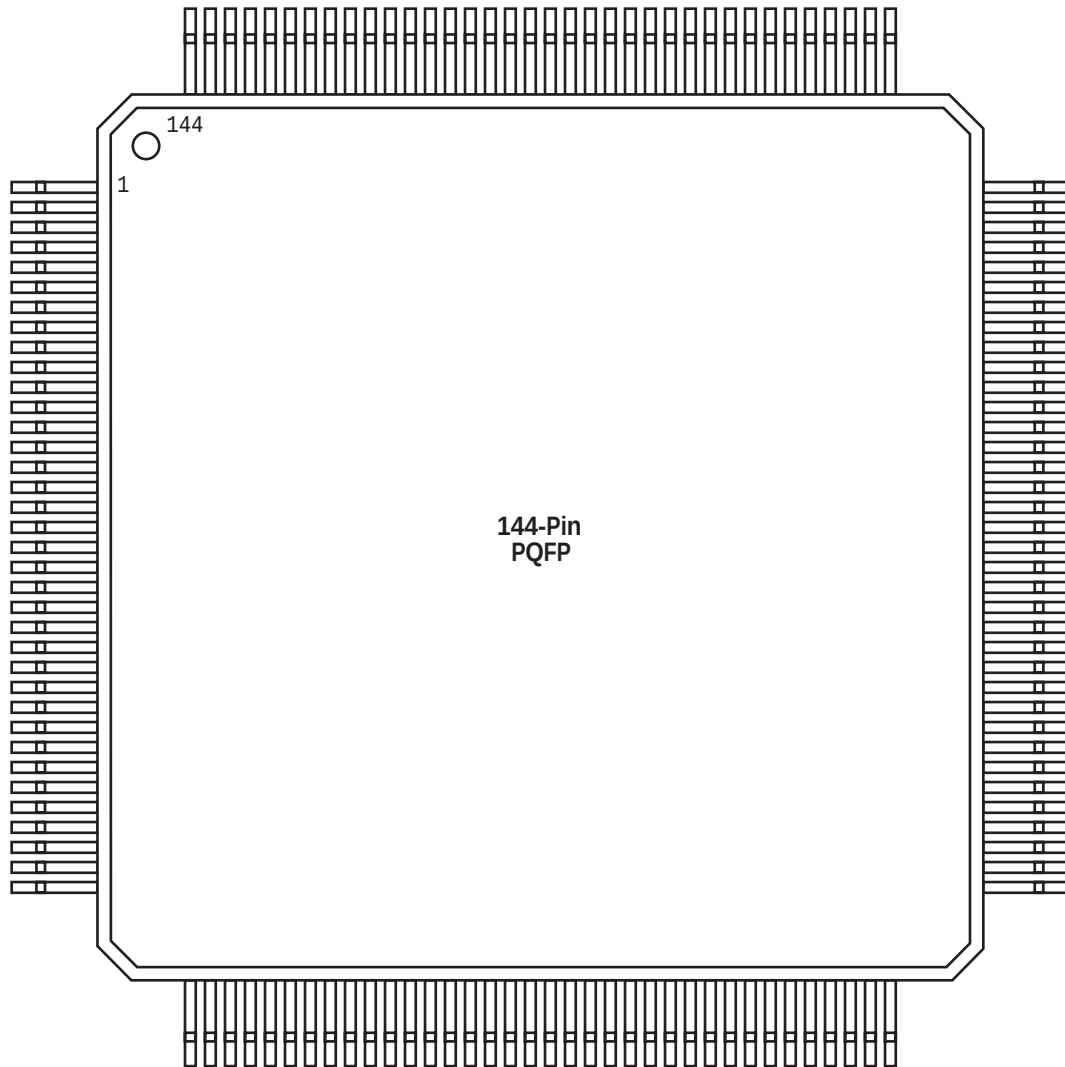


| PQ100      |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function | A42MX09 Function | A42MX16 Function |
| 1          | NC               | NC               | I/O              | I/O              |
| 2          | NC               | NC               | DCLK, I/O        | DCLK, I/O        |
| 3          | NC               | NC               | I/O              | I/O              |
| 4          | NC               | NC               | MODE             | MODE             |
| 5          | NC               | NC               | I/O              | I/O              |
| 6          | PRB, I/O         | PRB, I/O         | I/O              | I/O              |
| 7          | I/O              | I/O              | I/O              | I/O              |
| 8          | I/O              | I/O              | I/O              | I/O              |
| 9          | I/O              | I/O              | GND              | GND              |
| 10         | I/O              | I/O              | I/O              | I/O              |
| 11         | I/O              | I/O              | I/O              | I/O              |
| 12         | I/O              | I/O              | I/O              | I/O              |
| 13         | GND              | GND              | I/O              | I/O              |
| 14         | I/O              | I/O              | I/O              | I/O              |
| 15         | I/O              | I/O              | I/O              | I/O              |
| 16         | I/O              | I/O              | VCCA             | VCCA             |
| 17         | I/O              | I/O              | VCCI             | VCCA             |
| 18         | I/O              | I/O              | I/O              | I/O              |
| 19         | VCC              | V <sub>CC</sub>  | I/O              | I/O              |
| 20         | I/O              | I/O              | I/O              | I/O              |
| 21         | I/O              | I/O              | I/O              | I/O              |
| 22         | I/O              | I/O              | GND              | GND              |
| 23         | I/O              | I/O              | I/O              | I/O              |
| 24         | I/O              | I/O              | I/O              | I/O              |
| 25         | I/O              | I/O              | I/O              | I/O              |
| 26         | I/O              | I/O              | I/O              | I/O              |
| 27         | NC               | NC               | I/O              | I/O              |
| 28         | NC               | NC               | I/O              | I/O              |
| 29         | NC               | NC               | I/O              | I/O              |
| 30         | NC               | NC               | I/O              | I/O              |
| 31         | NC               | I/O              | I/O              | I/O              |
| 32         | NC               | I/O              | I/O              | I/O              |
| 33         | NC               | I/O              | I/O              | I/O              |
| 34         | I/O              | I/O              | GND              | GND              |
| 35         | I/O              | I/O              | I/O              | I/O              |
| 36         | GND              | GND              | I/O              | I/O              |

| PQ100      |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function | A42MX09 Function | A42MX16 Function |
| 37         | GND              | GND              | I/O              | I/O              |
| 38         | I/O              | I/O              | I/O              | I/O              |
| 39         | I/O              | I/O              | I/O              | I/O              |
| 40         | I/O              | I/O              | VCCA             | VCCA             |
| 41         | I/O              | I/O              | I/O              | I/O              |
| 42         | I/O              | I/O              | I/O              | I/O              |
| 43         | VCC              | VCC              | I/O              | I/O              |
| 44         | VCC              | VCC              | I/O              | I/O              |
| 45         | I/O              | I/O              | I/O              | I/O              |
| 46         | I/O              | I/O              | GND              | GND              |
| 47         | I/O              | I/O              | I/O              | I/O              |
| 48         | NC               | I/O              | I/O              | I/O              |
| 49         | NC               | I/O              | I/O              | I/O              |
| 50         | NC               | I/O              | I/O              | I/O              |
| 51         | NC               | NC               | I/O              | I/O              |
| 52         | NC               | NC               | SDO, I/O         | SDO, I/O         |
| 53         | NC               | NC               | I/O              | I/O              |
| 54         | NC               | NC               | I/O              | I/O              |
| 55         | NC               | NC               | I/O              | I/O              |
| 56         | VCC              | VCC              | I/O              | I/O              |
| 57         | I/O              | I/O              | GND              | GND              |
| 58         | I/O              | I/O              | I/O              | I/O              |
| 59         | I/O              | I/O              | I/O              | I/O              |
| 60         | I/O              | I/O              | I/O              | I/O              |
| 61         | I/O              | I/O              | I/O              | I/O              |
| 62         | I/O              | I/O              | I/O              | I/O              |
| 63         | GND              | GND              | I/O              | I/O              |
| 64         | I/O              | I/O              | LP               | LP               |
| 65         | I/O              | I/O              | VCCA             | VCCA             |
| 66         | I/O              | I/O              | VCCI             | VCCI             |
| 67         | I/O              | I/O              | VCCA             | VCCA             |
| 68         | I/O              | I/O              | I/O              | I/O              |
| 69         | VCC              | VCC              | I/O              | I/O              |
| 70         | I/O              | I/O              | I/O              | I/O              |
| 71         | I/O              | I/O              | I/O              | I/O              |
| 72         | I/O              | I/O              | GND              | GND              |

| PQ100      |                  |                  |                  |                  |
|------------|------------------|------------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function | A42MX09 Function | A42MX16 Function |
| 73         | I/O              | I/O              | I/O              | I/O              |
| 74         | I/O              | I/O              | I/O              | I/O              |
| 75         | I/O              | I/O              | I/O              | I/O              |
| 76         | I/O              | I/O              | I/O              | I/O              |
| 77         | NC               | NC               | I/O              | I/O              |
| 78         | NC               | NC               | I/O              | I/O              |
| 79         | NC               | NC               | SDI, I/O         | SDI, I/O         |
| 80         | NC               | I/O              | I/O              | I/O              |
| 81         | NC               | I/O              | I/O              | I/O              |
| 82         | NC               | I/O              | I/O              | I/O              |
| 83         | I/O              | I/O              | I/O              | I/O              |
| 84         | I/O              | I/O              | GND              | GND              |
| 85         | I/O              | I/O              | I/O              | I/O              |
| 86         | GND              | GND              | I/O              | I/O              |
| 87         | GND              | GND              | PRA, I/O         | PRA, I/O         |
| 88         | I/O              | I/O              | I/O              | I/O              |
| 89         | I/O              | I/O              | CLKA, I/O        | CLKA, I/O        |
| 90         | CLK, I/O         | CLK, I/O         | VCCA             | VCCA             |
| 91         | I/O              | I/O              | I/O              | I/O              |
| 92         | MODE             | MODE             | CLKB, I/O        | CLKB, I/O        |
| 93         | VCC              | VCC              | I/O              | I/O              |
| 94         | VCC              | VCC              | PRB, I/O         | PRB, I/O         |
| 95         | NC               | I/O              | I/O              | I/O              |
| 96         | NC               | I/O              | GND              | GND              |
| 97         | NC               | I/O              | I/O              | I/O              |
| 98         | SDI, I/O         | SDI, I/O         | I/O              | I/O              |
| 99         | DCLK, I/O        | DCLK, I/O        | I/O              | I/O              |
| 100        | PRA, I/O         | PRA, I/O         | I/O              | I/O              |

## PQ144



| PQ144      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| 1          | I/O              |
| 2          | MODE             |
| 3          | I/O              |
| 4          | I/O              |
| 5          | I/O              |
| 6          | I/O              |
| 7          | I/O              |
| 8          | I/O              |
| 9          | GNDQ             |
| 10         | GNDI             |
| 11         | NC               |
| 12         | I/O              |
| 13         | I/O              |
| 14         | I/O              |
| 15         | I/O              |
| 16         | I/O              |
| 17         | I/O              |
| 18         | VSV              |
| 19         | VCC              |
| 20         | VCCI             |
| 21         | NC               |
| 22         | I/O              |
| 23         | I/O              |
| 24         | I/O              |
| 25         | I/O              |
| 26         | I/O              |
| 27         | I/O              |
| 28         | GND              |
| 29         | GNDI             |
| 30         | NC               |
| 31         | I/O              |
| 32         | I/O              |
| 33         | I/O              |
| 34         | I/O              |
| 35         | I/O              |
| 36         | I/O              |

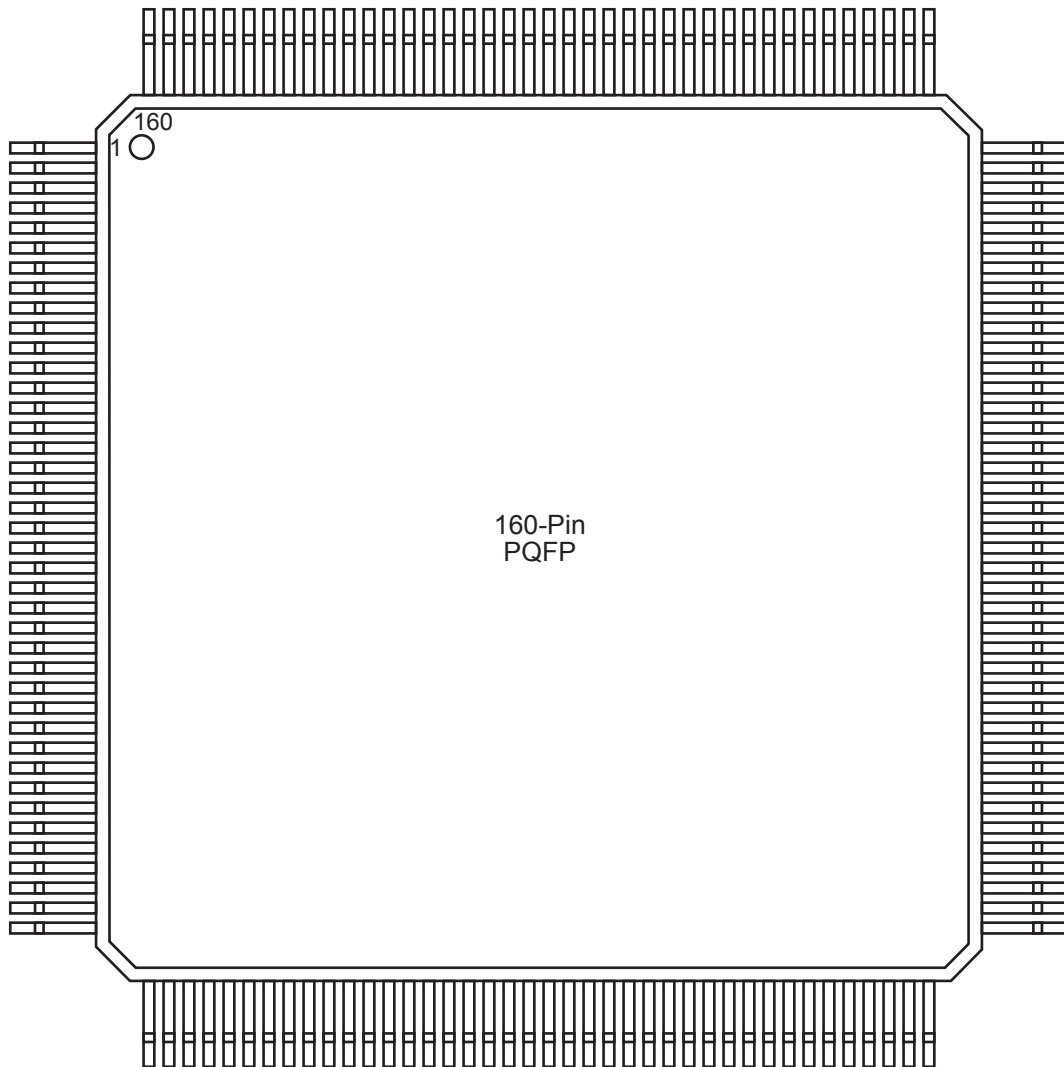
| PQ144      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| 37         | BININ            |
| 38         | BINOUT           |
| 39         | I/O              |
| 40         | I/O              |
| 41         | I/O              |
| 42         | I/O              |
| 43         | I/O              |
| 44         | GNDQ             |
| 45         | GNDI             |
| 46         | NC               |
| 47         | I/O              |
| 48         | I/O              |
| 49         | I/O              |
| 50         | I/O              |
| 51         | I/O              |
| 52         | I/O              |
| 53         | I/O              |
| 54         | VCC              |
| 55         | VCCI             |
| 56         | NC               |
| 57         | I/O              |
| 58         | I/O              |
| 59         | I/O              |
| 60         | I/O              |
| 61         | I/O              |
| 62         | I/O              |
| 63         | I/O              |
| 64         | GND              |
| 65         | GNDI             |
| 66         | I/O              |
| 67         | I/O              |
| 68         | I/O              |
| 69         | I/O              |
| 70         | I/O              |
| 71         | SDO              |
| 72         | I/O              |

| PQ144      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| 73         | I/O              |
| 74         | I/O              |
| 75         | I/O              |
| 76         | I/O              |
| 77         | I/O              |
| 78         | I/O              |
| 79         | GNDQ             |
| 80         | GNDI             |
| 81         | NC               |
| 82         | I/O              |
| 83         | I/O              |
| 84         | I/O              |
| 85         | I/O              |
| 86         | I/O              |
| 87         | I/O              |
| 88         | VKS              |
| 89         | VPP              |
| 90         | VCC              |
| 91         | VCCI             |
| 92         | NC               |
| 93         | VSV              |
| 94         | I/O              |
| 95         | I/O              |
| 96         | I/O              |
| 97         | I/O              |
| 98         | I/O              |
| 99         | I/O              |
| 100        | GND              |
| 101        | GNDI             |
| 102        | NC               |
| 103        | I/O              |
| 104        | I/O              |
| 105        | I/O              |
| 106        | I/O              |
| 107        | I/O              |
| 108        | I/O              |

| <b>PQ144</b>      |                         |
|-------------------|-------------------------|
| <b>Pin Number</b> | <b>A42MX09 Function</b> |
| 109               | I/O                     |
| 110               | SDI                     |
| 111               | I/O                     |
| 112               | I/O                     |
| 113               | I/O                     |
| 114               | I/O                     |
| 115               | I/O                     |
| 116               | GNDQ                    |
| 117               | GNDI                    |
| 118               | NC                      |
| 119               | I/O                     |
| 120               | I/O                     |
| 121               | I/O                     |
| 122               | I/O                     |
| 123               | PROBA                   |
| 124               | I/O                     |
| 125               | CLKA                    |
| 126               | VCC                     |
| 127               | VCCI                    |
| 128               | NC                      |
| 129               | I/O                     |
| 130               | CLKB                    |
| 131               | I/O                     |
| 132               | PROBB                   |
| 133               | I/O                     |
| 134               | I/O                     |
| 135               | I/O                     |
| 136               | GND                     |
| 137               | GNDI                    |
| 138               | NC                      |
| 139               | I/O                     |
| 140               | I/O                     |
| 141               | I/O                     |
| 142               | I/O                     |
| 143               | I/O                     |
| 144               | DCLK                    |

## PQ160

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| PQ160      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 1          | I/O              | I/O              | I/O              |
| 2          | DCLK, I/O        | DCLK, I/O        | DCLK, I/O        |
| 3          | NC               | I/O              | I/O              |
| 4          | I/O              | I/O              | WD, I/O          |
| 5          | I/O              | I/O              | WD, I/O          |
| 6          | NC               | VCCI             | VCCI             |
| 7          | I/O              | I/O              | I/O              |
| 8          | I/O              | I/O              | I/O              |
| 9          | I/O              | I/O              | I/O              |
| 10         | NC               | I/O              | I/O              |
| 11         | GND              | GND              | GND              |
| 12         | NC               | I/O              | I/O              |
| 13         | I/O              | I/O              | WD, I/O          |
| 14         | I/O              | I/O              | WD, I/O          |
| 15         | I/O              | I/O              | I/O              |
| 16         | PRB, I/O         | PRB, I/O         | PRB, I/O         |
| 17         | I/O              | I/O              | I/O              |
| 18         | CLKB, I/O        | CLKB, I/O        | CLKB, I/O        |
| 19         | I/O              | I/O              | I/O              |
| 20         | VCCA             | VCCA             | VCCA             |
| 21         | CLKA, I/O        | CLKA, I/O        | CLKA, I/O        |
| 22         | I/O              | I/O              | I/O              |
| 23         | PRA, I/O         | PRA, I/O         | PRA, I/O         |
| 24         | NC               | I/O              | WD, I/O          |
| 25         | I/O              | I/O              | WD, I/O          |
| 26         | I/O              | I/O              | I/O              |
| 27         | I/O              | I/O              | I/O              |
| 28         | NC               | I/O              | I/O              |
| 29         | I/O              | I/O              | WD, I/O          |
| 30         | GND              | GND              | GND              |
| 31         | NC               | I/O              | WD, I/O          |
| 32         | I/O              | I/O              | I/O              |
| 33         | I/O              | I/O              | I/O              |
| 34         | I/O              | I/O              | I/O              |
| 35         | NC               | VCCI             | VCCI             |
| 36         | I/O              | I/O              | WD, I/O          |

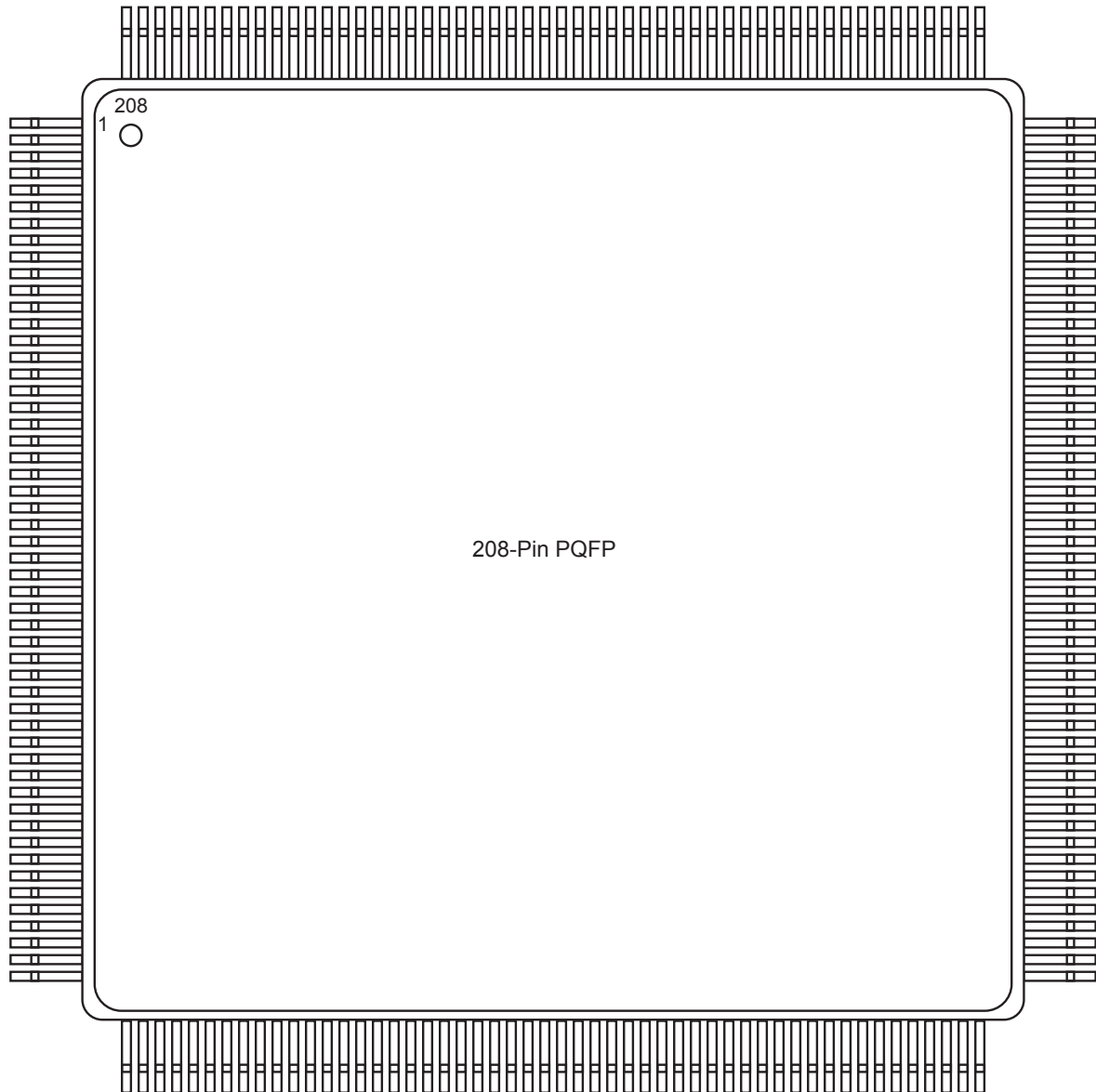
| PQ160      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 37         | I/O              | I/O              | WD, I/O          |
| 38         | SDI, I/O         | SDI, I/O         | SDI, I/O         |
| 39         | I/O              | I/O              | I/O              |
| 40         | GND              | GND              | GND              |
| 41         | I/O              | I/O              | I/O              |
| 42         | I/O              | I/O              | I/O              |
| 43         | I/O              | I/O              | I/O              |
| 44         | GND              | GND              | GND              |
| 45         | I/O              | I/O              | I/O              |
| 46         | I/O              | I/O              | I/O              |
| 47         | I/O              | I/O              | I/O              |
| 48         | I/O              | I/O              | I/O              |
| 49         | GND              | GND              | GND              |
| 50         | I/O              | I/O              | I/O              |
| 51         | I/O              | I/O              | I/O              |
| 52         | NC               | I/O              | I/O              |
| 53         | I/O              | I/O              | I/O              |
| 54         | NC               | VCCA             | VCCA             |
| 55         | I/O              | I/O              | I/O              |
| 56         | I/O              | I/O              | I/O              |
| 57         | VCCA             | VCCA             | VCCA             |
| 58         | VCCI             | VCCI             | VCCI             |
| 59         | GND              | GND              | GND              |
| 60         | VCCA             | VCCA             | VCCA             |
| 61         | LP               | LP               | LP               |
| 62         | I/O              | I/O              | TCK, I/O         |
| 63         | I/O              | I/O              | I/O              |
| 64         | GND              | GND              | GND              |
| 65         | I/O              | I/O              | I/O              |
| 66         | I/O              | I/O              | I/O              |
| 67         | I/O              | I/O              | I/O              |
| 68         | I/O              | I/O              | I/O              |
| 69         | GND              | GND              | GND              |
| 70         | NC               | I/O              | I/O              |
| 71         | I/O              | I/O              | I/O              |
| 72         | I/O              | I/O              | I/O              |

| PQ160      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 73         | I/O              | I/O              | I/O              |
| 74         | I/O              | I/O              | I/O              |
| 75         | NC               | I/O              | I/O              |
| 76         | I/O              | I/O              | I/O              |
| 77         | NC               | I/O              | I/O              |
| 78         | I/O              | I/O              | I/O              |
| 79         | NC               | I/O              | I/O              |
| 80         | GND              | GND              | GND              |
| 81         | I/O              | I/O              | I/O              |
| 82         | SDO, I/O         | SDO, I/O         | SDO, TDO, I/O    |
| 83         | I/O              | I/O              | WD, I/O          |
| 84         | I/O              | I/O              | WD, I/O          |
| 85         | I/O              | I/O              | I/O              |
| 86         | NC               | VCCI             | VCCI             |
| 87         | I/O              | I/O              | I/O              |
| 88         | I/O              | I/O              | WD, I/O          |
| 89         | GND              | GND              | GND              |
| 90         | NC               | I/O              | I/O              |
| 91         | I/O              | I/O              | I/O              |
| 92         | I/O              | I/O              | I/O              |
| 93         | I/O              | I/O              | I/O              |
| 94         | I/O              | I/O              | I/O              |
| 95         | I/O              | I/O              | I/O              |
| 96         | I/O              | I/O              | WD, I/O          |
| 97         | I/O              | I/O              | I/O              |
| 98         | VCCA             | VCCA             | VCCA             |
| 99         | GND              | GND              | GND              |
| 100        | NC               | I/O              | I/O              |
| 101        | I/O              | I/O              | I/O              |
| 102        | I/O              | I/O              | I/O              |
| 103        | NC               | I/O              | I/O              |
| 104        | I/O              | I/O              | I/O              |
| 105        | I/O              | I/O              | I/O              |
| 106        | I/O              | I/O              | WD, I/O          |
| 107        | I/O              | I/O              | WD, I/O          |
| 108        | I/O              | I/O              | I/O              |

| PQ160      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 109        | GND              | GND              | GND              |
| 110        | NC               | I/O              | I/O              |
| 111        | I/O              | I/O              | WD, I/O          |
| 112        | I/O              | I/O              | WD, I/O          |
| 113        | I/O              | I/O              | I/O              |
| 114        | NC               | VCCI             | VCCI             |
| 115        | I/O              | I/O              | WD, I/O          |
| 116        | NC               | I/O              | WD, I/O          |
| 117        | I/O              | I/O              | I/O              |
| 118        | I/O              | I/O              | TDI, I/O         |
| 119        | I/O              | I/O              | TMS, I/O         |
| 120        | GND              | GND              | GND              |
| 121        | I/O              | I/O              | I/O              |
| 122        | I/O              | I/O              | I/O              |
| 123        | I/O              | I/O              | I/O              |
| 124        | NC               | I/O              | I/O              |
| 125        | GND              | GND              | GND              |
| 126        | I/O              | I/O              | I/O              |
| 127        | I/O              | I/O              | I/O              |
| 128        | I/O              | I/O              | I/O              |
| 129        | NC               | I/O              | I/O              |
| 130        | GND              | GND              | GND              |
| 131        | I/O              | I/O              | I/O              |
| 132        | I/O              | I/O              | I/O              |
| 133        | I/O              | I/O              | I/O              |
| 134        | I/O              | I/O              | I/O              |
| 135        | NC               | VCCA             | VCCA             |
| 136        | I/O              | I/O              | I/O              |
| 137        | I/O              | I/O              | I/O              |
| 138        | NC               | VCCA             | VCCA             |
| 139        | VCCI             | VCCI             | VCCI             |
| 140        | GND              | GND              | GND              |
| 141        | NC               | I/O              | I/O              |
| 142        | I/O              | I/O              | I/O              |
| 143        | I/O              | I/O              | I/O              |
| 144        | I/O              | I/O              | I/O              |

| PQ160      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 145        | GND              | GND              | GND              |
| 146        | NC               | I/O              | I/O              |
| 147        | I/O              | I/O              | I/O              |
| 148        | I/O              | I/O              | I/O              |
| 149        | I/O              | I/O              | I/O              |
| 150        | NC               | VCCA             | VCCA             |
| 151        | NC               | I/O              | I/O              |
| 152        | NC               | I/O              | I/O              |
| 153        | NC               | I/O              | I/O              |
| 154        | NC               | I/O              | I/O              |
| 155        | GND              | GND              | GND              |
| 156        | I/O              | I/O              | I/O              |
| 157        | I/O              | I/O              | I/O              |
| 158        | I/O              | I/O              | I/O              |
| 159        | MODE             | MODE             | MODE             |
| 160        | GND              | GND              | GND              |

## PQ208



| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 1          | GND              | GND              | GND              |
| 2          | NC               | VCCA             | VCCA             |
| 3          | MODE             | MODE             | MODE             |
| 4          | I/O              | I/O              | I/O              |
| 5          | I/O              | I/O              | I/O              |
| 6          | I/O              | I/O              | I/O              |
| 7          | I/O              | I/O              | I/O              |
| 8          | I/O              | I/O              | I/O              |
| 9          | NC               | I/O              | I/O              |
| 10         | NC               | I/O              | I/O              |
| 11         | NC               | I/O              | I/O              |
| 12         | I/O              | I/O              | I/O              |
| 13         | I/O              | I/O              | I/O              |
| 14         | I/O              | I/O              | I/O              |
| 15         | I/O              | I/O              | I/O              |
| 16         | NC               | I/O              | I/O              |
| 17         | VCCA             | VCCA             | VCCA             |
| 18         | I/O              | I/O              | I/O              |
| 19         | I/O              | I/O              | I/O              |
| 20         | I/O              | I/O              | I/O              |
| 21         | I/O              | I/O              | I/O              |
| 22         | GND              | GND              | GND              |
| 23         | I/O              | I/O              | I/O              |
| 24         | I/O              | I/O              | I/O              |
| 25         | I/O              | I/O              | I/O              |
| 26         | I/O              | I/O              | I/O              |
| 27         | GND              | GND              | GND              |
| 28         | VCCI             | VCCI             | VCCI             |
| 29         | VCCA             | VCCA             | VCCA             |
| 30         | I/O              | I/O              | I/O              |
| 31         | I/O              | I/O              | I/O              |
| 32         | VCCA             | VCCA             | VCCA             |
| 33         | I/O              | I/O              | I/O              |
| 34         | I/O              | I/O              | I/O              |
| 35         | I/O              | I/O              | I/O              |
| 36         | I/O              | I/O              | I/O              |

| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 37         | I/O              | I/O              | I/O              |
| 38         | I/O              | I/O              | I/O              |
| 39         | I/O              | I/O              | I/O              |
| 40         | I/O              | I/O              | I/O              |
| 41         | NC               | I/O              | I/O              |
| 42         | NC               | I/O              | I/O              |
| 43         | NC               | I/O              | I/O              |
| 44         | I/O              | I/O              | I/O              |
| 45         | I/O              | I/O              | I/O              |
| 46         | I/O              | I/O              | I/O              |
| 47         | I/O              | I/O              | I/O              |
| 48         | I/O              | I/O              | I/O              |
| 49         | I/O              | I/O              | I/O              |
| 50         | NC               | I/O              | I/O              |
| 51         | NC               | I/O              | I/O              |
| 52         | GND              | GND              | GND              |
| 53         | GND              | GND              | GND              |
| 54         | I/O              | TMS, I/O         | TMS, I/O         |
| 55         | I/O              | TDI, I/O         | TDI, I/O         |
| 56         | I/O              | I/O              | I/O              |
| 57         | I/O              | WD, I/O          | WD, I/O          |
| 58         | I/O              | WD, I/O          | WD, I/O          |
| 59         | I/O              | I/O              | I/O              |
| 60         | VCCI             | VCCI             | VCCI             |
| 61         | NC               | I/O              | I/O              |
| 62         | NC               | I/O              | I/O              |
| 63         | I/O              | I/O              | I/O              |
| 64         | I/O              | I/O              | I/O              |
| 65         | I/O              | I/O              | QCLKA, I/O       |
| 66         | I/O              | WD, I/O          | WD, I/O          |
| 67         | NC               | WD, I/O          | WD, I/O          |
| 68         | NC               | I/O              | I/O              |
| 69         | I/O              | I/O              | I/O              |
| 70         | I/O              | WD, I/O          | WD, I/O          |
| 71         | I/O              | WD, I/O          | WD, I/O          |
| 72         | I/O              | I/O              | I/O              |

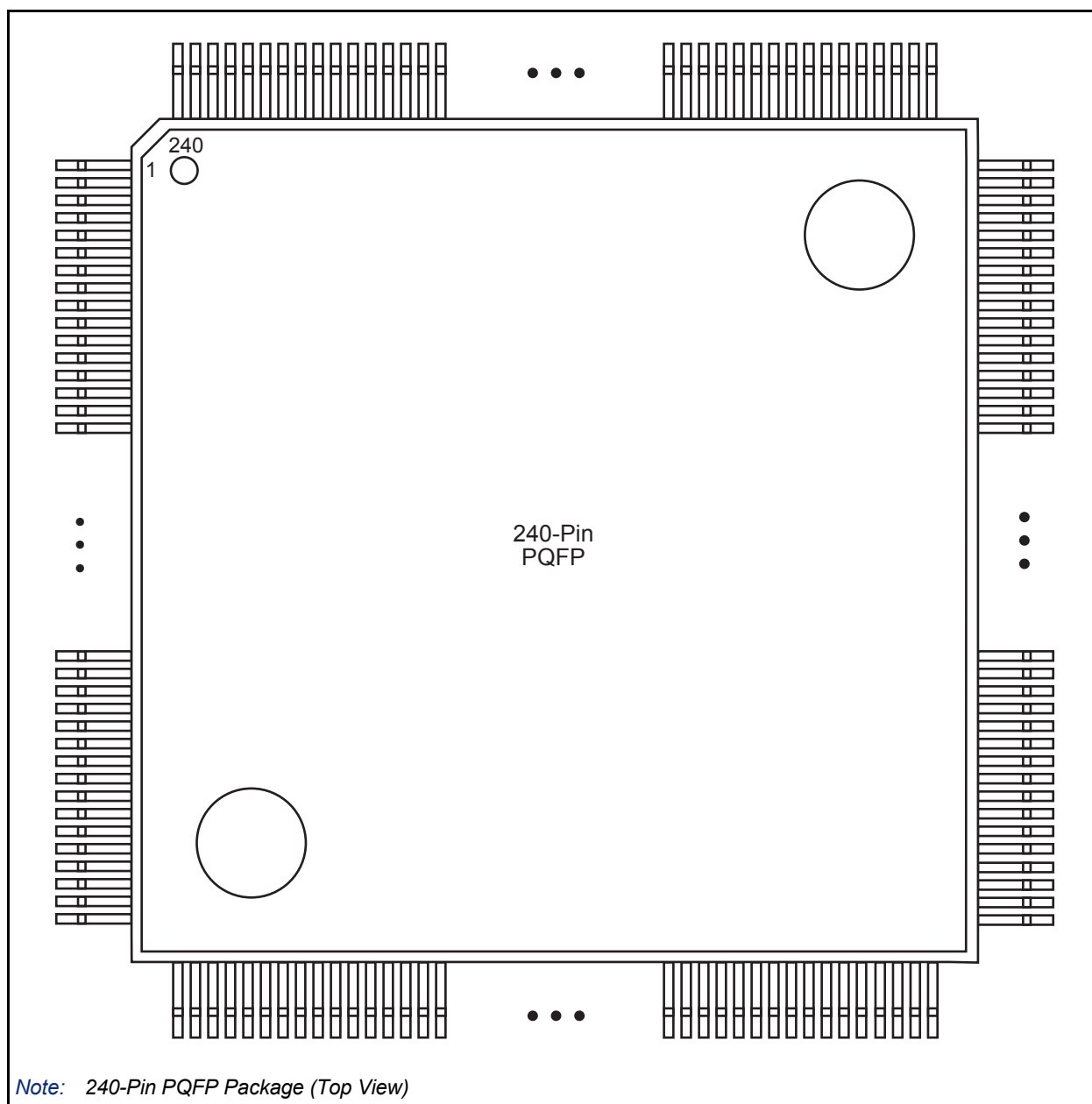
| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 73         | I/O              | I/O              | I/O              |
| 74         | I/O              | I/O              | I/O              |
| 75         | I/O              | I/O              | I/O              |
| 76         | I/O              | I/O              | I/O              |
| 77         | I/O              | I/O              | I/O              |
| 78         | GND              | GND              | GND              |
| 79         | VCCA             | VCCA             | VCCA             |
| 80         | NC               | VCCI             | VCCI             |
| 81         | I/O              | I/O              | I/O              |
| 82         | I/O              | I/O              | I/O              |
| 83         | I/O              | I/O              | I/O              |
| 84         | I/O              | I/O              | I/O              |
| 85         | I/O              | WD, I/O          | WD, I/O          |
| 86         | I/O              | WD, I/O          | WD, I/O          |
| 87         | I/O              | I/O              | I/O              |
| 88         | I/O              | I/O              | I/O              |
| 89         | NC               | I/O              | I/O              |
| 90         | NC               | I/O              | I/O              |
| 91         | I/O              | I/O              | QCLKB, I/O       |
| 92         | I/O              | I/O              | I/O              |
| 93         | I/O              | WD, I/O          | WD, I/O          |
| 94         | I/O              | WD, I/O          | WD, I/O          |
| 95         | NC               | I/O              | I/O              |
| 96         | NC               | I/O              | I/O              |
| 97         | NC               | I/O              | I/O              |
| 98         | VCCI             | VCCI             | VCCI             |
| 99         | I/O              | I/O              | I/O              |
| 100        | I/O              | WD, I/O          | WD, I/O          |
| 101        | I/O              | WD, I/O          | WD, I/O          |
| 102        | I/O              | I/O              | I/O              |
| 103        | SDO, I/O         | SDO, TDO, I/O    | SDO, TDO, I/O    |
| 104        | I/O              | I/O              | I/O              |
| 105        | GND              | GND              | GND              |
| 106        | NC               | VCCA             | VCCA             |
| 107        | I/O              | I/O              | I/O              |
| 108        | I/O              | I/O              | I/O              |

| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 109        | I/O              | I/O              | I/O              |
| 110        | I/O              | I/O              | I/O              |
| 111        | I/O              | I/O              | I/O              |
| 112        | NC               | I/O              | I/O              |
| 113        | NC               | I/O              | I/O              |
| 114        | NC               | I/O              | I/O              |
| 115        | NC               | I/O              | I/O              |
| 116        | I/O              | I/O              | I/O              |
| 117        | I/O              | I/O              | I/O              |
| 118        | I/O              | I/O              | I/O              |
| 119        | I/O              | I/O              | I/O              |
| 120        | I/O              | I/O              | I/O              |
| 121        | I/O              | I/O              | I/O              |
| 122        | I/O              | I/O              | I/O              |
| 123        | I/O              | I/O              | I/O              |
| 124        | I/O              | I/O              | I/O              |
| 125        | I/O              | I/O              | I/O              |
| 126        | GND              | GND              | GND              |
| 127        | I/O              | I/O              | I/O              |
| 128        | I/O              | TCK, I/O         | TCK, I/O         |
| 129        | LP               | LP               | LP               |
| 130        | VCCA             | VCCA             | VCCA             |
| 131        | GND              | GND              | GND              |
| 132        | VCCI             | VCCI             | VCCI             |
| 133        | VCCA             | VCCA             | VCCA             |
| 134        | I/O              | I/O              | I/O              |
| 135        | I/O              | I/O              | I/O              |
| 136        | VCCA             | VCCA             | VCCA             |
| 137        | I/O              | I/O              | I/O              |
| 138        | I/O              | I/O              | I/O              |
| 139        | I/O              | I/O              | I/O              |
| 140        | I/O              | I/O              | I/O              |
| 141        | NC               | I/O              | I/O              |
| 142        | I/O              | I/O              | I/O              |
| 143        | I/O              | I/O              | I/O              |
| 144        | I/O              | I/O              | I/O              |

| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 145        | I/O              | I/O              | I/O              |
| 146        | NC               | I/O              | I/O              |
| 147        | NC               | I/O              | I/O              |
| 148        | NC               | I/O              | I/O              |
| 149        | NC               | I/O              | I/O              |
| 150        | GND              | GND              | GND              |
| 151        | I/O              | I/O              | I/O              |
| 152        | I/O              | I/O              | I/O              |
| 153        | I/O              | I/O              | I/O              |
| 154        | I/O              | I/O              | I/O              |
| 155        | I/O              | I/O              | I/O              |
| 156        | I/O              | I/O              | I/O              |
| 157        | GND              | GND              | GND              |
| 158        | I/O              | I/O              | I/O              |
| 159        | SDI, I/O         | SDI, I/O         | SDI, I/O         |
| 160        | I/O              | I/O              | I/O              |
| 161        | I/O              | WD, I/O          | WD, I/O          |
| 162        | I/O              | WD, I/O          | WD, I/O          |
| 163        | I/O              | I/O              | I/O              |
| 164        | VCCI             | VCCI             | VCCI             |
| 165        | NC               | I/O              | I/O              |
| 166        | NC               | I/O              | I/O              |
| 167        | I/O              | I/O              | I/O              |
| 168        | I/O              | WD, I/O          | WD, I/O          |
| 169        | I/O              | WD, I/O          | WD, I/O          |
| 170        | I/O              | I/O              | I/O              |
| 171        | NC               | I/O              | QCLKD, I/O       |
| 172        | I/O              | I/O              | I/O              |
| 173        | I/O              | I/O              | I/O              |
| 174        | I/O              | I/O              | I/O              |
| 175        | I/O              | I/O              | I/O              |
| 176        | I/O              | WD, I/O          | WD, I/O          |
| 177        | I/O              | WD, I/O          | WD, I/O          |
| 178        | PRA, I/O         | PRA, I/O         | PRA, I/O         |
| 179        | I/O              | I/O              | I/O              |
| 180        | CLKA, I/O        | CLKA, I/O        | CLKA, I/O        |

| PQ208      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX16 Function | A42MX24 Function | A42MX36 Function |
| 181        | NC               | I/O              | I/O              |
| 182        | NC               | VCCI             | VCCI             |
| 183        | VCCA             | VCCA             | VCCA             |
| 184        | GND              | GND              | GND              |
| 185        | I/O              | I/O              | I/O              |
| 186        | CLKB, I/O        | CLKB, I/O        | CLKB, I/O        |
| 187        | I/O              | I/O              | I/O              |
| 188        | PRB, I/O         | PRB, I/O         | PRB, I/O         |
| 189        | I/O              | I/O              | I/O              |
| 190        | I/O              | WD, I/O          | WD, I/O          |
| 191        | I/O              | WD, I/O          | WD, I/O          |
| 192        | I/O              | I/O              | I/O              |
| 193        | NC               | I/O              | I/O              |
| 194        | NC               | WD, I/O          | WD, I/O          |
| 195        | NC               | WD, I/O          | WD, I/O          |
| 196        | I/O              | I/O              | QCLKC, I/O       |
| 197        | NC               | I/O              | I/O              |
| 198        | I/O              | I/O              | I/O              |
| 199        | I/O              | I/O              | I/O              |
| 200        | I/O              | I/O              | I/O              |
| 201        | NC               | I/O              | I/O              |
| 202        | VCCI             | VCCI             | VCCI             |
| 203        | I/O              | WD, I/O          | WD, I/O          |
| 204        | I/O              | WD, I/O          | WD, I/O          |
| 205        | I/O              | I/O              | I/O              |
| 206        | I/O              | I/O              | I/O              |
| 207        | DCLK, I/O        | DCLK, I/O        | DCLK, I/O        |
| 208        | I/O              | I/O              | I/O              |

## PQ240



| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 1          | I/O              |
| 2          | DCLK, I/O        |
| 3          | I/O              |
| 4          | I/O              |
| 5          | I/O              |
| 6          | WD, I/O          |
| 7          | WD, I/O          |
| 8          | VCCI             |
| 9          | I/O              |
| 10         | I/O              |
| 11         | I/O              |
| 12         | I/O              |
| 13         | I/O              |
| 14         | I/O              |
| 15         | QCLKC, I/O       |
| 16         | I/O              |
| 17         | WD, I/O          |
| 18         | WD, I/O          |
| 19         | I/O              |
| 20         | I/O              |
| 21         | WD, I/O          |
| 22         | WD, I/O          |
| 23         | I/O              |
| 24         | PRB, I/O         |
| 25         | I/O              |
| 26         | CLKB, I/O        |
| 27         | I/O              |
| 28         | GND              |
| 29         | VCCA             |
| 30         | VCCI             |
| 31         | I/O              |
| 32         | CLKA, I/O        |
| 33         | I/O              |
| 34         | PRA, I/O         |
| 35         | I/O              |
| 36         | I/O              |

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 37         | WD, I/O          |
| 38         | WD, I/O          |
| 39         | I/O              |
| 40         | I/O              |
| 41         | I/O              |
| 42         | I/O              |
| 43         | I/O              |
| 44         | I/O              |
| 45         | QCLKD, I/O       |
| 46         | I/O              |
| 47         | WD, I/O          |
| 48         | WD, I/O          |
| 49         | I/O              |
| 50         | I/O              |
| 51         | I/O              |
| 52         | VCCI             |
| 53         | I/O              |
| 54         | WD, I/O          |
| 55         | WD, I/O          |
| 56         | I/O              |
| 57         | SDI, I/O         |
| 58         | I/O              |
| 59         | VCCA             |
| 60         | GND              |
| 61         | GND              |
| 62         | I/O              |
| 63         | I/O              |
| 64         | I/O              |
| 65         | I/O              |
| 66         | I/O              |
| 67         | I/O              |
| 68         | I/O              |
| 69         | I/O              |
| 70         | I/O              |
| 71         | VCCI             |
| 72         | I/O              |

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 73         | I/O              |
| 74         | I/O              |
| 75         | I/O              |
| 76         | I/O              |
| 77         | I/O              |
| 78         | I/O              |
| 79         | I/O              |
| 80         | I/O              |
| 81         | I/O              |
| 82         | I/O              |
| 83         | I/O              |
| 84         | I/O              |
| 85         | VCCA             |
| 86         | I/O              |
| 87         | I/O              |
| 88         | VCCA             |
| 89         | VCCI             |
| 90         | VCCA             |
| 91         | LP               |
| 92         | TCK, I/O         |
| 93         | I/O              |
| 94         | GND              |
| 95         | I/O              |
| 96         | I/O              |
| 97         | I/O              |
| 98         | I/O              |
| 99         | I/O              |
| 100        | I/O              |
| 101        | I/O              |
| 102        | I/O              |
| 103        | I/O              |
| 104        | I/O              |
| 105        | I/O              |
| 106        | I/O              |
| 107        | I/O              |
| 108        | VCCI             |

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 109        | I/O              |
| 110        | I/O              |
| 111        | I/O              |
| 112        | I/O              |
| 113        | I/O              |
| 114        | I/O              |
| 115        | I/O              |
| 116        | I/O              |
| 117        | I/O              |
| 118        | VCCA             |
| 119        | GND              |
| 120        | GND              |
| 121        | GND              |
| 122        | I/O              |
| 123        | SDO, TDO, I/O    |
| 124        | I/O              |
| 125        | WD, I/O          |
| 126        | WD, I/O          |
| 127        | I/O              |
| 128        | VCCI             |
| 129        | I/O              |
| 130        | I/O              |
| 131        | I/O              |
| 132        | WD, I/O          |
| 133        | WD, I/O          |
| 134        | I/O              |
| 135        | QCLKB, I/O       |
| 136        | I/O              |
| 137        | I/O              |
| 138        | I/O              |
| 139        | I/O              |
| 140        | I/O              |
| 141        | I/O              |
| 142        | WD, I/O          |
| 143        | WD, I/O          |
| 144        | I/O              |

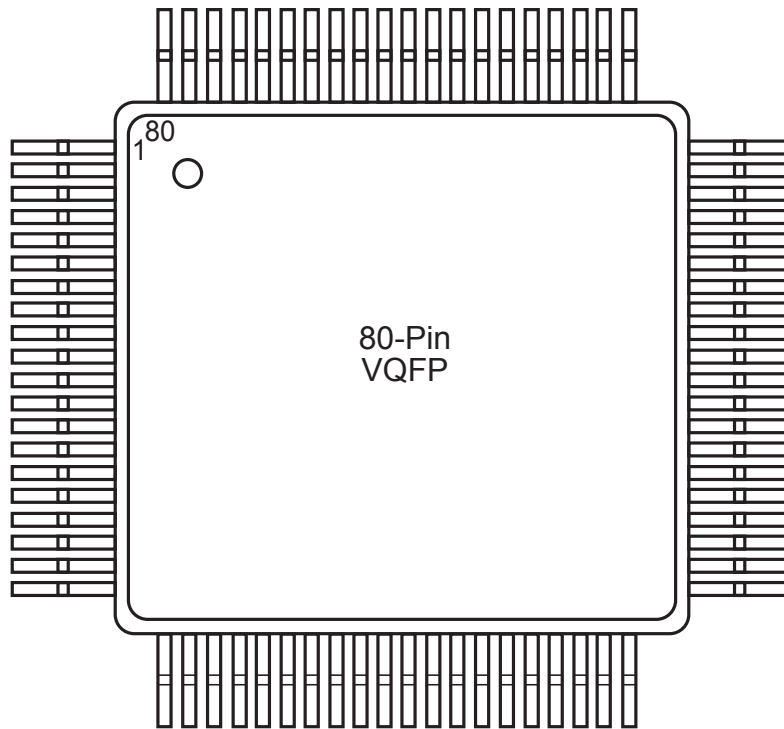
| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 145        | I/O              |
| 146        | I/O              |
| 147        | I/O              |
| 148        | I/O              |
| 149        | I/O              |
| 150        | VCCI             |
| 151        | VCCA             |
| 152        | GND              |
| 153        | I/O              |
| 154        | I/O              |
| 155        | I/O              |
| 156        | I/O              |
| 157        | I/O              |
| 158        | I/O              |
| 159        | WD, I/O          |
| 160        | WD, I/O          |
| 161        | I/O              |
| 162        | I/O              |
| 163        | WD, I/O          |
| 164        | WD, I/O          |
| 165        | I/O              |
| 166        | QCLKA, I/O       |
| 167        | I/O              |
| 168        | I/O              |
| 169        | I/O              |
| 170        | I/O              |
| 171        | I/O              |
| 172        | VCCI             |
| 173        | I/O              |
| 174        | WD, I/O          |
| 175        | WD, I/O          |
| 176        | I/O              |
| 177        | I/O              |
| 178        | TDI, I/O         |
| 179        | TMS, I/O         |
| 180        | GND              |

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 181        | VCCA             |
| 182        | GND              |
| 183        | I/O              |
| 184        | I/O              |
| 185        | I/O              |
| 186        | I/O              |
| 187        | I/O              |
| 188        | I/O              |
| 189        | I/O              |
| 190        | I/O              |
| 191        | I/O              |
| 192        | VCCI             |
| 193        | I/O              |
| 194        | I/O              |
| 195        | I/O              |
| 196        | I/O              |
| 197        | I/O              |
| 198        | I/O              |
| 199        | I/O              |
| 200        | I/O              |
| 201        | I/O              |
| 202        | I/O              |
| 203        | I/O              |
| 204        | I/O              |
| 205        | I/O              |
| 206        | VCCA             |
| 207        | I/O              |
| 208        | I/O              |
| 209        | VCCA             |
| 210        | VCCI             |
| 211        | I/O              |
| 212        | I/O              |
| 213        | I/O              |
| 214        | I/O              |
| 215        | I/O              |
| 216        | I/O              |

| PQ240      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 217        | I/O              |
| 218        | I/O              |
| 219        | VCCA             |
| 220        | I/O              |
| 221        | I/O              |
| 222        | I/O              |
| 223        | I/O              |
| 224        | I/O              |
| 225        | I/O              |
| 226        | I/O              |
| 227        | VCCI             |
| 228        | I/O              |
| 229        | I/O              |
| 230        | I/O              |
| 231        | I/O              |
| 232        | I/O              |
| 233        | I/O              |
| 234        | I/O              |
| 235        | I/O              |
| 236        | I/O              |
| 237        | GND              |
| 238        | MODE             |
| 239        | VCCA             |
| 240        | GND              |

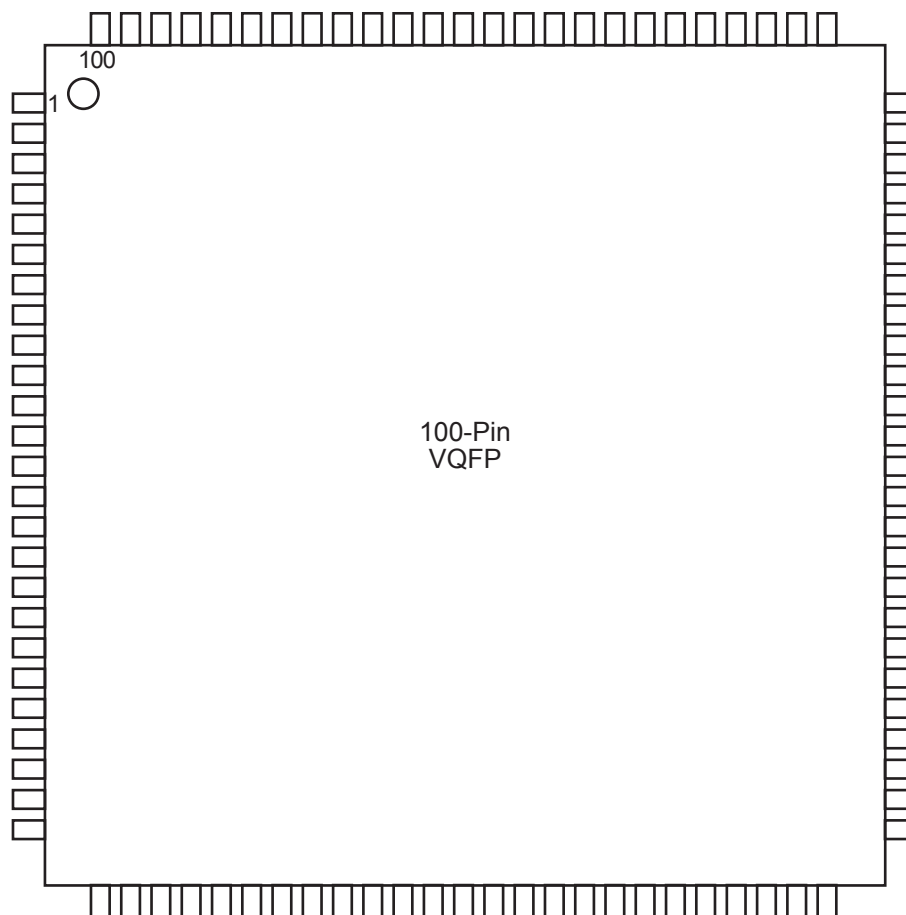
## VQ80

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| VQ80       |                  |                  | VQ80       |                  |                  | VQ80       |                  |                  |
|------------|------------------|------------------|------------|------------------|------------------|------------|------------------|------------------|
| Pin Number | A40MX02 Function | A40MX04 Function | Pin Number | A40MX02 Function | A40MX04 Function | Pin Number | A40MX02 Function | A40MX04 Function |
| 1          | I/O              | I/O              | 28         | I/O              | I/O              | 55         | NC               | I/O              |
| 2          | NC               | I/O              | 29         | I/O              | I/O              | 56         | NC               | I/O              |
| 3          | NC               | I/O              | 30         | I/O              | I/O              | 57         | SDI, I/O         | SDI, I/O         |
| 4          | NC               | I/O              | 31         | I/O              | I/O              | 58         | DCLK, I/O        | DCLK, I/O        |
| 5          | I/O              | I/O              | 32         | I/O              | I/O              | 59         | PRA, I/O         | PRA, I/O         |
| 6          | I/O              | I/O              | 33         | VCC              | VCC              | 60         | NC               | NC               |
| 7          | GND              | GND              | 34         | I/O              | I/O              | 61         | PRB, I/O         | PRB, I/O         |
| 8          | I/O              | I/O              | 35         | I/O              | I/O              | 62         | I/O              | I/O              |
| 9          | I/O              | I/O              | 36         | I/O              | I/O              | 63         | I/O              | I/O              |
| 10         | I/O              | I/O              | 37         | I/O              | I/O              | 64         | I/O              | I/O              |
| 11         | I/O              | I/O              | 38         | I/O              | I/O              | 65         | I/O              | I/O              |
| 12         | I/O              | I/O              | 39         | I/O              | I/O              | 66         | I/O              | I/O              |
| 13         | VCC              | VCC              | 40         | I/O              | I/O              | 67         | I/O              | I/O              |
| 14         | I/O              | I/O              | 41         | NC               | I/O              | 68         | GND              | GND              |
| 15         | I/O              | I/O              | 42         | NC               | I/O              | 69         | I/O              | I/O              |
| 16         | I/O              | I/O              | 43         | NC               | I/O              | 70         | I/O              | I/O              |
| 17         | NC               | I/O              | 44         | I/O              | I/O              | 71         | I/O              | I/O              |
| 18         | NC               | I/O              | 45         | I/O              | I/O              | 72         | I/O              | I/O              |
| 19         | NC               | I/O              | 46         | I/O              | I/O              | 73         | I/O              | I/O              |
| 20         | VCC              | VCC              | 47         | GND              | GND              | 74         | VCC              | <b>VCC</b>       |
| 21         | I/O              | I/O              | 48         | I/O              | I/O              | 75         | I/O              | I/O              |
| 22         | I/O              | I/O              | 49         | I/O              | I/O              | 76         | I/O              | I/O              |
| 23         | I/O              | I/O              | 50         | CLK, I/O         | CLK, I/O         | 77         | I/O              | I/O              |
| 24         | I/O              | I/O              | 51         | I/O              | I/O              | 78         | I/O              | I/O              |
| 25         | I/O              | I/O              | 52         | MODE             | MODE             | 79         | I/O              | I/O              |
| 26         | I/O              | I/O              | 53         | VCC              | VCC              | 80         | I/O              | I/O              |
| 27         | GND              | GND              | 54         | NC               | I/O              |            |                  |                  |

## VQ100

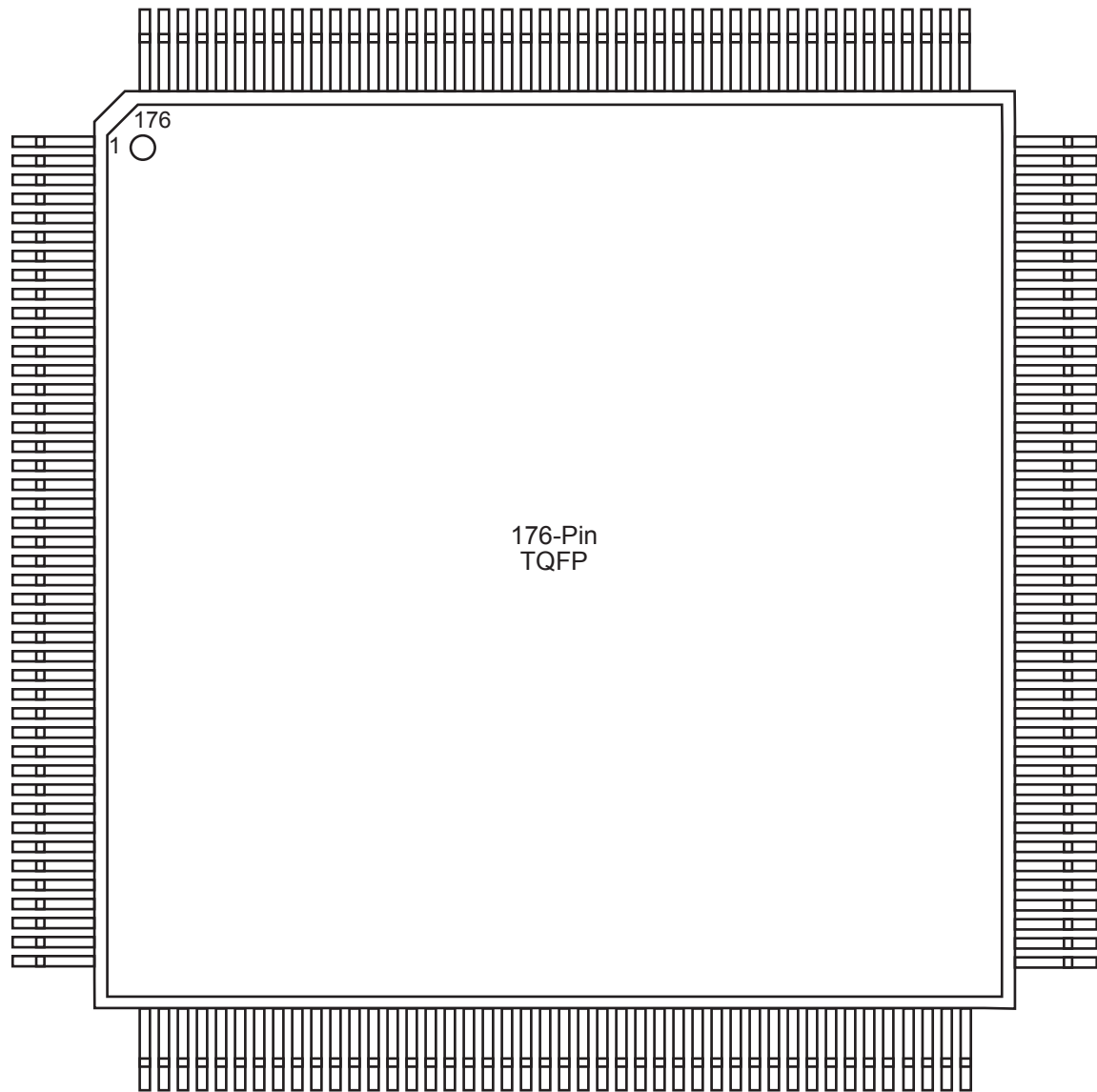


| VQ100      |                  |                  |
|------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function |
| 1          | I/O              | I/O              |
| 2          | MODE             | MODE             |
| 3          | I/O              | I/O              |
| 4          | I/O              | I/O              |
| 5          | I/O              | I/O              |
| 6          | I/O              | I/O              |
| 7          | GND              | GND              |
| 8          | I/O              | I/O              |
| 9          | I/O              | I/O              |
| 10         | I/O              | I/O              |
| 11         | I/O              | I/O              |
| 12         | I/O              | I/O              |
| 13         | I/O              | I/O              |
| 14         | VCCA             | NC               |
| 15         | VCCI             | VCCI             |
| 16         | I/O              | I/O              |
| 17         | I/O              | I/O              |
| 18         | I/O              | I/O              |
| 19         | I/O              | I/O              |
| 20         | GND              | GND              |
| 21         | I/O              | I/O              |
| 22         | I/O              | I/O              |
| 23         | I/O              | I/O              |
| 24         | I/O              | I/O              |
| 25         | I/O              | I/O              |
| 26         | I/O              | I/O              |
| 27         | I/O              | I/O              |
| 28         | I/O              | I/O              |
| 29         | I/O              | I/O              |
| 30         | I/O              | I/O              |
| 31         | I/O              | I/O              |
| 32         | GND              | GND              |
| 33         | I/O              | I/O              |
| 34         | I/O              | I/O              |
| 35         | I/O              | I/O              |

| VQ100      |                  |                  |
|------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function |
| 36         | I/O              | I/O              |
| 37         | I/O              | I/O              |
| 38         | VCCA             | VCCA             |
| 39         | I/O              | I/O              |
| 40         | I/O              | I/O              |
| 41         | I/O              | I/O              |
| 42         | I/O              | I/O              |
| 43         | I/O              | I/O              |
| 44         | GND              | GND              |
| 45         | I/O              | I/O              |
| 46         | I/O              | I/O              |
| 47         | I/O              | I/O              |
| 48         | I/O              | I/O              |
| 49         | I/O              | I/O              |
| 50         | SDO, I/O         | SDO, I/O         |
| 51         | I/O              | I/O              |
| 52         | I/O              | I/O              |
| 53         | I/O              | I/O              |
| 54         | I/O              | I/O              |
| 55         | GND              | GND              |
| 56         | I/O              | I/O              |
| 57         | I/O              | I/O              |
| 58         | I/O              | I/O              |
| 59         | I/O              | I/O              |
| 60         | I/O              | I/O              |
| 61         | I/O              | I/O              |
| 62         | LP               | LP               |
| 63         | VCCA             | VCCA             |
| 64         | VCCI             | VCCI             |
| 65         | VCCA             | VCCA             |
| 66         | I/O              | I/O              |
| 67         | I/O              | I/O              |
| 68         | I/O              | I/O              |
| 69         | I/O              | I/O              |
| 70         | GND              | GND              |

| VQ100      |                  |                  |
|------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function |
| 71         | I/O              | I/O              |
| 72         | I/O              | I/O              |
| 73         | I/O              | I/O              |
| 74         | I/O              | I/O              |
| 75         | I/O              | I/O              |
| 76         | I/O              | I/O              |
| 77         | SDI, I/O         | SDI, I/O         |
| 78         | I/O              | I/O              |
| 79         | I/O              | I/O              |
| 80         | I/O              | I/O              |
| 81         | I/O              | I/O              |
| 82         | GND              | GND              |
| 83         | I/O              | I/O              |
| 84         | I/O              | I/O              |
| 85         | PRA, I/O         | PRA, I/O         |
| 86         | I/O              | I/O              |
| 87         | CLKA, I/O        | CLKA, I/O        |
| 88         | VCCA             | VCCA             |
| 89         | I/O              | I/O              |
| 90         | CLKB, I/O        | CLKB, I/O        |
| 91         | I/O              | I/O              |
| 92         | PRB, I/O         | PRB, I/O         |
| 93         | I/O              | I/O              |
| 94         | GND              | GND              |
| 95         | I/O              | I/O              |
| 96         | I/O              | I/O              |
| 97         | I/O              | I/O              |
| 98         | I/O              | I/O              |
| 99         | I/O              | I/O              |
| 100        | DCLK, I/O        | DCLK, I/O        |

## TQ176



| TQ176      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 1          | GND              | GND              | GND              |
| 2          | MODE             | MODE             | MODE             |
| 3          | I/O              | I/O              | I/O              |
| 4          | I/O              | I/O              | I/O              |
| 5          | I/O              | I/O              | I/O              |
| 6          | I/O              | I/O              | I/O              |
| 7          | I/O              | I/O              | I/O              |
| 8          | NC               | NC               | I/O              |
| 9          | I/O              | I/O              | I/O              |
| 10         | NC               | I/O              | I/O              |
| 11         | NC               | I/O              | I/O              |
| 12         | I/O              | I/O              | I/O              |
| 13         | NC               | VCCA             | VCCA             |
| 14         | I/O              | I/O              | I/O              |
| 15         | I/O              | I/O              | I/O              |
| 16         | I/O              | I/O              | I/O              |
| 17         | I/O              | I/O              | I/O              |
| 18         | GND              | GND              | GND              |
| 19         | NC               | I/O              | I/O              |
| 20         | NC               | I/O              | I/O              |
| 21         | I/O              | I/O              | I/O              |
| 22         | NC               | I/O              | I/O              |
| 23         | GND              | GND              | GND              |
| 24         | NC               | VCCI             | VCCI             |
| 25         | VCCA             | VCCA             | VCCA             |
| 26         | NC               | I/O              | I/O              |
| 27         | NC               | I/O              | I/O              |
| 28         | VCCI             | VCCA             | VCCA             |
| 29         | NC               | I/O              | I/O              |
| 30         | I/O              | I/O              | I/O              |
| 31         | I/O              | I/O              | I/O              |
| 32         | I/O              | I/O              | I/O              |
| 33         | NC               | NC               | I/O              |
| 34         | I/O              | I/O              | I/O              |
| 35         | I/O              | I/O              | I/O              |
| 36         | I/O              | I/O              | I/O              |

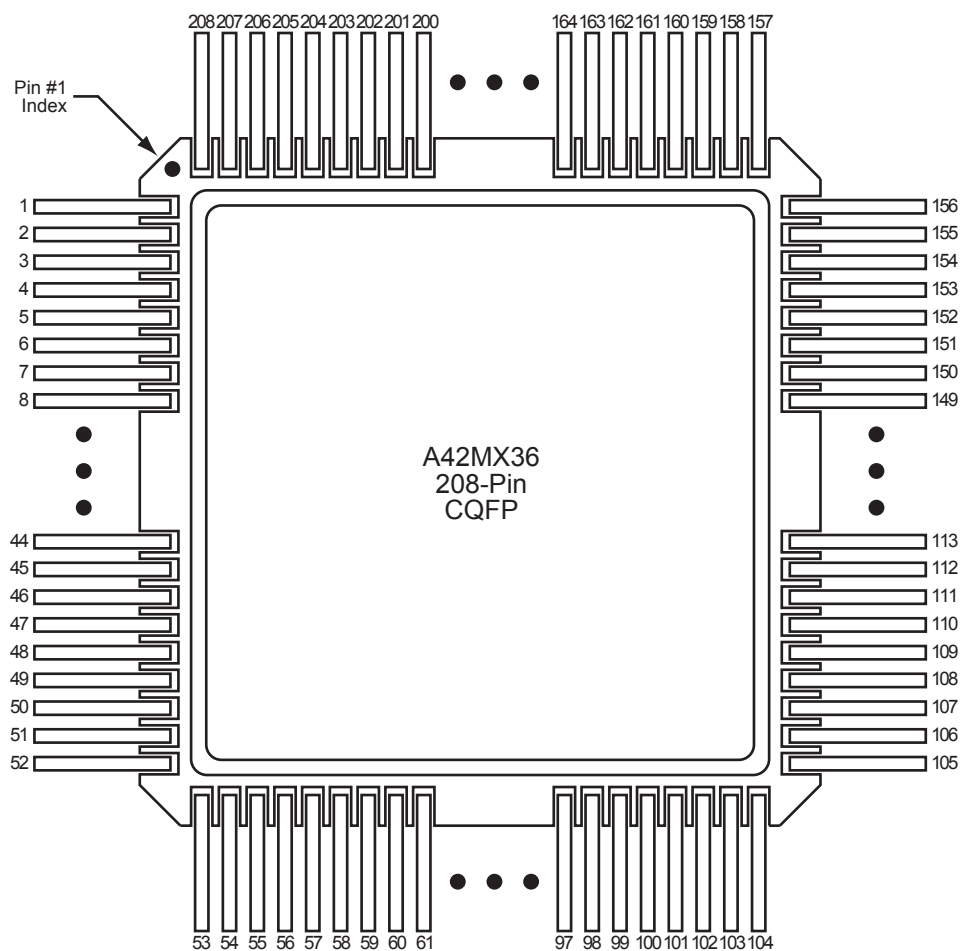
| TQ176      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 37         | NC               | I/O              | I/O              |
| 38         | NC               | NC               | I/O              |
| 39         | I/O              | I/O              | I/O              |
| 40         | I/O              | I/O              | I/O              |
| 41         | I/O              | I/O              | I/O              |
| 42         | I/O              | I/O              | I/O              |
| 43         | I/O              | I/O              | I/O              |
| 44         | I/O              | I/O              | I/O              |
| 45         | GND              | GND              | GND              |
| 46         | I/O              | I/O              | TMS, I/O         |
| 47         | I/O              | I/O              | TDI, I/O         |
| 48         | I/O              | I/O              | I/O              |
| 49         | I/O              | I/O              | WD, I/O          |
| 50         | I/O              | I/O              | WD, I/O          |
| 51         | I/O              | I/O              | I/O              |
| 52         | NC               | VCCI             | VCCI             |
| 53         | I/O              | I/O              | I/O              |
| 54         | NC               | I/O              | I/O              |
| 55         | NC               | I/O              | WD, I/O          |
| 56         | I/O              | I/O              | WD, I/O          |
| 57         | NC               | NC               | I/O              |
| 58         | I/O              | I/O              | I/O              |
| 59         | I/O              | I/O              | WD, I/O          |
| 60         | I/O              | I/O              | WD, I/O          |
| 61         | NC               | I/O              | I/O              |
| 62         | I/O              | I/O              | I/O              |
| 63         | I/O              | I/O              | I/O              |
| 64         | NC               | I/O              | I/O              |
| 65         | I/O              | I/O              | I/O              |
| 66         | NC               | I/O              | I/O              |
| 67         | GND              | GND              | GND              |
| 68         | VCCA             | VCCA             | VCCA             |
| 69         | I/O              | I/O              | WD, I/O          |
| 70         | I/O              | I/O              | WD, I/O          |
| 71         | I/O              | I/O              | I/O              |
| 72         | I/O              | I/O              | I/O              |

| TQ176      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 73         | I/O              | I/O              | I/O              |
| 74         | NC               | I/O              | I/O              |
| 75         | I/O              | I/O              | I/O              |
| 76         | I/O              | I/O              | I/O              |
| 77         | NC               | NC               | WD, I/O          |
| 78         | NC               | I/O              | WD, I/O          |
| 79         | I/O              | I/O              | I/O              |
| 80         | NC               | I/O              | I/O              |
| 81         | I/O              | I/O              | I/O              |
| 82         | NC               | VCCI             | VCCI             |
| 83         | I/O              | I/O              | I/O              |
| 84         | I/O              | I/O              | WD, I/O          |
| 85         | I/O              | I/O              | WD, I/O          |
| 86         | NC               | I/O              | I/O              |
| 87         | SDO, I/O         | SDO, I/O         | SDO, TDO, I/O    |
| 88         | I/O              | I/O              | I/O              |
| 89         | GND              | GND              | GND              |
| 90         | I/O              | I/O              | I/O              |
| 91         | I/O              | I/O              | I/O              |
| 92         | I/O              | I/O              | I/O              |
| 93         | I/O              | I/O              | I/O              |
| 94         | I/O              | I/O              | I/O              |
| 95         | I/O              | I/O              | I/O              |
| 96         | NC               | I/O              | I/O              |
| 97         | NC               | I/O              | I/O              |
| 98         | I/O              | I/O              | I/O              |
| 99         | I/O              | I/O              | I/O              |
| 100        | I/O              | I/O              | I/O              |
| 101        | NC               | NC               | I/O              |
| 102        | I/O              | I/O              | I/O              |
| 103        | NC               | I/O              | I/O              |
| 104        | I/O              | I/O              | I/O              |
| 105        | I/O              | I/O              | I/O              |
| 106        | GND              | GND              | GND              |
| 107        | NC               | I/O              | I/O              |
| 108        | NC               | I/O              | TCK, I/O         |

| TQ176      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 109        | LP               | LP               | LP               |
| 110        | VCCA             | VCCA             | VCCA             |
| 111        | GND              | GND              | GND              |
| 112        | VCCI             | VCCI             | VCCI             |
| 113        | VCCA             | VCCA             | VCCA             |
| 114        | NC               | I/O              | I/O              |
| 115        | NC               | I/O              | I/O              |
| 116        | NC               | VCCA             | VCCA             |
| 117        | I/O              | I/O              | I/O              |
| 118        | I/O              | I/O              | I/O              |
| 119        | I/O              | I/O              | I/O              |
| 120        | I/O              | I/O              | I/O              |
| 121        | NC               | NC               | I/O              |
| 122        | I/O              | I/O              | I/O              |
| 123        | I/O              | I/O              | I/O              |
| 124        | NC               | I/O              | I/O              |
| 125        | NC               | I/O              | I/O              |
| 126        | NC               | NC               | I/O              |
| 127        | I/O              | I/O              | I/O              |
| 128        | I/O              | I/O              | I/O              |
| 129        | I/O              | I/O              | I/O              |
| 130        | I/O              | I/O              | I/O              |
| 131        | I/O              | I/O              | I/O              |
| 132        | I/O              | I/O              | I/O              |
| 133        | GND              | GND              | GND              |
| 134        | I/O              | I/O              | I/O              |
| 135        | SDI, I/O         | SDI, I/O         | SDI, I/O         |
| 136        | NC               | I/O              | I/O              |
| 137        | I/O              | I/O              | WD, I/O          |
| 138        | I/O              | I/O              | WD, I/O          |
| 139        | I/O              | I/O              | I/O              |
| 140        | NC               | VCCI             | VCCI             |
| 141        | I/O              | I/O              | I/O              |
| 142        | I/O              | I/O              | I/O              |
| 143        | NC               | I/O              | I/O              |
| 144        | NC               | I/O              | WD, I/O          |

| TQ176      |                  |                  |                  |
|------------|------------------|------------------|------------------|
| Pin Number | A42MX09 Function | A42MX16 Function | A42MX24 Function |
| 145        | NC               | NC               | WD, I/O          |
| 146        | I/O              | I/O              | I/O              |
| 147        | NC               | I/O              | I/O              |
| 148        | I/O              | I/O              | I/O              |
| 149        | I/O              | I/O              | I/O              |
| 150        | I/O              | I/O              | WD, I/O          |
| 151        | NC               | I/O              | WD, I/O          |
| 152        | PRA, I/O         | PRA, I/O         | PRA, I/O         |
| 153        | I/O              | I/O              | I/O              |
| 154        | CLKA, I/O        | CLKA, I/O        | CLKA, I/O        |
| 155        | VCCA             | VCCA             | VCCA             |
| 156        | GND              | GND              | GND              |
| 157        | I/O              | I/O              | I/O              |
| 158        | CLKB, I/O        | CLKB, I/O        | CLKB, I/O        |
| 159        | I/O              | I/O              | I/O              |
| 160        | PRB, I/O         | PRB, I/O         | PRB, I/O         |
| 161        | NC               | I/O              | WD, I/O          |
| 162        | I/O              | I/O              | WD, I/O          |
| 163        | I/O              | I/O              | I/O              |
| 164        | I/O              | I/O              | I/O              |
| 165        | NC               | NC               | WD, I/O          |
| 166        | NC               | I/O              | WD, I/O          |
| 167        | I/O              | I/O              | I/O              |
| 168        | NC               | I/O              | I/O              |
| 169        | I/O              | I/O              | I/O              |
| 170        | NC               | VCCI             | VCCI             |
| 171        | I/O              | I/O              | WD, I/O          |
| 172        | I/O              | I/O              | WD, I/O          |
| 173        | NC               | I/O              | I/O              |
| 174        | I/O              | I/O              | I/O              |
| 175        | DCLK, I/O        | DCLK, I/O        | DCLK, I/O        |
| 176        | I/O              | I/O              | I/O              |

## CQ208



| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 1          | GND              |
| 2          | VCCA             |
| 3          | MODE             |
| 4          | I/O              |
| 5          | I/O              |
| 6          | I/O              |
| 7          | I/O              |
| 8          | I/O              |
| 9          | I/O              |
| 10         | I/O              |
| 11         | I/O              |
| 12         | I/O              |
| 13         | I/O              |
| 14         | I/O              |
| 15         | I/O              |
| 16         | I/O              |
| 17         | VCCA             |
| 18         | I/O              |
| 19         | I/O              |
| 20         | I/O              |
| 21         | I/O              |
| 22         | GND              |
| 23         | I/O              |
| 24         | I/O              |
| 25         | I/O              |
| 26         | I/O              |
| 27         | GND              |
| 28         | VCCI             |
| 29         | VCCA             |
| 30         | I/O              |
| 31         | I/O              |
| 32         | VCCA             |
| 33         | I/O              |
| 34         | I/O              |
| 35         | I/O              |
| 36         | I/O              |

| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 37         | I/O              |
| 38         | I/O              |
| 39         | I/O              |
| 40         | I/O              |
| 41         | I/O              |
| 42         | I/O              |
| 43         | I/O              |
| 44         | I/O              |
| 45         | I/O              |
| 46         | I/O              |
| 47         | I/O              |
| 48         | I/O              |
| 49         | I/O              |
| 50         | I/O              |
| 51         | I/O              |
| 52         | GND              |
| 53         | GND              |
| 54         | TMS, I/O         |
| 55         | TDI, I/O         |
| 56         | I/O              |
| 57         | WD, I/O          |
| 58         | WD, I/O          |
| 59         | I/O              |
| 60         | VCCI             |
| 61         | I/O              |
| 62         | I/O              |
| 63         | I/O              |
| 64         | I/O              |
| 65         | QCLKA, I/O       |
| 66         | WD, I/O          |
| 67         | WD, I/O          |
| 68         | I/O              |
| 69         | I/O              |
| 70         | WD, I/O          |
| 71         | WD, I/O          |
| 72         | I/O              |

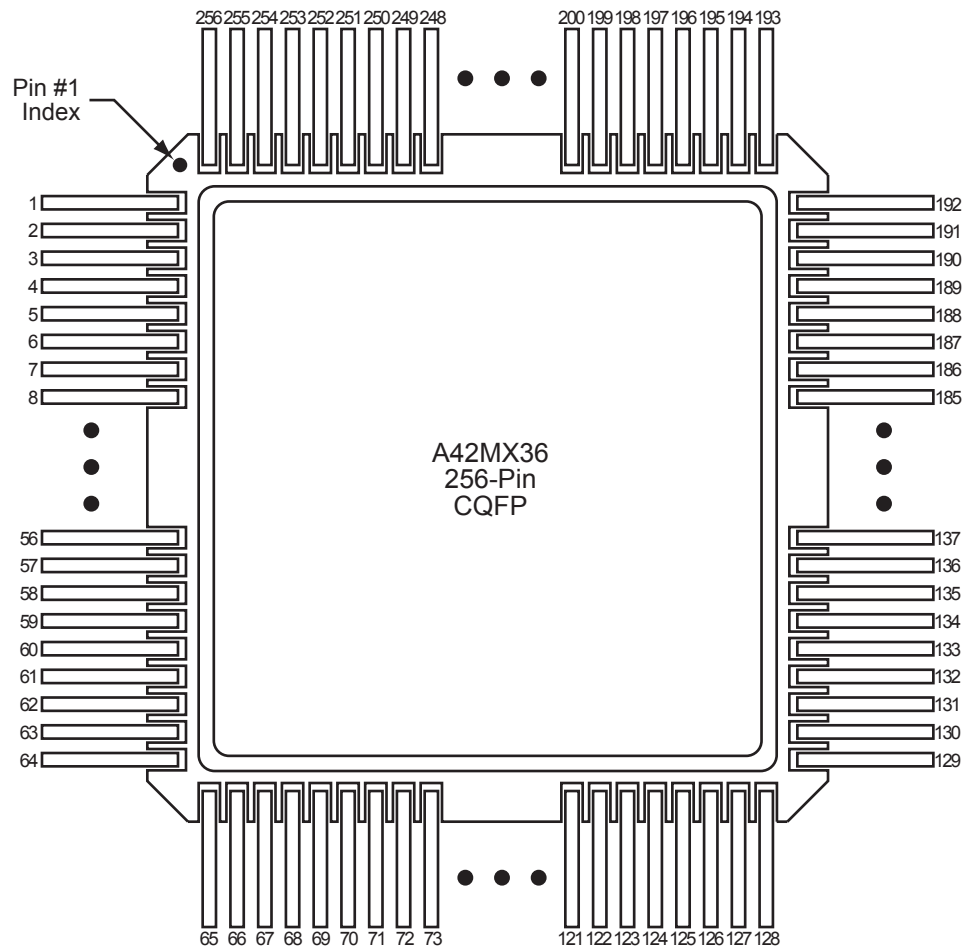
| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 73         | I/O              |
| 74         | I/O              |
| 75         | I/O              |
| 76         | I/O              |
| 77         | I/O              |
| 78         | GND              |
| 79         | VCCA             |
| 80         | VCCI             |
| 81         | I/O              |
| 82         | I/O              |
| 83         | I/O              |
| 84         | I/O              |
| 85         | WD, I/O          |
| 86         | WD, I/O          |
| 87         | I/O              |
| 88         | I/O              |
| 89         | I/O              |
| 90         | I/O              |
| 91         | QCLKB, I/O       |
| 92         | I/O              |
| 93         | WD, I/O          |
| 94         | WD, I/O          |
| 95         | I/O              |
| 96         | I/O              |
| 97         | I/O              |
| 98         | VCCI             |
| 99         | I/O              |
| 100        | WD, I/O          |
| 101        | WD, I/O          |
| 102        | I/O              |
| 103        | TDO, I/O         |
| 104        | I/O              |
| 105        | GND              |
| 106        | VCCA             |
| 107        | I/O              |
| 108        | I/O              |

| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 109        | I/O              |
| 110        | I/O              |
| 111        | I/O              |
| 112        | I/O              |
| 113        | I/O              |
| 114        | I/O              |
| 115        | I/O              |
| 116        | I/O              |
| 117        | I/O              |
| 118        | I/O              |
| 119        | I/O              |
| 120        | I/O              |
| 121        | I/O              |
| 122        | I/O              |
| 123        | I/O              |
| 124        | I/O              |
| 125        | I/O              |
| 126        | GND              |
| 127        | I/O              |
| 128        | TCK, I/O         |
| 129        | LP               |
| 130        | VCCA             |
| 131        | GND              |
| 132        | VCCI             |
| 133        | VCCA             |
| 134        | I/O              |
| 135        | I/O              |
| 136        | VCCA             |
| 137        | I/O              |
| 138        | I/O              |
| 139        | I/O              |
| 140        | I/O              |
| 141        | I/O              |
| 142        | I/O              |
| 143        | I/O              |
| 144        | I/O              |

| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 145        | I/O              |
| 146        | I/O              |
| 147        | I/O              |
| 148        | I/O              |
| 149        | I/O              |
| 150        | GND              |
| 151        | I/O              |
| 152        | I/O              |
| 153        | I/O              |
| 154        | I/O              |
| 155        | I/O              |
| 156        | I/O              |
| 157        | GND              |
| 158        | I/O              |
| 159        | SDI, I/O         |
| 160        | I/O              |
| 161        | WD, I/O          |
| 162        | WD, I/O          |
| 163        | I/O              |
| 164        | VCCI             |
| 165        | I/O              |
| 166        | I/O              |
| 167        | I/O              |
| 168        | WD, I/O          |
| 169        | WD, I/O          |
| 170        | I/O              |
| 171        | QCLKD, I/O       |
| 172        | I/O              |
| 173        | I/O              |
| 174        | I/O              |
| 175        | I/O              |
| 176        | WD, I/O          |
| 177        | WD, I/O          |
| 178        | PRA, I/O         |
| 179        | I/O              |
| 180        | CLKA, I/O        |

| CQ208      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 181        | I/O              |
| 182        | VCCI             |
| 183        | VCCA             |
| 184        | GND              |
| 185        | I/O              |
| 186        | CLKB, I/O        |
| 187        | I/O              |
| 188        | PRB, I/O         |
| 189        | I/O              |
| 190        | WD, I/O          |
| 191        | WD, I/O          |
| 192        | I/O              |
| 193        | I/O              |
| 194        | WD, I/O          |
| 195        | WD, I/O          |
| 196        | QCLKC, I/O       |
| 197        | I/O              |
| 198        | I/O              |
| 199        | I/O              |
| 200        | I/O              |
| 201        | I/O              |
| 202        | VCCI             |
| 203        | WD, I/O          |
| 204        | WD, I/O          |
| 205        | I/O              |
| 206        | I/O              |
| 207        | DCLK, I/O        |
| 208        | I/O              |

## CQ256



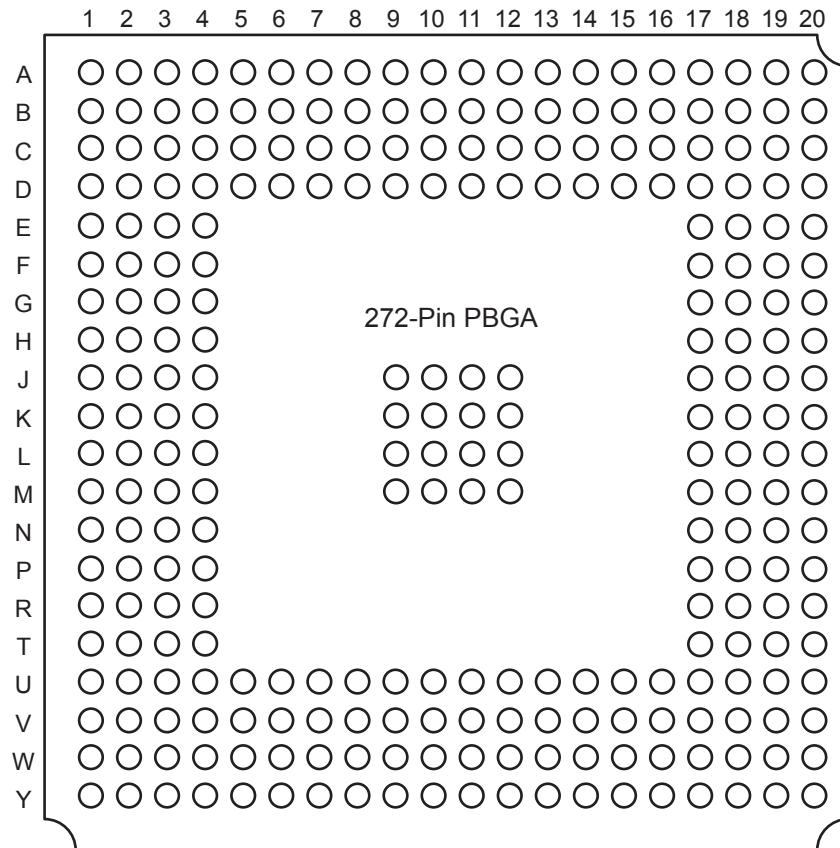
| CQ256      |                  | CQ256      |                  | CQ256      |                  |
|------------|------------------|------------|------------------|------------|------------------|
| Pin Number | A42MX36 Function | Pin Number | A42MX36 Function | Pin Number | A42MX36 Function |
| 1          | NC               | 37         | I/O              | 73         | I/O              |
| 2          | GND              | 38         | I/O              | 74         | I/O              |
| 3          | I/O              | 39         | I/O              | 75         | I/O              |
| 4          | I/O              | 40         | I/O              | 76         | WD, I/O          |
| 5          | I/O              | 41         | I/O              | 77         | GND              |
| 6          | I/O              | 42         | I/O              | 78         | WD, I/O          |
| 7          | I/O              | 43         | I/O              | 79         | I/O              |
| 8          | I/O              | 44         | I/O              | 80         | QCLKB, I/O       |
| 9          | I/O              | 45         | I/O              | 81         | I/O              |
| 10         | GND              | 46         | I/O              | 82         | I/O              |
| 11         | I/O              | 47         | I/O              | 83         | I/O              |
| 12         | I/O              | 48         | GND              | 84         | I/O              |
| 13         | I/O              | 49         | I/O              | 85         | I/O              |
| 14         | I/O              | 50         | I/O              | 86         | I/O              |
| 15         | I/O              | 51         | I/O              | 87         | WD, I/O          |
| 16         | I/O              | 52         | I/O              | 88         | WD, I/O          |
| 17         | I/O              | 53         | I/O              | 89         | I/O              |
| 18         | I/O              | 54         | I/O              | 90         | I/O              |
| 19         | I/O              | 55         | I/O              | 91         | I/O              |
| 20         | I/O              | 56         | I/O              | 92         | I/O              |
| 21         | I/O              | 57         | I/O              | 93         | I/O              |
| 22         | I/O              | 58         | I/O              | 94         | I/O              |
| 23         | I/O              | 59         | I/O              | 95         | VCCI             |
| 24         | I/O              | 60         | VCCA             | 96         | VCCA             |
| 25         | I/O              | 61         | GND              | 97         | GND              |
| 26         | VCCA             | 62         | GND              | 98         | GND              |
| 27         | I/O              | 63         | NC               | 99         | I/O              |
| 28         | I/O              | 64         | NC               | 100        | I/O              |
| 29         | VCCA             | 65         | NC               | 101        | I/O              |
| 30         | VCCI             | 66         | I/O              | 102        | I/O              |
| 31         | GND              | 67         | SDO, TDO, I/O    | 103        | I/O              |
| 32         | VCCA             | 68         | I/O              | 104        | I/O              |
| 33         | LP               | 69         | WD, I/O          | 105        | WD, I/O          |
| 34         | TCK, I/O         | 70         | WD, I/O          | 106        | WD, I/O          |
| 35         | I/O              | 71         | I/O              | 107        | I/O              |
| 36         | GND              | 72         | VCCI             | 108        | I/O              |

| CQ256      |                  | CQ256      |                  | CQ256      |                  |
|------------|------------------|------------|------------------|------------|------------------|
| Pin Number | A42MX36 Function | Pin Number | A42MX36 Function | Pin Number | A42MX36 Function |
| 109        | WD, I/O          | 145        | I/O              | 181        | I/O              |
| 110        | WD, I/O          | 146        | I/O              | 182        | I/O              |
| 111        | I/O              | 147        | I/O              | 183        | I/O              |
| 112        | QCLKA, I/O       | 148        | I/O              | 184        | I/O              |
| 113        | I/O              | 149        | I/O              | 185        | I/O              |
| 114        | GND              | 150        | I/O              | 186        | I/O              |
| 115        | I/O              | 151        | I/O              | 187        | I/O              |
| 116        | I/O              | 152        | I/O              | 188        | MODE             |
| 117        | I/O              | 153        | I/O              | 189        | VCCA             |
| 118        | I/O              | 154        | I/O              | 190        | GND              |
| 119        | VCCI             | 155        | VCCA             | 191        | NC               |
| 120        | I/O              | 156        | I/O              | 192        | NC               |
| 121        | WD, I/O          | 157        | I/O              | 193        | NC               |
| 122        | WD, I/O          | 158        | VCCA             | 194        | I/O              |
| 123        | I/O              | 159        | VCCI             | 195        | DCLK, I/O        |
| 124        | I/O              | 160        | GND              | 196        | I/O              |
| 125        | I/O              | 161        | I/O              | 197        | I/O              |
| 126        | I/O              | 162        | I/O              | 198        | I/O              |
| 127        | GND              | 163        | I/O              | 199        | WD, I/O          |
| 128        | NC               | 164        | I/O              | 200        | WD, I/O          |
| 129        | NC               | 165        | GND              | 201        | VCCI             |
| 130        | NC               | 166        | I/O              | 202        | I/O              |
| 131        | GND              | 167        | I/O              | 203        | I/O              |
| 132        | I/O              | 168        | I/O              | 204        | I/O              |
| 133        | I/O              | 169        | I/O              | 205        | I/O              |
| 134        | I/O              | 170        | VCCA             | 206        | GND              |
| 135        | I/O              | 171        | I/O              | 207        | I/O              |
| 136        | I/O              | 172        | I/O              | 208        | I/O              |
| 137        | I/O              | 173        | I/O              | 209        | QCLKC, I/O       |
| 138        | I/O              | 174        | I/O              | 210        | I/O              |
| 139        | GND              | 175        | I/O              | 211        | WD, I/O          |
| 140        | I/O              | 176        | I/O              | 212        | WD, I/O          |
| 141        | I/O              | 177        | I/O              | 213        | I/O              |
| 142        | I/O              | 178        | I/O              | 214        | I/O              |
| 143        | I/O              | 179        | I/O              | 215        | WD, I/O          |
| 144        | I/O              | 180        | GND              | 216        | WD, I/O          |

| CQ256      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 217        | I/O              |
| 218        | PRB, I/O         |
| 219        | I/O              |
| 220        | CLKB, I/O        |
| 221        | I/O              |
| 222        | GND              |
| 223        | GND              |
| 224        | VCCA             |
| 225        | VCCI             |
| 226        | I/O              |
| 227        | CLKA, I/O        |
| 228        | I/O              |
| 229        | PRA, I/O         |
| 230        | I/O              |
| 231        | I/O              |
| 232        | WD, I/O          |
| 233        | WD, I/O          |
| 234        | I/O              |
| 235        | I/O              |
| 236        | I/O              |
| 237        | I/O              |
| 238        | I/O              |
| 239        | I/O              |
| 240        | QCLKD, I/O       |
| 241        | I/O              |
| 242        | WD, I/O          |
| 243        | GND              |
| 244        | WD, I/O          |
| 245        | I/O              |
| 246        | I/O              |
| 247        | I/O              |
| 248        | VCCI             |
| 249        | I/O              |
| 250        | WD, I/O          |
| 251        | WD, I/O          |
| 252        | I/O              |

| CQ256      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| 253        | SDI, I/O         |
| 254        | I/O              |
| 255        | GND              |
| 256        | NC               |

## BG272



| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| A1         | GND              |
| A2         | GND              |
| A3         | I/O              |
| A4         | WD, I/O          |
| A5         | I/O              |
| A6         | I/O              |
| A7         | WD, I/O          |
| A8         | WD, I/O          |
| A9         | I/O              |
| A10        | I/O              |
| A11        | CLKA             |
| A12        | I/O              |
| A13        | I/O              |
| A14        | I/O              |
| A15        | I/O              |
| A16        | WD, I/O          |
| A17        | I/O              |
| A18        | I/O              |
| A19        | GND              |
| A20        | GND              |
| B1         | GND              |
| B2         | GND              |
| B3         | DCLK, I/O        |
| B4         | I/O              |
| B5         | I/O              |
| B6         | I/O              |
| B7         | WD, I/O          |
| B8         | I/O              |
| B9         | PRB, I/O         |
| B10        | I/O              |
| B11        | I/O              |
| B12        | WD, I/O          |
| B13        | I/O              |
| B14        | I/O              |
| B15        | WD, I/O          |
| B16        | I/O              |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| B17        | WD, I/O          |
| B18        | I/O              |
| B19        | GND              |
| B20        | GND              |
| C1         | I/O              |
| C2         | MODE             |
| C3         | GND              |
| C4         | I/O              |
| C5         | WD, I/O          |
| C6         | I/O              |
| C7         | QCLKC, I/O       |
| C8         | I/O              |
| C9         | I/O              |
| C10        | CLKB             |
| C11        | PRA, I/O         |
| C12        | WD, I/O          |
| C13        | I/O              |
| C14        | QCLKD, I/O       |
| C15        | I/O              |
| C16        | WD, I/O          |
| C17        | SDI, I/O         |
| C18        | I/O              |
| C19        | I/O              |
| C20        | I/O              |
| D1         | I/O              |
| D2         | I/O              |
| D3         | I/O              |
| D4         | I/O              |
| D5         | VCCI             |
| D6         | I/O              |
| D7         | I/O              |
| D8         | VCCA             |
| D9         | WD, I/O          |
| D10        | VCCI             |
| D11        | I/O              |
| D12        | VCCI             |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| D13        | I/O              |
| D14        | VCCI             |
| D15        | I/O              |
| D16        | VCCA             |
| D17        | GND              |
| D18        | I/O              |
| D19        | I/O              |
| D20        | I/O              |
| E1         | I/O              |
| E2         | I/O              |
| E3         | I/O              |
| E4         | VCCA             |
| E17        | VCCI             |
| E18        | I/O              |
| E19        | I/O              |
| E20        | I/O              |
| F1         | I/O              |
| F2         | I/O              |
| F3         | I/O              |
| F4         | VCCI             |
| F17        | I/O              |
| F18        | I/O              |
| F19        | I/O              |
| F20        | I/O              |
| G1         | I/O              |
| G2         | I/O              |
| G3         | I/O              |
| G4         | VCCI             |
| G17        | VCCI             |
| G18        | I/O              |
| G19        | I/O              |
| G20        | I/O              |
| H1         | I/O              |
| H2         | I/O              |
| H3         | I/O              |
| H4         | VCCA             |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| H17        | I/O              |
| H18        | I/O              |
| H19        | I/O              |
| H20        | I/O              |
| J1         | I/O              |
| J2         | I/O              |
| J3         | I/O              |
| J4         | VCCI             |
| J9         | GND              |
| J10        | GND              |
| J11        | GND              |
| J12        | GND              |
| J17        | VCCA             |
| J18        | I/O              |
| J19        | I/O              |
| J20        | I/O              |
| K1         | I/O              |
| K2         | I/O              |
| K3         | I/O              |
| K4         | VCCI             |
| K9         | GND              |
| K10        | GND              |
| K11        | GND              |
| K12        | GND              |
| K17        | I/O              |
| K18        | VCCA             |
| K19        | VCCA             |
| K20        | LP               |
| L1         | I/O              |
| L2         | I/O              |
| L3         | VCCA             |
| L4         | VCCA             |
| L9         | GND              |
| L10        | GND              |
| L11        | GND              |
| L12        | GND              |

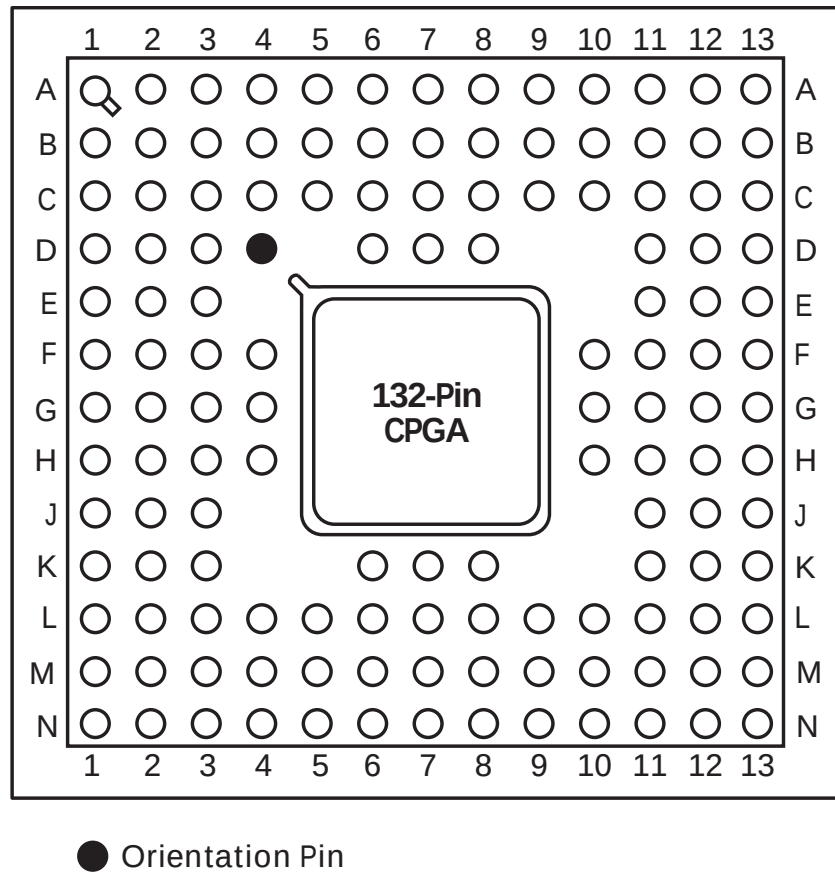
| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| L17        | VCCI             |
| L18        | I/O              |
| L19        | I/O              |
| L20        | TCK, I/O         |
| M1         | I/O              |
| M2         | I/O              |
| M3         | I/O              |
| M4         | VCCI             |
| M9         | GND              |
| M10        | GND              |
| M11        | GND              |
| M12        | GND              |
| M17        | I/O              |
| M18        | I/O              |
| M19        | I/O              |
| M20        | I/O              |
| N1         | I/O              |
| N2         | I/O              |
| N3         | I/O              |
| N4         | VCCI             |
| N17        | VCCI             |
| N18        | I/O              |
| N19        | I/O              |
| N20        | I/O              |
| P1         | I/O              |
| P2         | I/O              |
| P3         | I/O              |
| P4         | VCCA             |
| P17        | I/O              |
| P18        | I/O              |
| P19        | I/O              |
| P20        | I/O              |
| R1         | I/O              |
| R2         | I/O              |
| R3         | I/O              |
| R4         | VCCI             |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| R17        | VCCI             |
| R18        | I/O              |
| R19        | I/O              |
| R20        | I/O              |
| T1         | I/O              |
| T2         | I/O              |
| T3         | I/O              |
| T4         | I/O              |
| T17        | VCCA             |
| T18        | I/O              |
| T19        | I/O              |
| T20        | I/O              |
| U1         | I/O              |
| U2         | I/O              |
| U3         | I/O              |
| U4         | I/O              |
| U5         | VCCI             |
| U6         | WD, I/O          |
| U7         | I/O              |
| U8         | I/O              |
| U9         | WD, I/O          |
| U10        | VCCA             |
| U11        | VCCI             |
| U12        | I/O              |
| U13        | I/O              |
| U14        | QCLKB, I/O       |
| U15        | I/O              |
| U16        | VCCI             |
| U17        | I/O              |
| U18        | GND              |
| U19        | I/O              |
| U20        | I/O              |
| V1         | I/O              |
| V2         | I/O              |
| V3         | GND              |
| V4         | GND              |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| V5         | I/O              |
| V6         | I/O              |
| V7         | I/O              |
| V8         | WD, I/O          |
| V9         | I/O              |
| V10        | I/O              |
| V11        | I/O              |
| V12        | I/O              |
| V13        | WD, I/O          |
| V14        | I/O              |
| V15        | WD, I/O          |
| V16        | I/O              |
| V17        | I/O              |
| V18        | SDO, TDO, I/O    |
| V19        | I/O              |
| V20        | I/O              |
| W1         | GND              |
| W2         | GND              |
| W3         | I/O              |
| W4         | TMS, I/O         |
| W5         | I/O              |
| W6         | I/O              |
| W7         | I/O              |
| W8         | WD, I/O          |
| W9         | WD, I/O          |
| W10        | I/O              |
| W11        | I/O              |
| W12        | I/O              |
| W13        | WD, I/O          |
| W14        | I/O              |
| W15        | I/O              |
| W16        | WD, I/O          |
| W17        | I/O              |
| W18        | WD, I/O          |
| W19        | GND              |
| W20        | GND              |

| BG272      |                  |
|------------|------------------|
| Pin Number | A42MX36 Function |
| Y1         | GND              |
| Y2         | GND              |
| Y3         | I/O              |
| Y4         | TDI, I/O         |
| Y5         | WD, I/O          |
| Y6         | I/O              |
| Y7         | QCLKA, I/O       |
| Y8         | I/O              |
| Y9         | I/O              |
| Y10        | I/O              |
| Y11        | I/O              |
| Y12        | I/O              |
| Y13        | I/O              |
| Y14        | I/O              |
| Y15        | I/O              |
| Y16        | I/O              |
| Y17        | I/O              |
| Y18        | WD, I/O          |
| Y19        | GND              |
| Y20        | GND              |

## PG132



| PG132      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| –          | PMPOUT           |
| B2         | I/O              |
| A1         | MODE             |
| B1         | I/O              |
| D3         | I/O              |
| C2         | I/O              |
| C1         | I/O              |
| D2         | I/O              |
| D1         | I/O              |
| E2         | I/O              |
| E1         | I/O              |
| F3         | I/O              |
| F2         | I/O              |
| F1         | I/O              |
| G1         | I/O              |
| G4         | VSV              |
| H1         | I/O              |
| H2         | I/O              |
| H3         | I/O              |
| H4         | I/O              |
| J1         | I/O              |
| K1         | I/O              |
| L1         | I/O              |
| K2         | I/O              |
| M1         | I/O              |
| K3         | I/O              |
| L2         | I/O              |
| N1         | I/O              |
| L3         | BININ            |
| M2         | BINOUT           |
| N2         | I/O              |
| M3         | I/O              |
| L4         | I/O              |
| N3         | I/O              |
| M4         | I/O              |

| PG132      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| N4         | I/O              |
| M5         | I/O              |
| K6         | I/O              |
| N5         | I/O              |
| N6         | I/O              |
| L6         | I/O              |
| M6         | I/O              |
| M7         | I/O              |
| N7         | I/O              |
| N8         | I/O              |
| M8         | I/O              |
| L8         | I/O              |
| K8         | I/O              |
| N9         | I/O              |
| N10        | I/O              |
| M10        | I/O              |
| N11        | I/O              |
| L10        | I/O              |
| M11        | I/O              |
| N12        | SDO              |
| M12        | I/O              |
| L11        | I/O              |
| N13        | I/O              |
| M13        | I/O              |
| K11        | I/O              |
| L12        | I/O              |
| L13        | I/O              |
| K13        | I/O              |
| H10        | I/O              |
| J12        | I/O              |
| J13        | I/O              |
| H11        | I/O              |
| H12        | I/O              |
| H13        | VKS              |
| G13        | VPP              |

| PG132      |                  |
|------------|------------------|
| Pin Number | A42MX09 Function |
| G12        | VSV              |
| F13        | I/O              |
| F12        | I/O              |
| F11        | I/O              |
| F10        | I/O              |
| E13        | I/O              |
| D13        | I/O              |
| D12        | I/O              |
| C13        | I/O              |
| B13        | I/O              |
| D11        | I/O              |
| C12        | I/O              |
| A13        | I/O              |
| C11        | I/O              |
| B12        | SDI              |
| B11        | I/O              |
| C10        | I/O              |
| A12        | I/O              |
| A11        | I/O              |
| B10        | I/O              |
| D8         | I/O              |
| A10        | I/O              |
| C8         | I/O              |
| A9         | I/O              |
| B8         | PRBA             |
| A8         | I/O              |
| B7         | CLKA             |
| A7         | I/O              |
| B6         | CLKB             |
| A6         | I/O              |
| C6         | PRBB             |
| A5         | I/O              |
| D6         | I/O              |
| A4         | I/O              |
| B4         | I/O              |

| PG132      |          |
|------------|----------|
| A42MX09    |          |
| Pin Number | Function |
| A3         | I/O      |
| C4         | I/O      |
| B3         | I/O      |
| A2         | I/O      |
| C3         | DCLK     |
| B5         | GNDA     |
| E12        | GNDA     |
| J2         | GNDA     |
| M9         | GNDA     |
| B9         | GNDI     |
| C5         | GNDI     |
| E11        | GNDI     |
| F4         | GNDI     |
| J3         | GNDI     |
| J11        | GNDI     |
| L5         | GNDI     |
| L9         | GNDI     |
| C9         | GNDQ     |
| E3         | GNDQ     |
| K12        | GNDQ     |
| D7         | VCCA     |
| G3         | VCCA     |
| G10        | VCCA     |
| L7         | VCCA     |
| C7         | VCCI     |
| G2         | VCCI     |
| G11        | VCCI     |
| K7         | VCCI     |

## 3 – Datasheet Information

### List of Changes

The following table lists critical changes that were made in the current version of the document.

| Revision                         | Changes                                                                                                                                                                                                           | Page |
|----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| Revision 13<br>(August 2015)     | Added "PQ144" Package for A42MX09 device (SAR 69776).                                                                                                                                                             | 2-13 |
|                                  | Added "PG132" Package for A42MX09 device (SAR 69776).                                                                                                                                                             | 2-54 |
| Revision 12<br>(March 2014)      | Added information on power-up behavior for A42MX24 and A42MX36 devices to the "Power Supply" section (SAR 42096).                                                                                                 | 1-9  |
|                                  | Corrected the inadvertent mistake in the naming of the PL68 pin assignment table (SARs 48999, 49793).                                                                                                             | 2-4  |
| Revision 11<br>(May 2012)        | The FuseLock logo and accompanying text was removed from the "User Security" section. This marking is no longer used on Microsemi devices (PCN 0915).                                                             | 1-8  |
|                                  | The "Development Tool Support" section was updated (SAR 38512).                                                                                                                                                   | 1-16 |
| Revision 10<br>(April 2012)      | "Ordering Information" was updated to include lead-free package ordering codes (SAR 21968).                                                                                                                       | iii  |
|                                  | The "User Security" section was revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 34673). | 1-8  |
|                                  | The "Transient Current" section is new (SAR 36930).                                                                                                                                                               | 1-9  |
|                                  | Package names were revised according to standards established in <i>Package Mechanical Drawings</i> (SAR 34774).                                                                                                  | 2-1  |
| Revision 9<br>(v6.1, April 2009) | In Table 1-14 • Absolute Maximum Ratings*, the limits in VI were changed from -0.5 to VCCI + 0.5 to -0.5 to VCCA + 0.5.                                                                                           | 1-21 |
|                                  | In Table 1-16 • Mixed 5.0V/3.3V Electrical Specifications, VOH was changed from 3.7 to 2.4 for the min in industrial and military. VIH had VCCI and that was changed to VCCA.                                     | 1-22 |

| Revision               | Changes                                                                    | Page |
|------------------------|----------------------------------------------------------------------------|------|
| v6.0<br>(January 2004) | The "Ease of Integration" section was updated.                             | 1-i  |
|                        | The "Temperature Grade Offerings" section is new.                          | 1-iv |
|                        | The "Speed Grade Offerings" section is new.                                | 1-v  |
|                        | The "General Description" section was updated.                             | 1-1  |
|                        | The "MultiPlex I/O Modules" section was updated.                           | 1-7  |
|                        | The "User Security" section was updated.                                   | 1-8  |
|                        | Table 1-1 • Voltage Support of MX Devices was updated.                     | 1-9  |
|                        | The "Power Dissipation" section was updated.                               | 1-10 |
|                        | The "Static Power Component" section was updated.                          | 1-10 |
|                        | The "Equivalent Capacitance" section was updated.                          | 1-10 |
|                        | Figure 1-12 • Silicon Explorer II Setup with 42MX was updated.             | 1-12 |
|                        | Table 1-4 • Supported BST Public Instructions was updated.                 | 1-14 |
|                        | Figure 1-13 • 42MX IEEE 1149.1 Boundary Scan Circuitry was updated.        | 1-14 |
|                        | Table 1-5 • Boundary Scan Pin Configuration and Functionality was updated. | 1-15 |

| Revision            | Changes                                                                                                                                                                                                                                                                       | Page |
|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| v6.0<br>(continued) | The "Development Tool Support" section was updated.                                                                                                                                                                                                                           | 1-16 |
|                     | The Table 1-7 • Absolute Maximum Ratings for 42MX Devices* and the Table 1-6 • Absolute Maximum Ratings for 40MX Devices* were updated.                                                                                                                                       | 1-17 |
|                     | The Table 1-9 • 5V TTL Electrical Specifications was updated.                                                                                                                                                                                                                 | 1-18 |
|                     | The Table 1-13 • 3.3V LVTTTL Electrical Specifications was updated.                                                                                                                                                                                                           | 1-20 |
|                     | In the "Mixed 5.0V/3.3V Electrical Specifications" section, Table 1-14 • Absolute Maximum Ratings*, Table 1-15 • Recommended Operating Conditions, and Table 1-16 • Mixed 5.0V/3.3V Electrical Specifications were updated.                                                   | 1-21 |
|                     | Table 1-17 • DC Specification (5.0 V PCI Signaling) <sup>1</sup> was updated.                                                                                                                                                                                                 | 1-23 |
|                     | Table 1-19 • DC Specification (3.3 V PCI Signaling) <sup>1</sup> was updated.                                                                                                                                                                                                 | 1-24 |
|                     | The "Junction Temperature (T <sub>J</sub> )" section, "Package Thermal Characteristics" section, and the tables were updated.                                                                                                                                                 | 1-26 |
|                     | Figure 1-16 • 40MX Timing Model* was updated.                                                                                                                                                                                                                                 | 1-27 |
|                     | Figure 1-18 • 42MX Timing Model (Logic Functions Using Quadrant Clocks) was updated.                                                                                                                                                                                          | 1-28 |
|                     | Figure 1-19 • 42MX Timing Model (SRAM Functions) was updated.                                                                                                                                                                                                                 | 1-29 |
|                     | Figure 1-26 • Output Buffer Latches was updated.                                                                                                                                                                                                                              | 1-32 |
|                     | Table 1-22 • 42MX Temperature and Voltage Derating Factors is new.                                                                                                                                                                                                            | 1-36 |
|                     | Table 1-23 • 40MX Temperature and Voltage Derating Factors is new.                                                                                                                                                                                                            | 1-36 |
|                     | The "Pin Descriptions" section was updated.                                                                                                                                                                                                                                   | 1-83 |
|                     | In the "PQ100" table, Pin 64 (42MX09 and 42MX16) has changed to LP.                                                                                                                                                                                                           | 2-10 |
|                     | In the "PQ160" table, Pin 61 (42MX09, 42MX16, and 42MX64) has changed to LP.                                                                                                                                                                                                  | 2-17 |
|                     | In the "PQ208" table, the following pins changed:<br>Pin 129 (42MX09, 42MX16, and 42MX64) has changed to LP.<br>Pin 198 (42MX09) has changed to I/O.                                                                                                                          | 2-23 |
|                     | In the "PQ240" table, Pin 91 (42MX36) has changed to LP.                                                                                                                                                                                                                      | 2-30 |
|                     | In the "VQ100" table, Pin 62 (42MX09 and 42MX16) has changed to LP.                                                                                                                                                                                                           | 2-36 |
|                     | In the "TQ176" table, Pin 109 (42MX09 and 42MX16) has changed to LP.                                                                                                                                                                                                          | 2-38 |
|                     | In the "BG272" table, Pin K20 (42MX36) has changed to LP.                                                                                                                                                                                                                     | 2-51 |
| v5.1                | The "Low Power Mode" section was updated.                                                                                                                                                                                                                                     | 1-9  |
|                     | Footnote 8 in Table 1-9 • 5V TTL Electrical Specifications was updated.                                                                                                                                                                                                       | 1-18 |
|                     | Footnote 8 in Table 1-13 • 3.3V LVTTTL Electrical Specifications was updated.                                                                                                                                                                                                 | 1-20 |
| v5.0                | Because the changes in this data sheet are extensive and technical in nature, this should be viewed as a new document. Please read it as you would a datasheet that is published for the first time.                                                                          | ALL  |
|                     | Note that the "Package Characteristics and Mechanical Drawings" section has been eliminated from the datasheet. The mechanical drawings are now contained in a separate document, <i>Package Mechanical Drawings</i> , available on the Microsemi SoC Products Group website. |      |

## Datasheet Categories

In order to provide the latest information to designers, some datasheets are published before data has been fully characterized. Datasheets are designated as "Product Brief," "Advanced," "Production," and "Datasheet Supplement." The definitions of these categories are as follows:

### Product Brief

The product brief is a summarized version of a datasheet (advanced or production) containing general product information. This brief gives an overview of specific device and family information.

### Advance

This datasheet version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production.

### Unmarked (production)

This datasheet version contains information that is considered to be final.

### Datasheet Supplement

The datasheet supplement gives specific device information for a derivative family that differs from the general family datasheet. The supplement is to be used in conjunction with the datasheet to obtain more detailed information and for specifications that do not differ between the two families.



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